

RYAN R. WIXOM

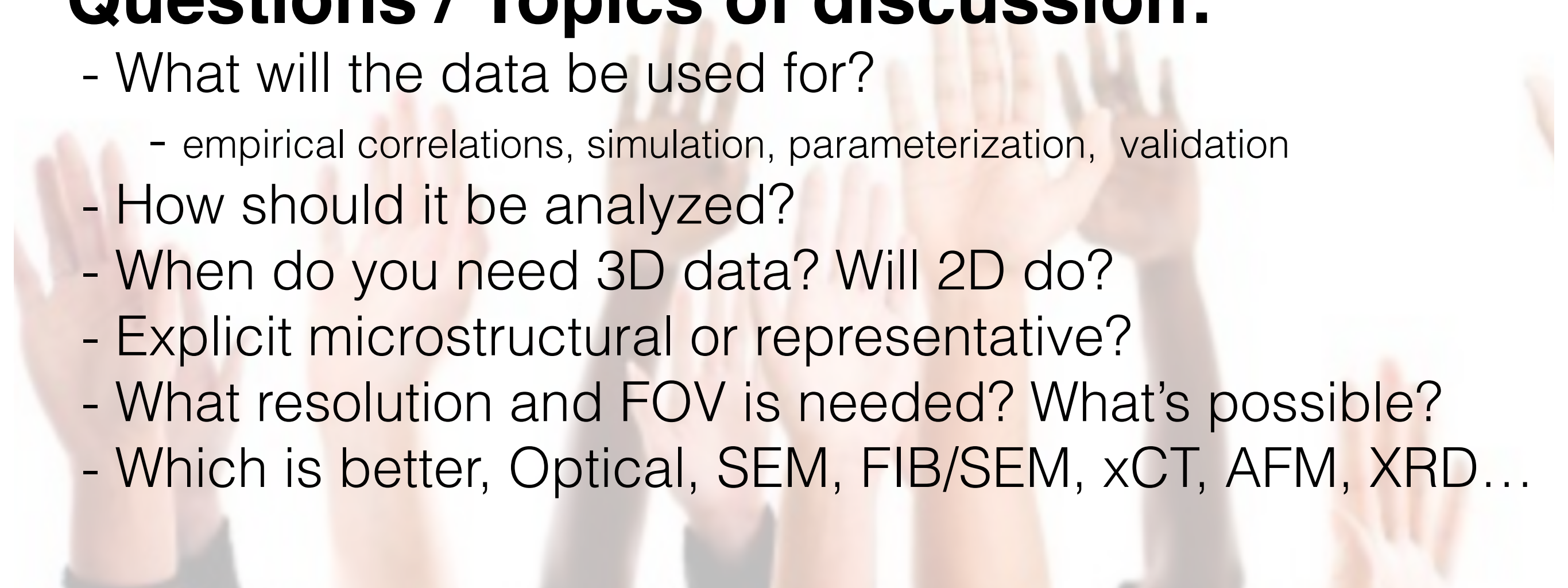
MICROSTRUCTURAL CHARACTERIZATION OF ENERGETIC MATERIALS

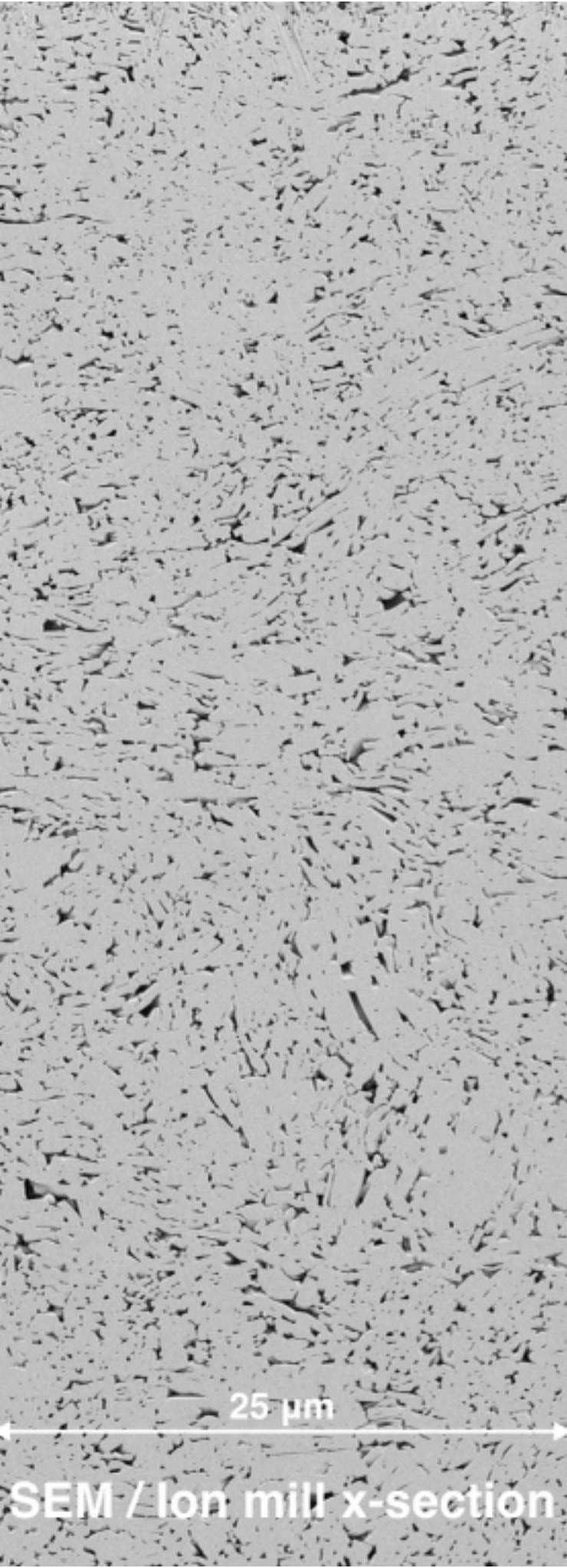


PEOPLE

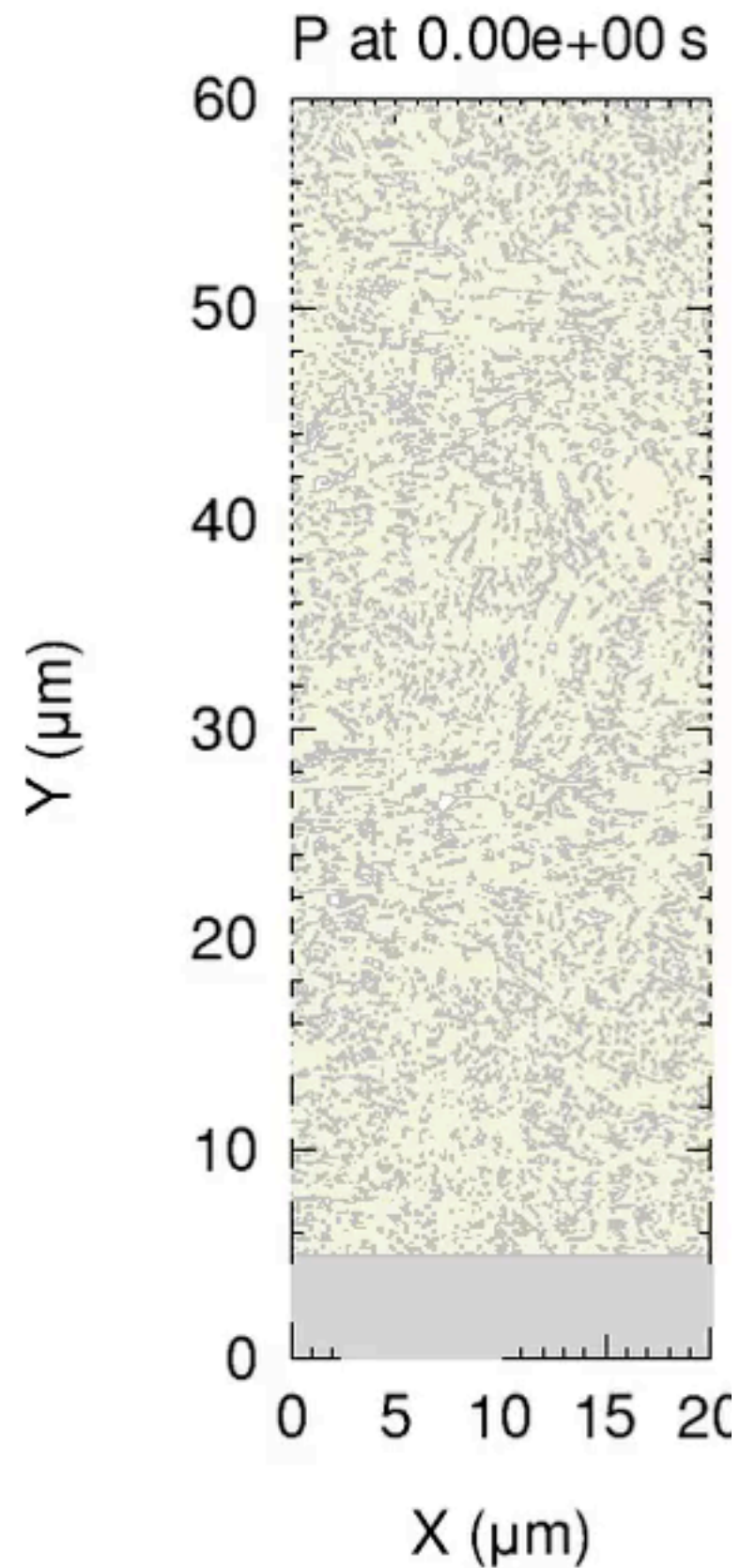
- Dave Jones, Eric Welle, [Mel Baer](#), Alex Tappan
- Joe Michael, Micheal Rye
- **Barry Ritchey**, [Cole Yarrington](#), [Rob Knepper](#), David Damm
- Chris Molek (HMX and analysis)
- Todd Reedy (low density CL-20)
- Marcia Cooper, Graham Kosiba (RPI APCP characterization)

Questions / Topics of discussion:

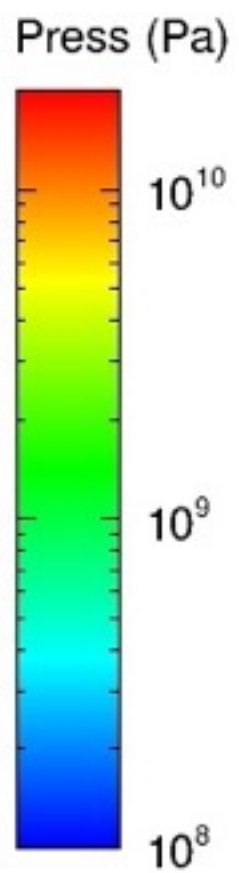
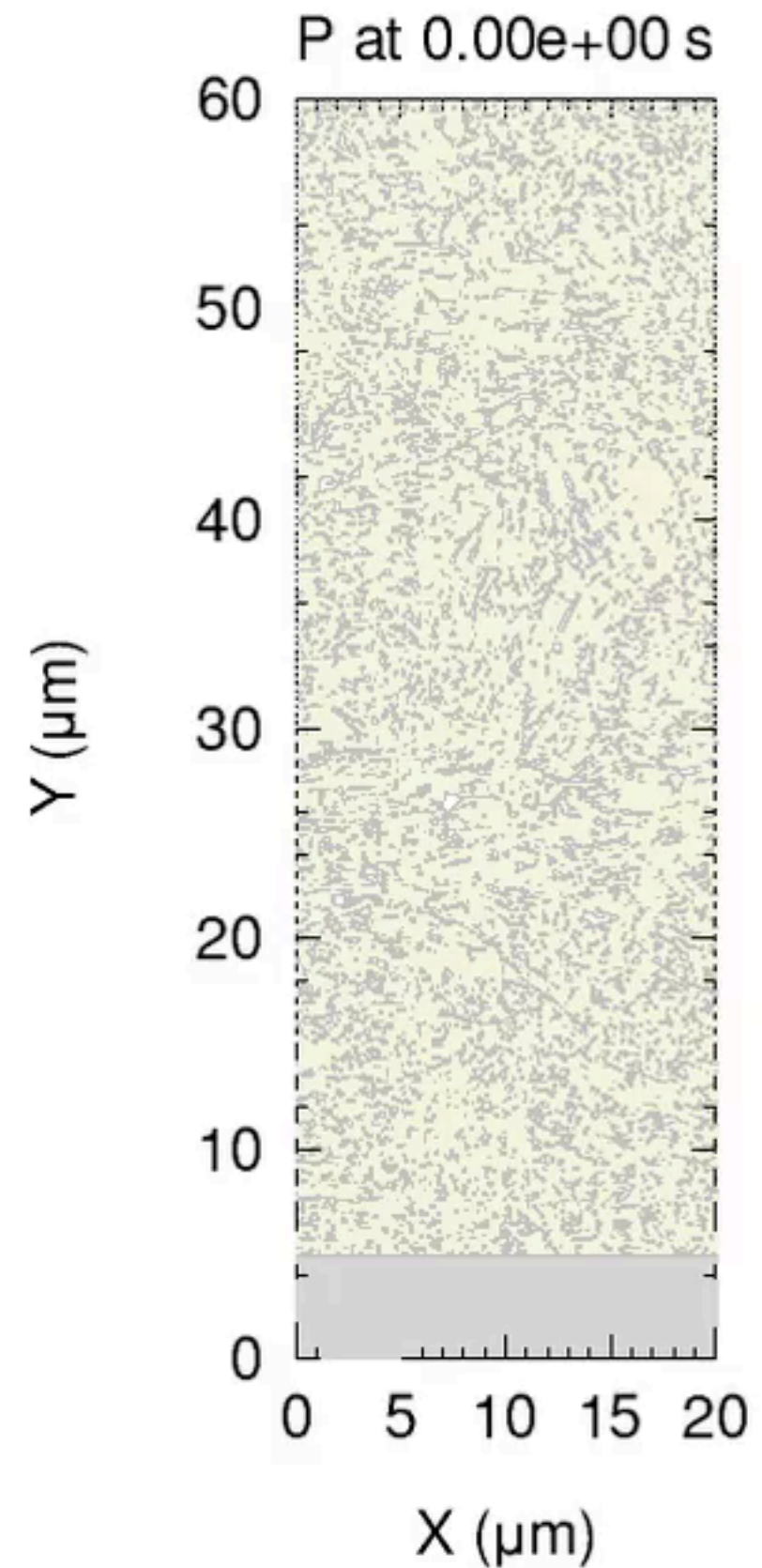
- 
- What will the data be used for?
 - empirical correlations, simulation, parameterization, validation
 - How should it be analyzed?
 - When do you need 3D data? Will 2D do?
 - Explicit microstructural or representative?
 - What resolution and FOV is needed? What's possible?
 - Which is better, Optical, SEM, FIB/SEM, xCT, AFM, XRD...



Flyer impact 1500 m/s



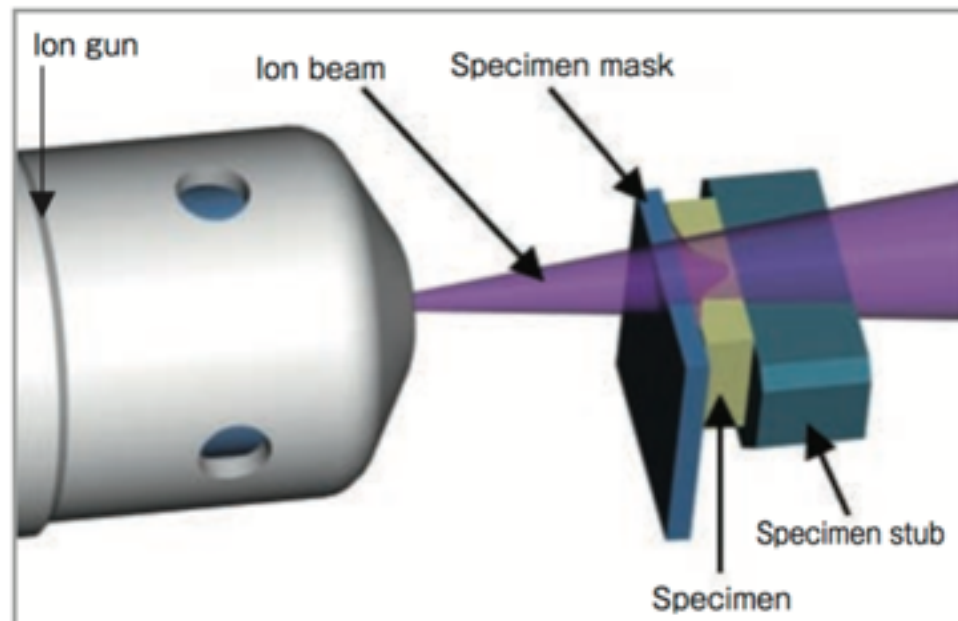
2500 m/s



aluminum flyer impacting hexanitrostilbene

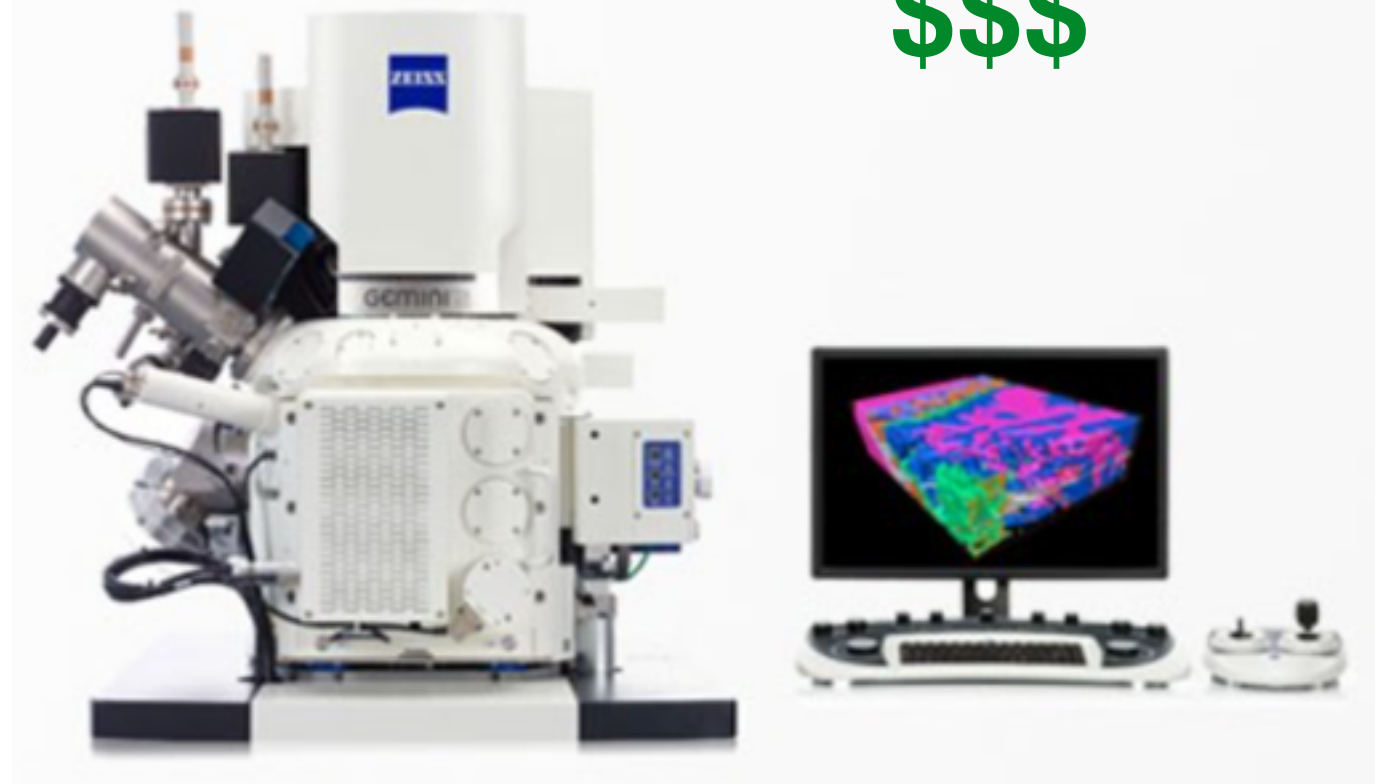
\$

Ar ion-beam
cross-sections
Hitachi IM4000



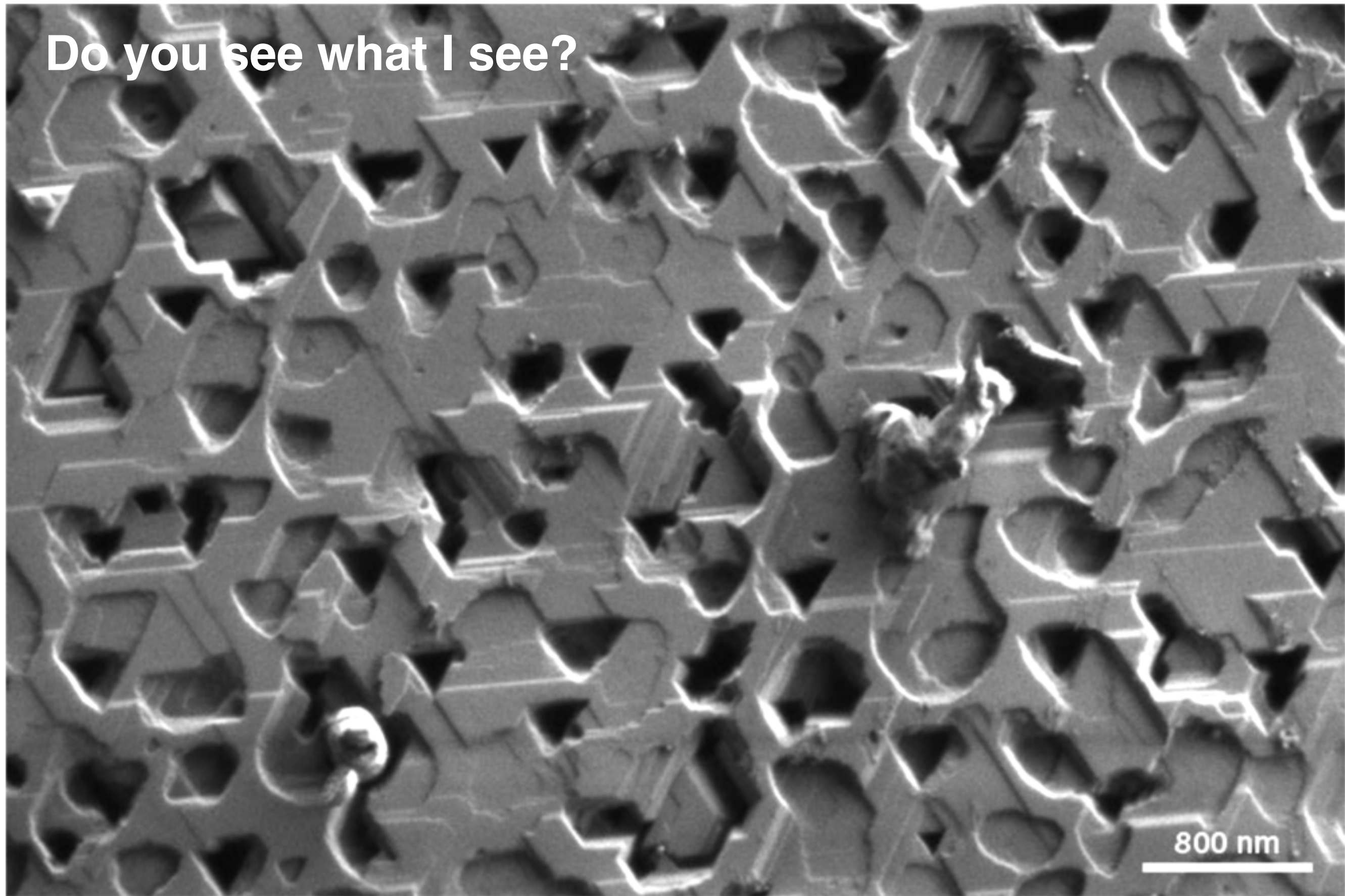
Schematic diagram for processing of Cross-section milling

FIB/SEM Zeiss Cross-beam
\$\$\$



xCT
Zeiss / Xradia
Versa 520

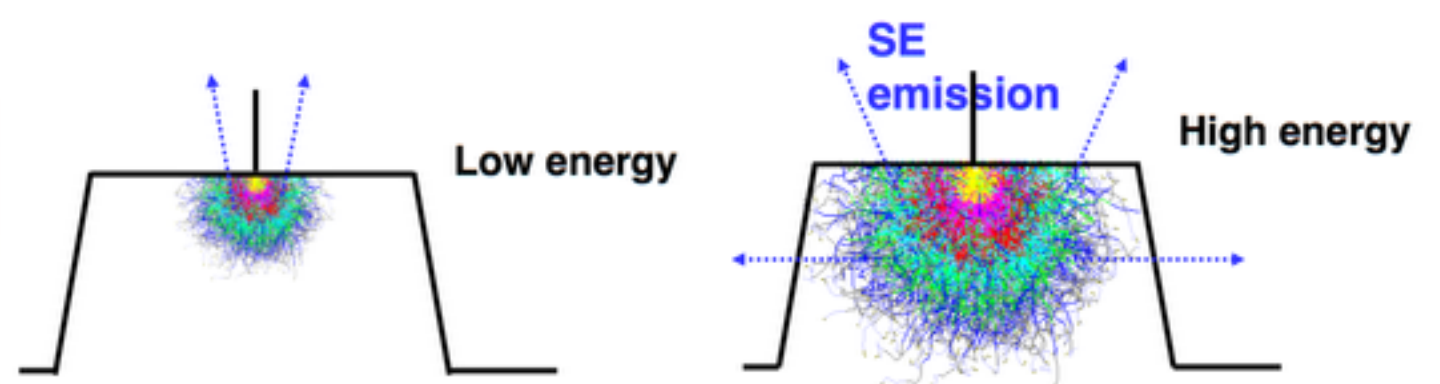
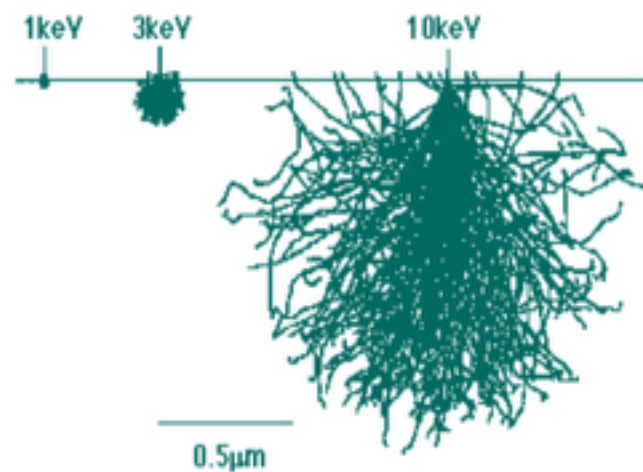
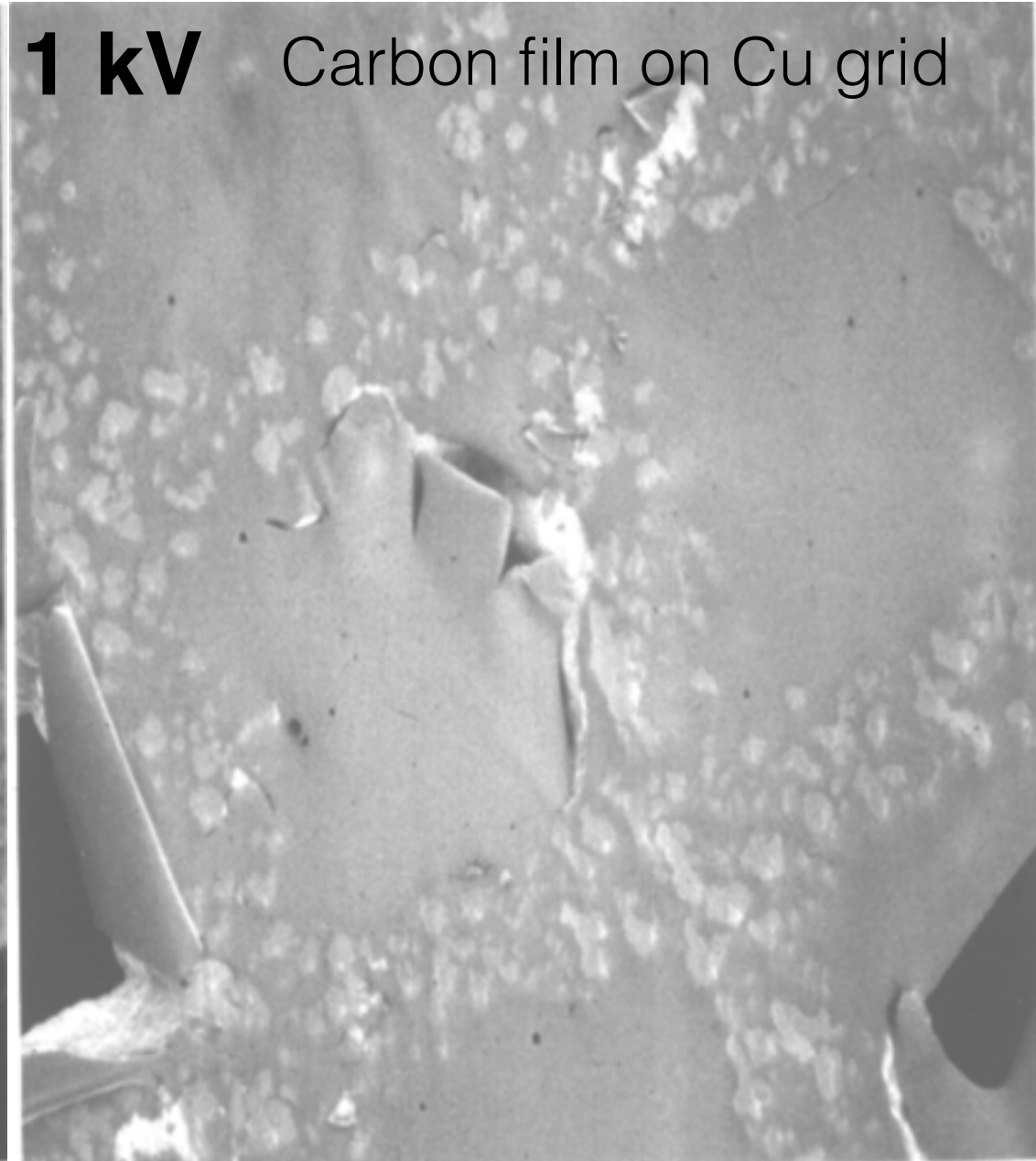
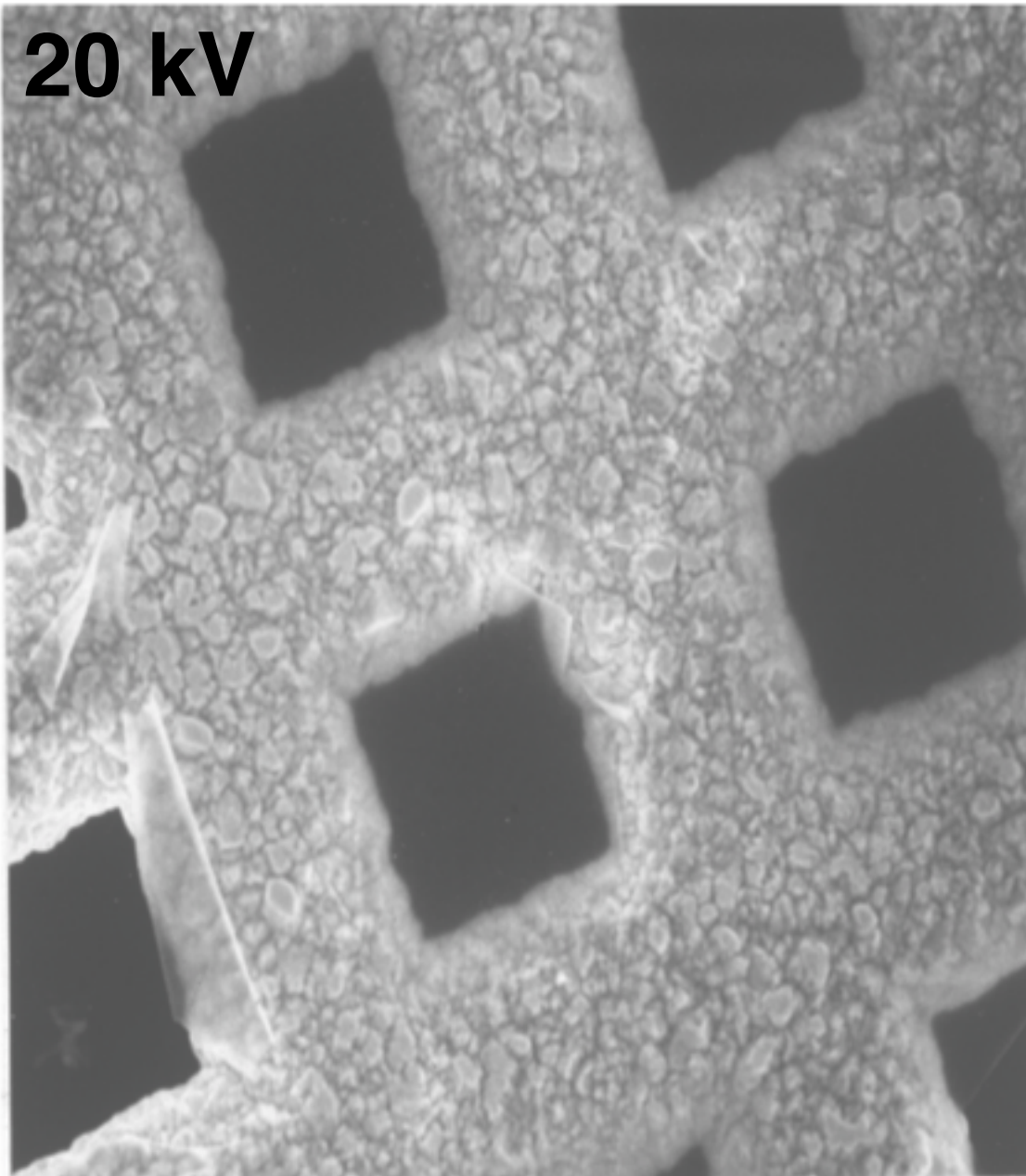
Do you see what I see?



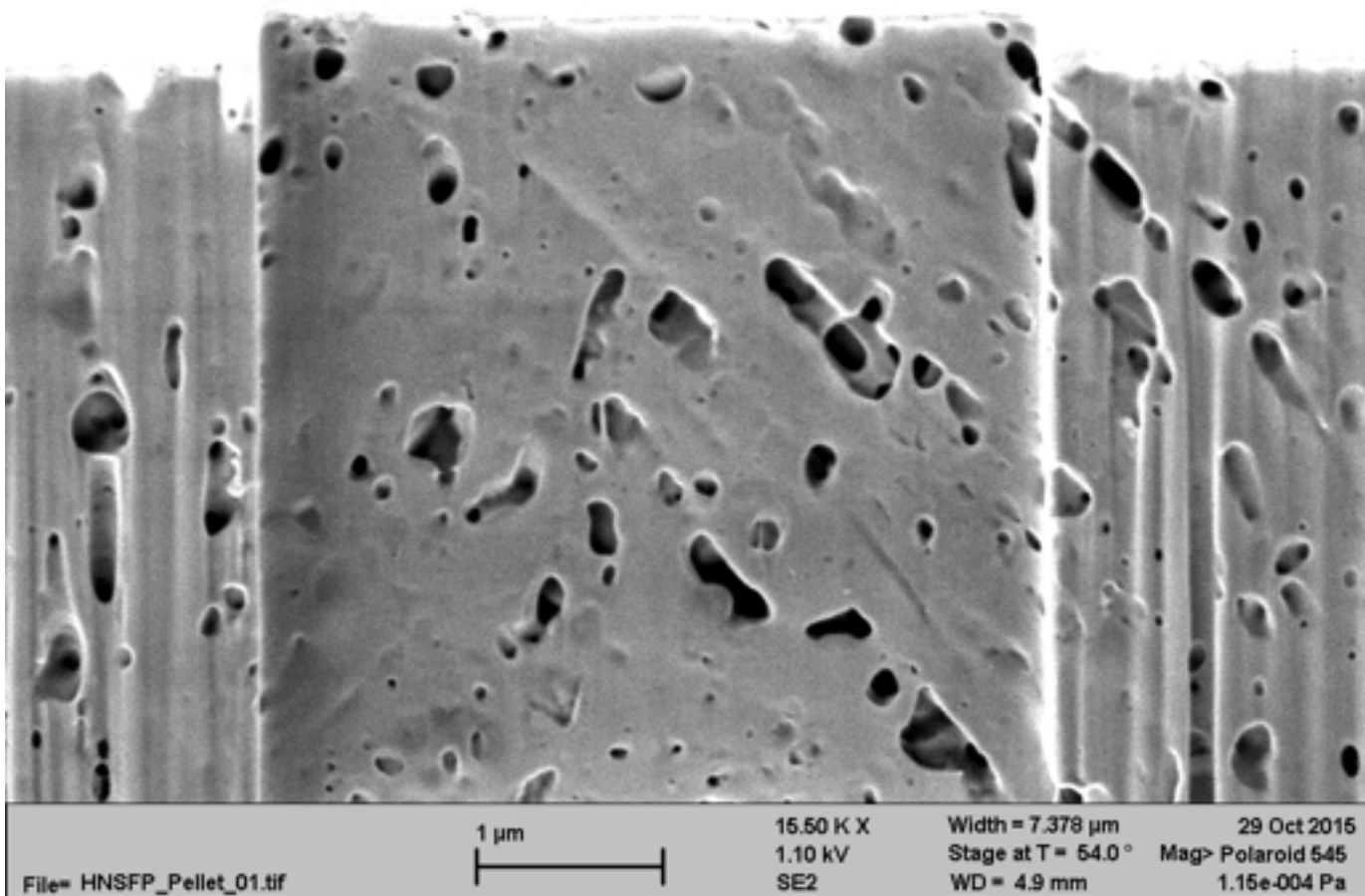
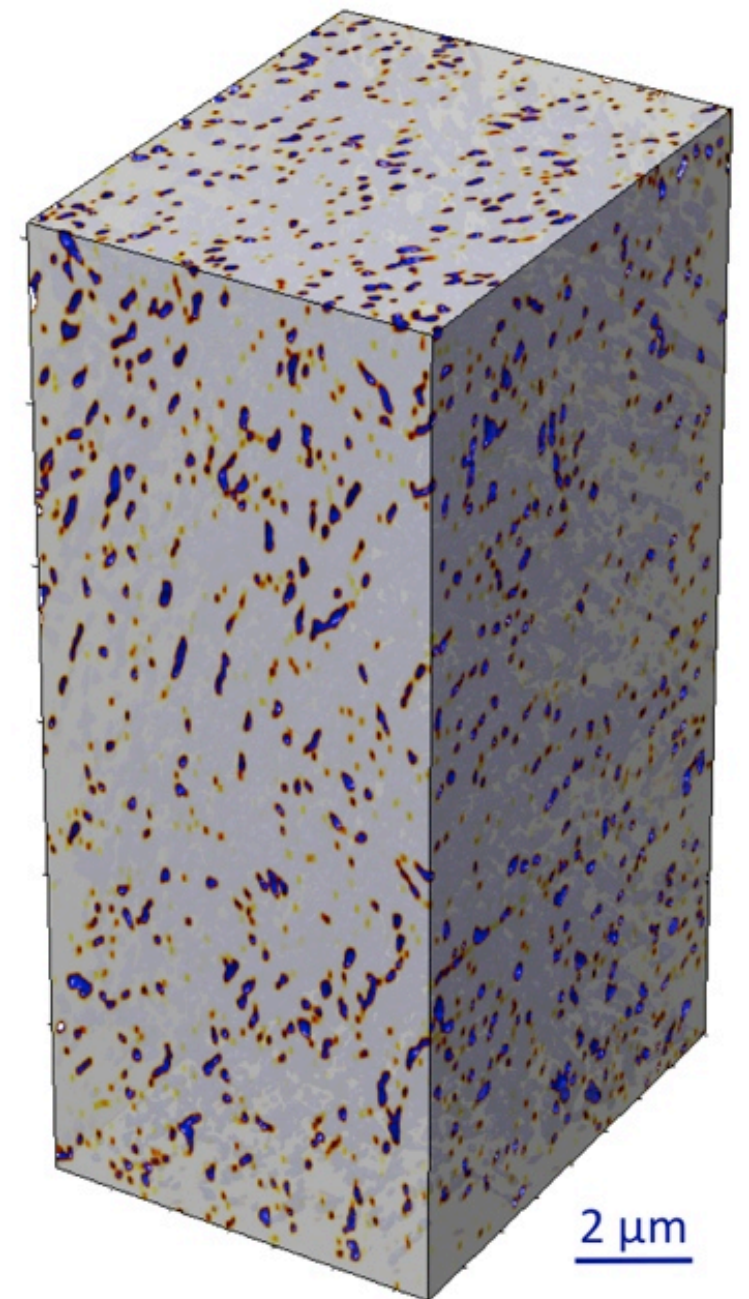
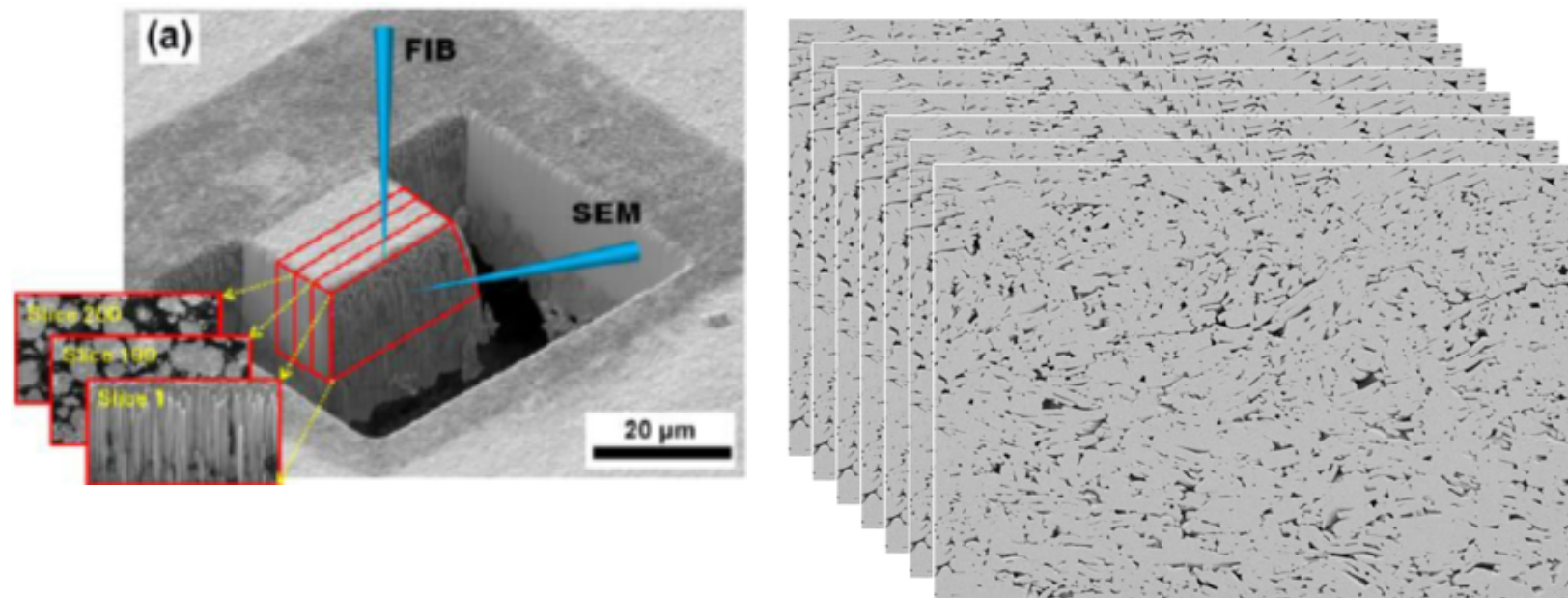
Etched silicon nanostructures at 50 V, no sample biasing. Imaged with GeminiSEM 500.

Sample: courtesy of A. Charai, Aix Marseille University, France.

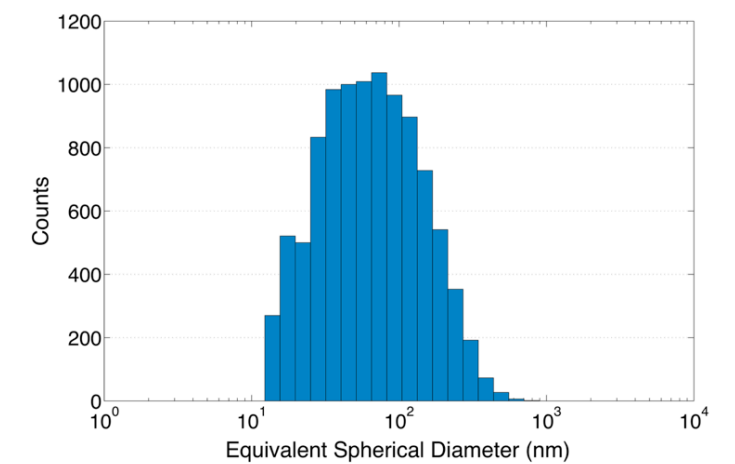
Be nice to your sample. Less voltage, please.



FIB/SEM Nanotomography



80,000 pores, mean diameter 86.3 nm



Wixom et al. J. Mater. Res. 25 1362 (2010).

Ion beam cross-sectioning

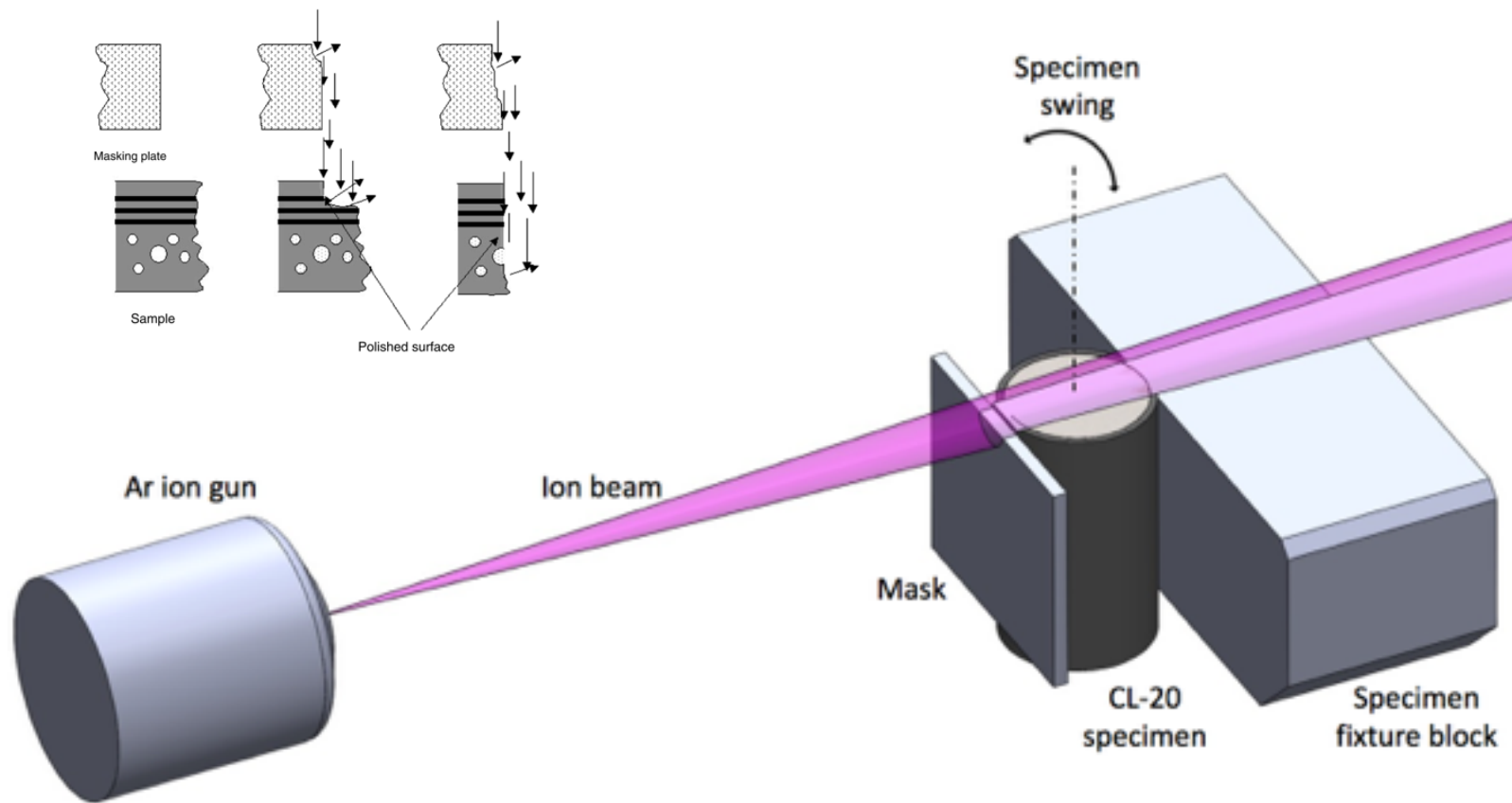
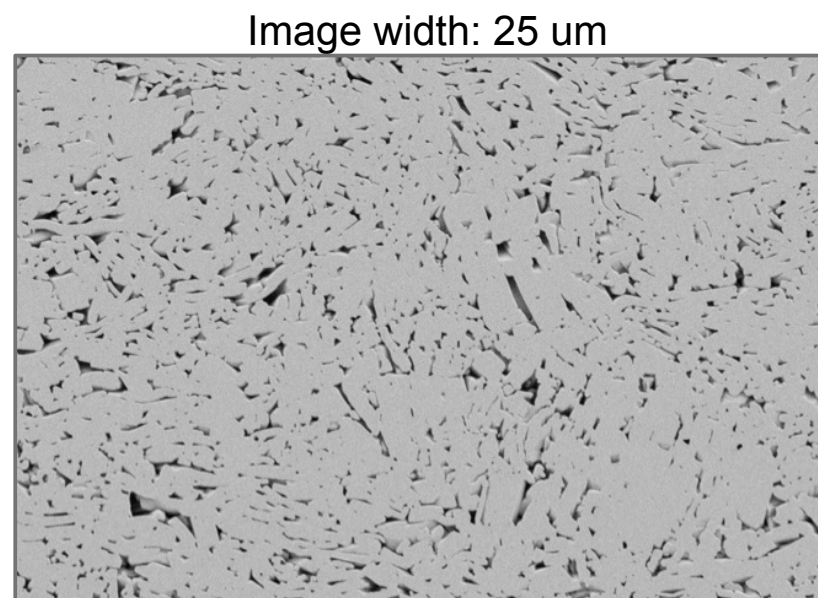
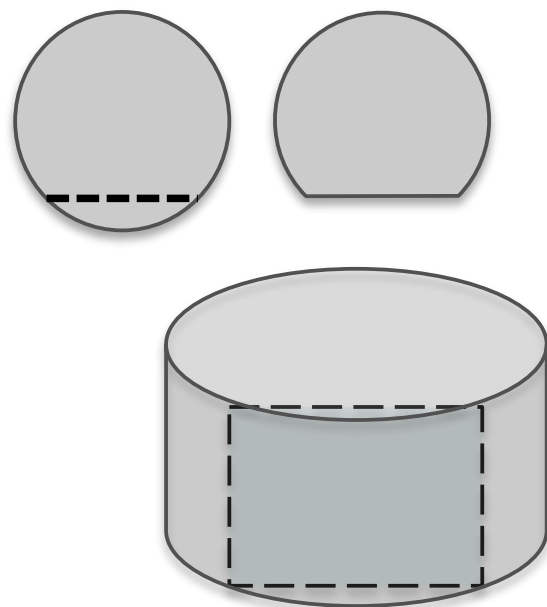


Figure 2-4. Schematic of cross-sectional ion milling.



HNS-FP, 90% TMD

CL-20: 50% 70% 90% TMD

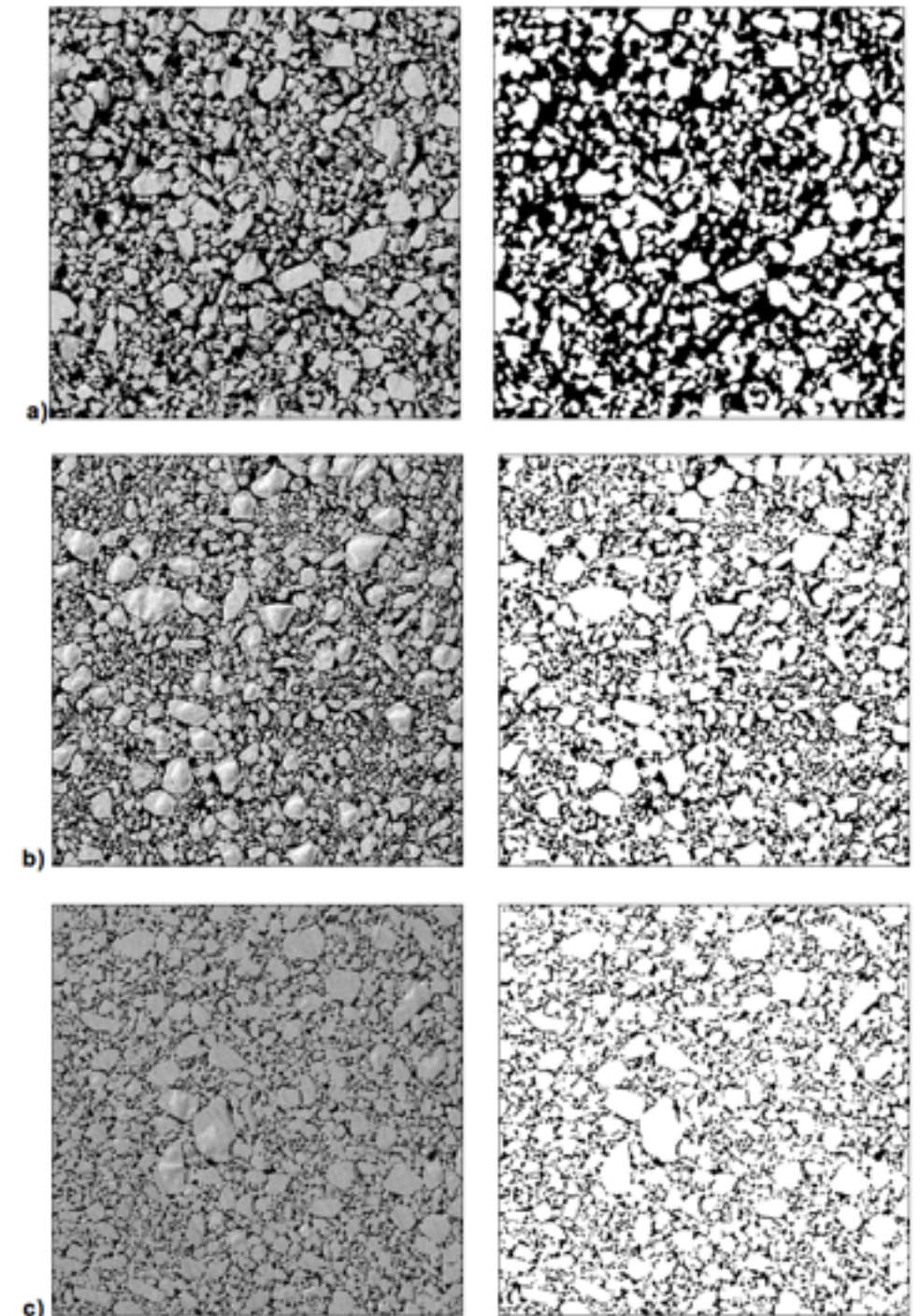
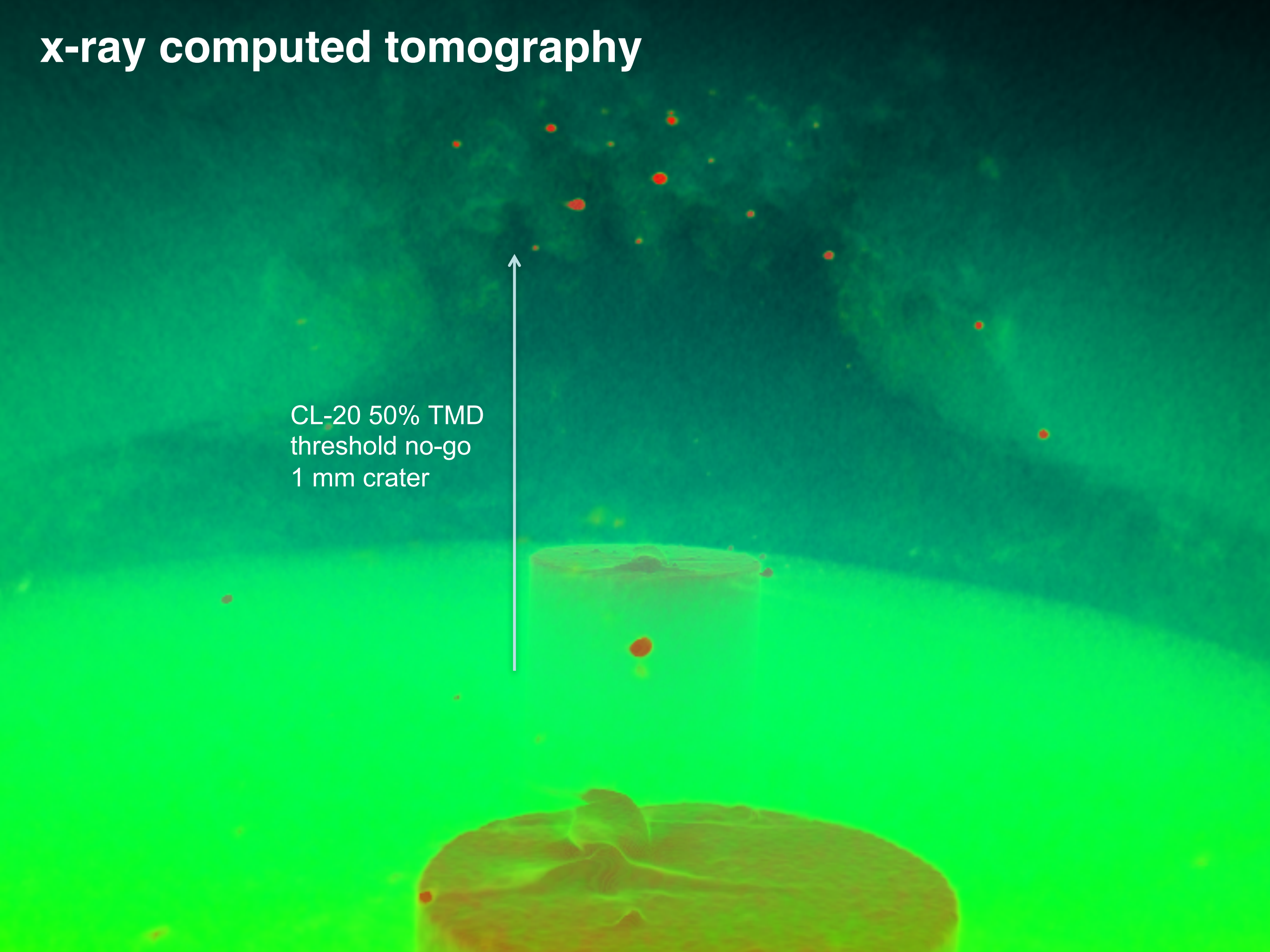
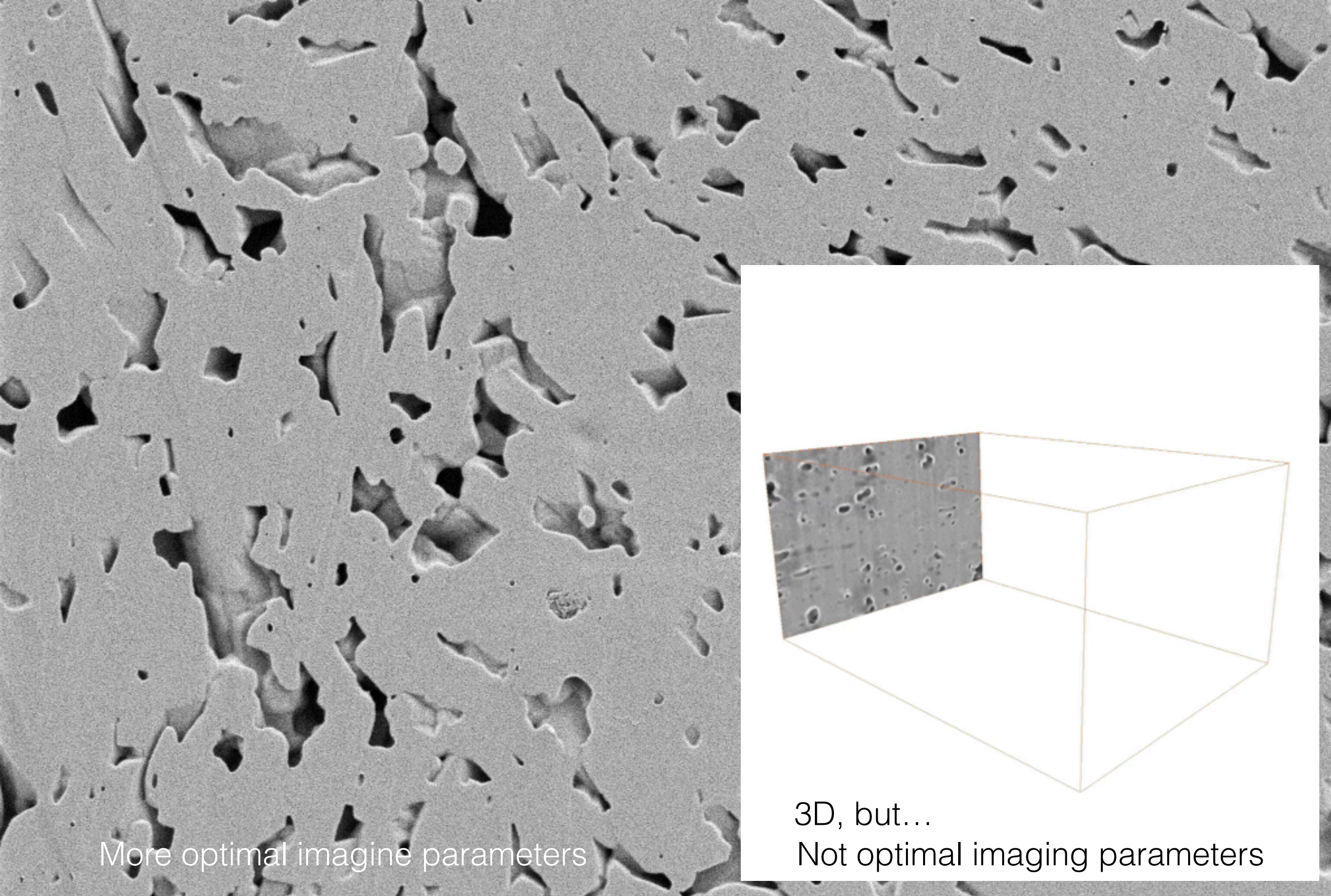


Figure 2-8. Ion-milled cross-section electron images of powder A pressed to nominally a) 50% TMD, b) 70% TMD, and c) 90% TMD. The image in right column is a segmented binary representation of the micrograph shown in the left column. Each image is 50 μm by 50 μm.

x-ray computed tomography

CL-20 50% TMD
threshold no-go
1 mm crater





More optimal imagine parameters

3D, but...
Not optimal imaging parameters

HNS-10



EHT = 1.50 kV

WD = 4.3 mm

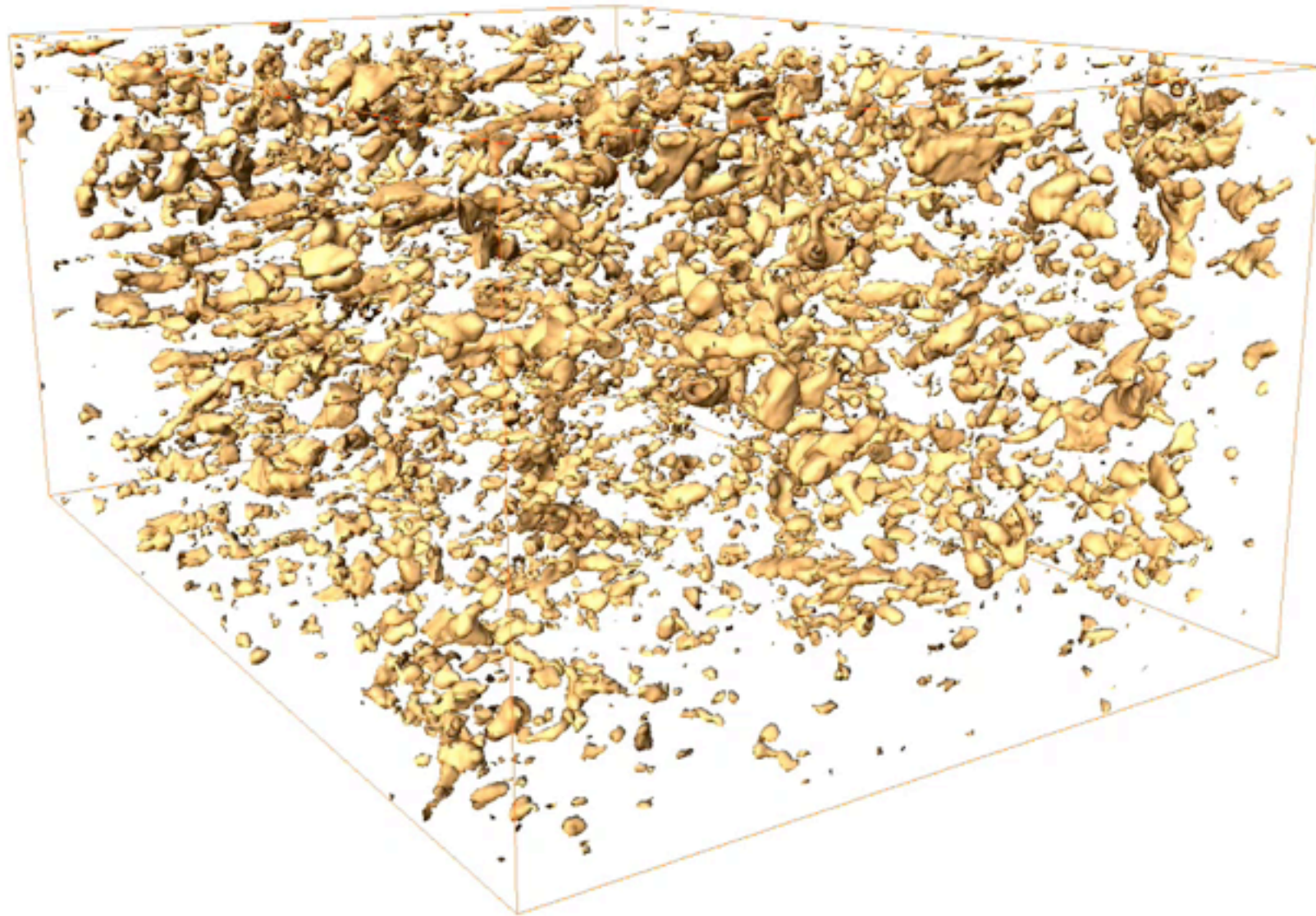
Date :21 Apr 2009

Mag = 25.00 K X

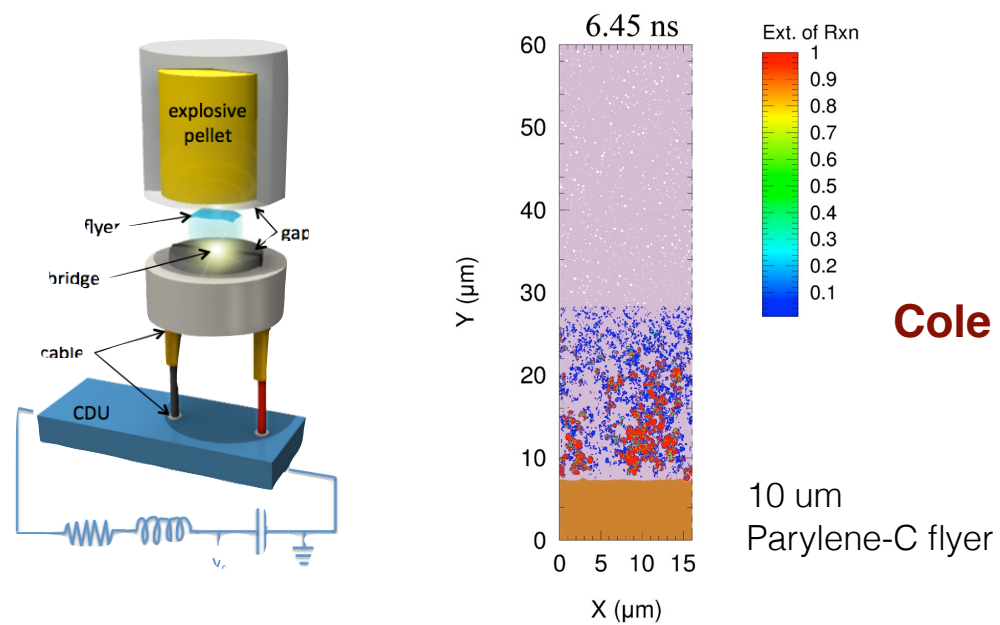
Signal A = SE2

Time :11:27:32

Obligatory spinning image

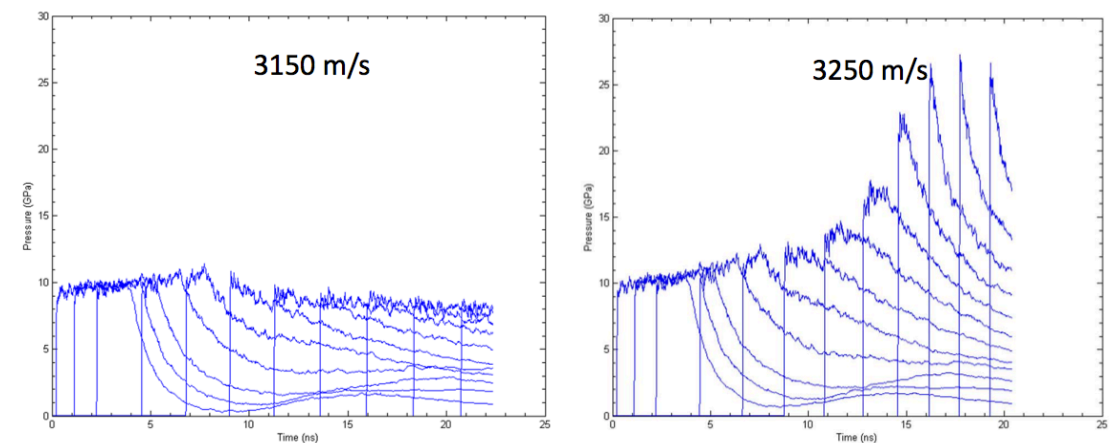


Mesoscale simulations with '**equivalent**' microstructure



**Cole Yarrington
SNL**

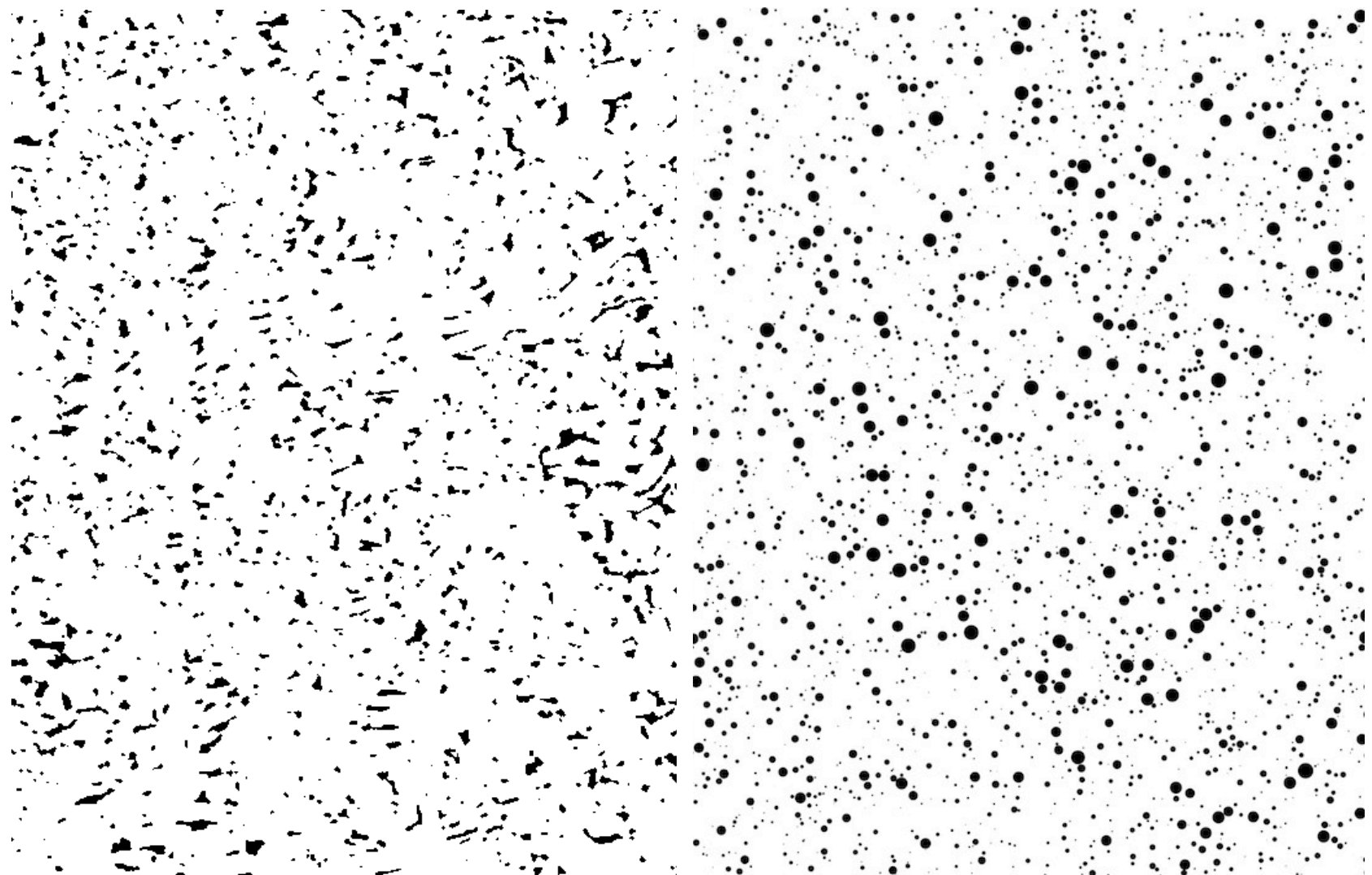
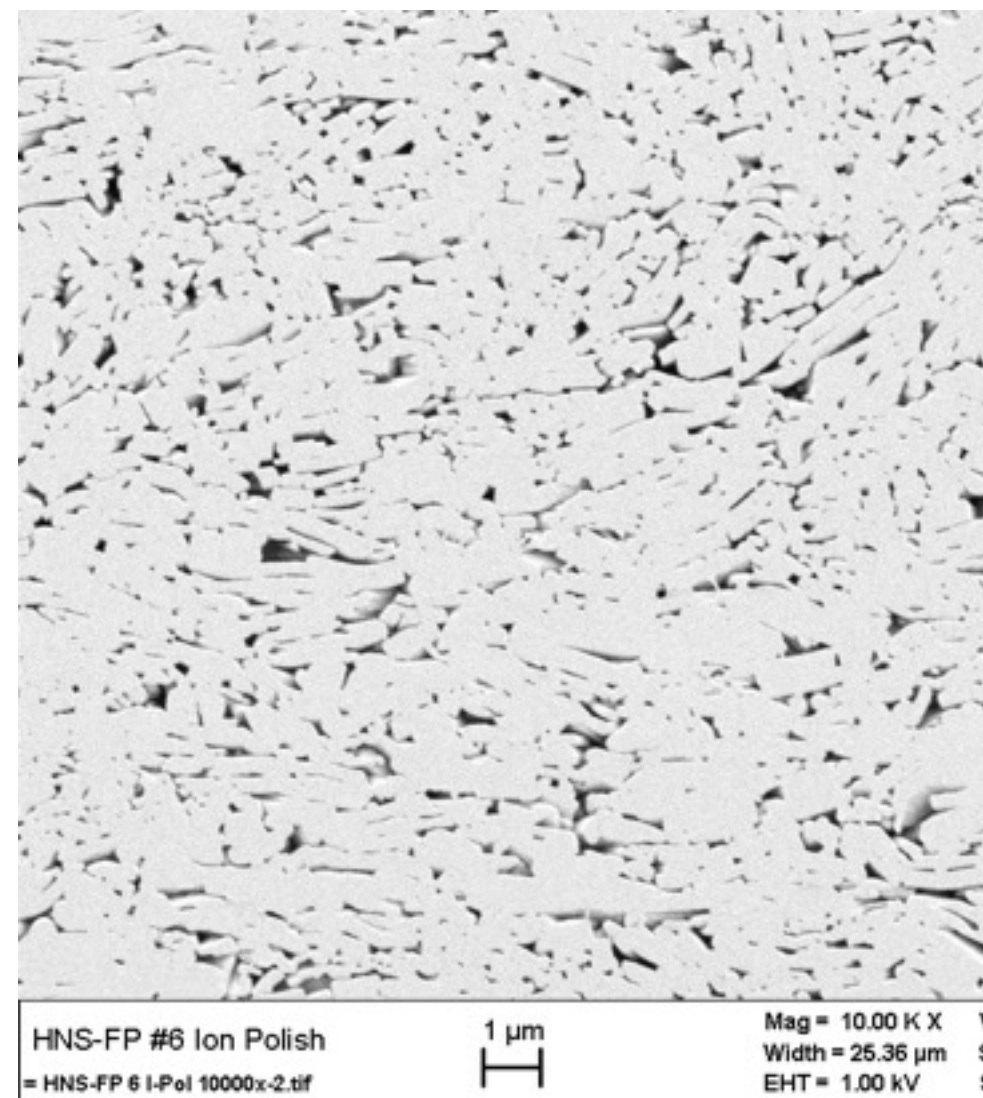
Predicts a shift in run distance with increasing pore size



Ion mill cross section

segmented

equivalent



Collaboration with AFRL (Eric Welle and Chris Molek)

Class III

Class V

PBX N5

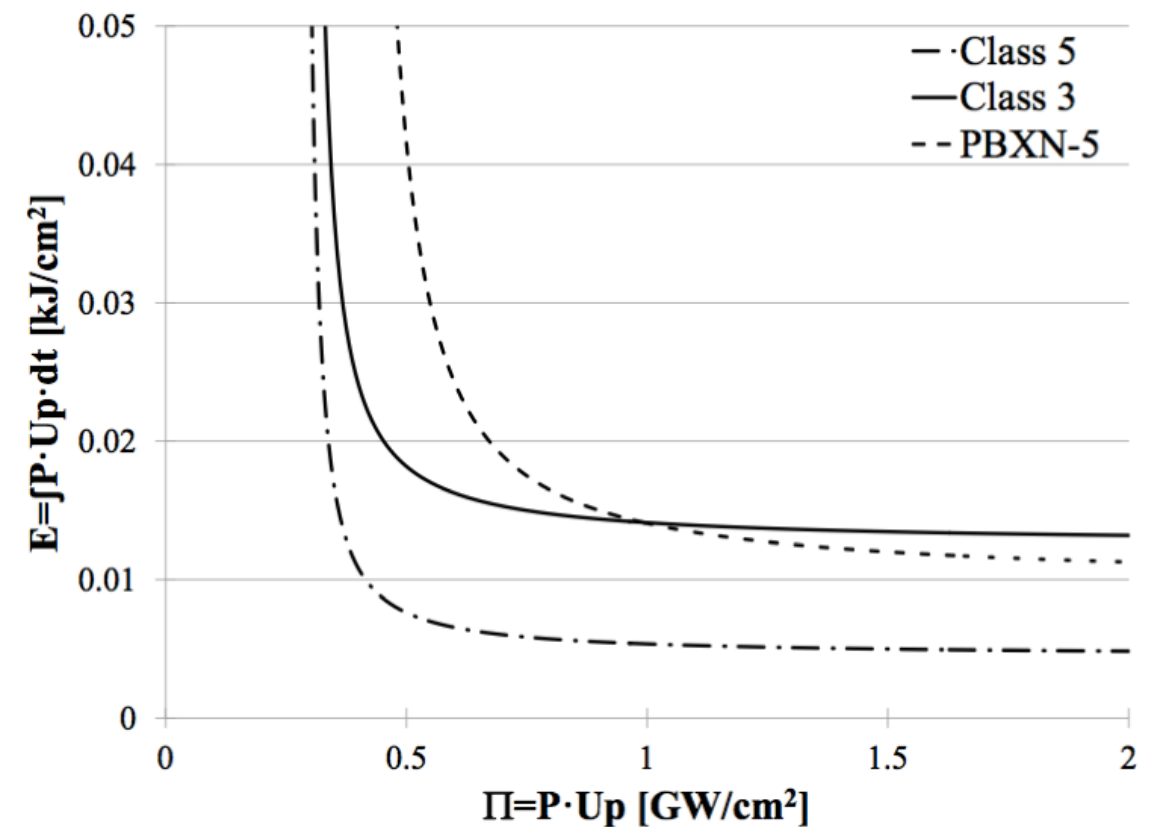
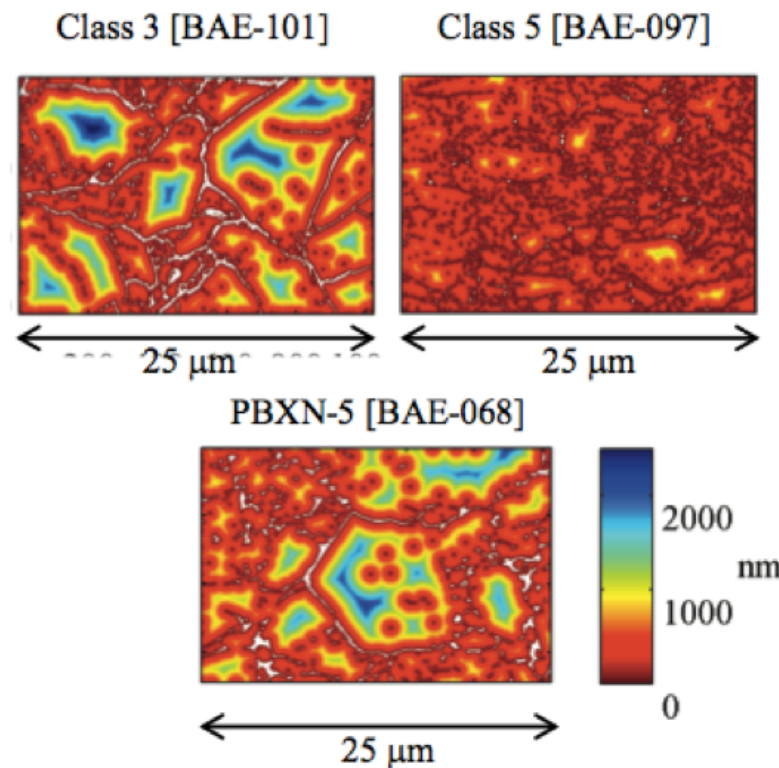
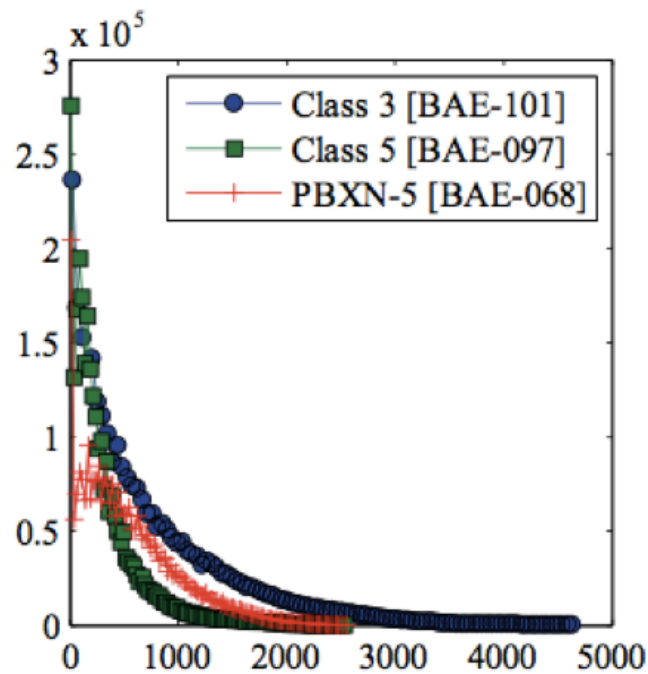
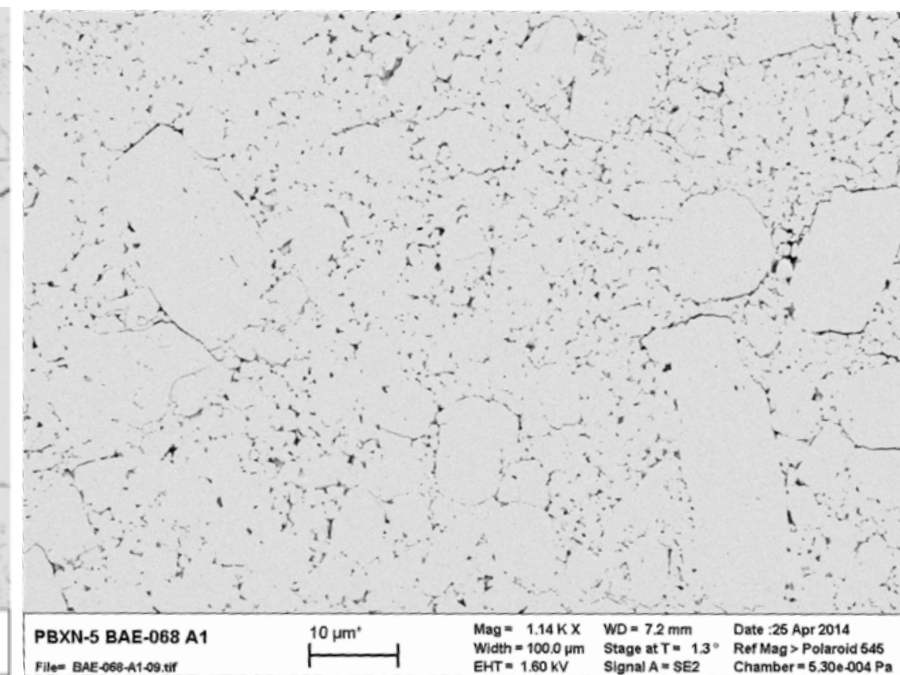
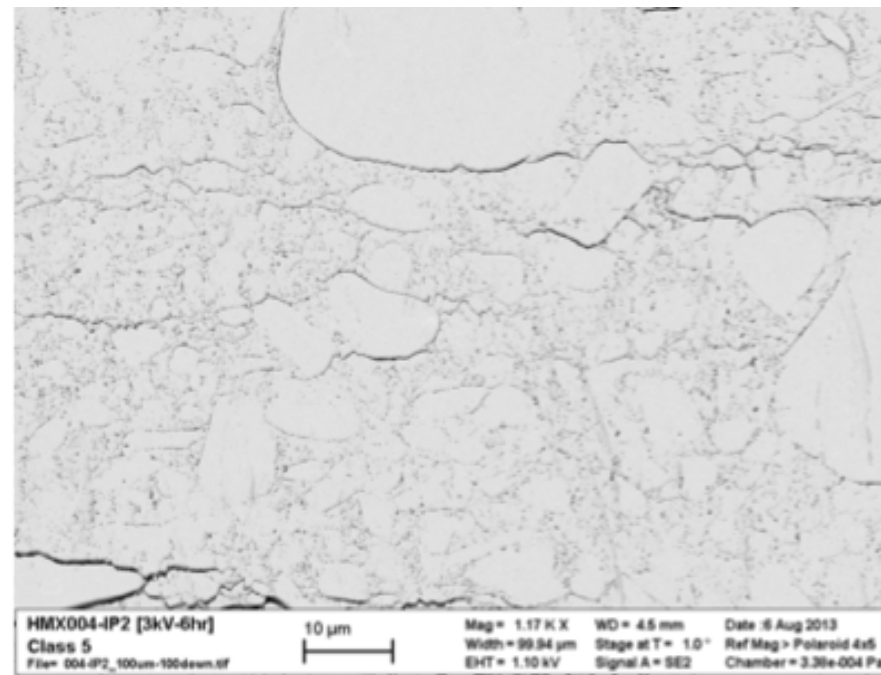
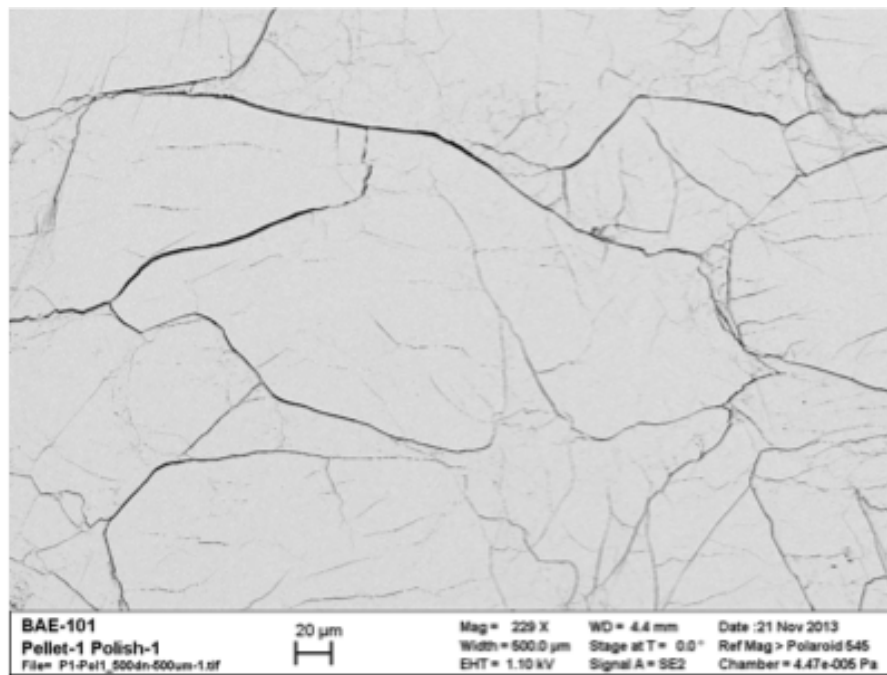


Fig. 7. Trend lines fit to initiation threshold data.

FIB/SEM, HINTS OF AMAZING THINGS TO COME

Chris Molek and Jim Vitarelli
AFRL



100 μm

30.00 μm

EHT = 3.00 kV

Mag = 39 X

Imaging Mode: SEM

Signal A = SE2

InlensDuo Grid = 0 V

30kV:65nA

WD = 5.9 mm

54.0 °

Width = 2.918 mm

Image Pixel Size = 2.849 μm

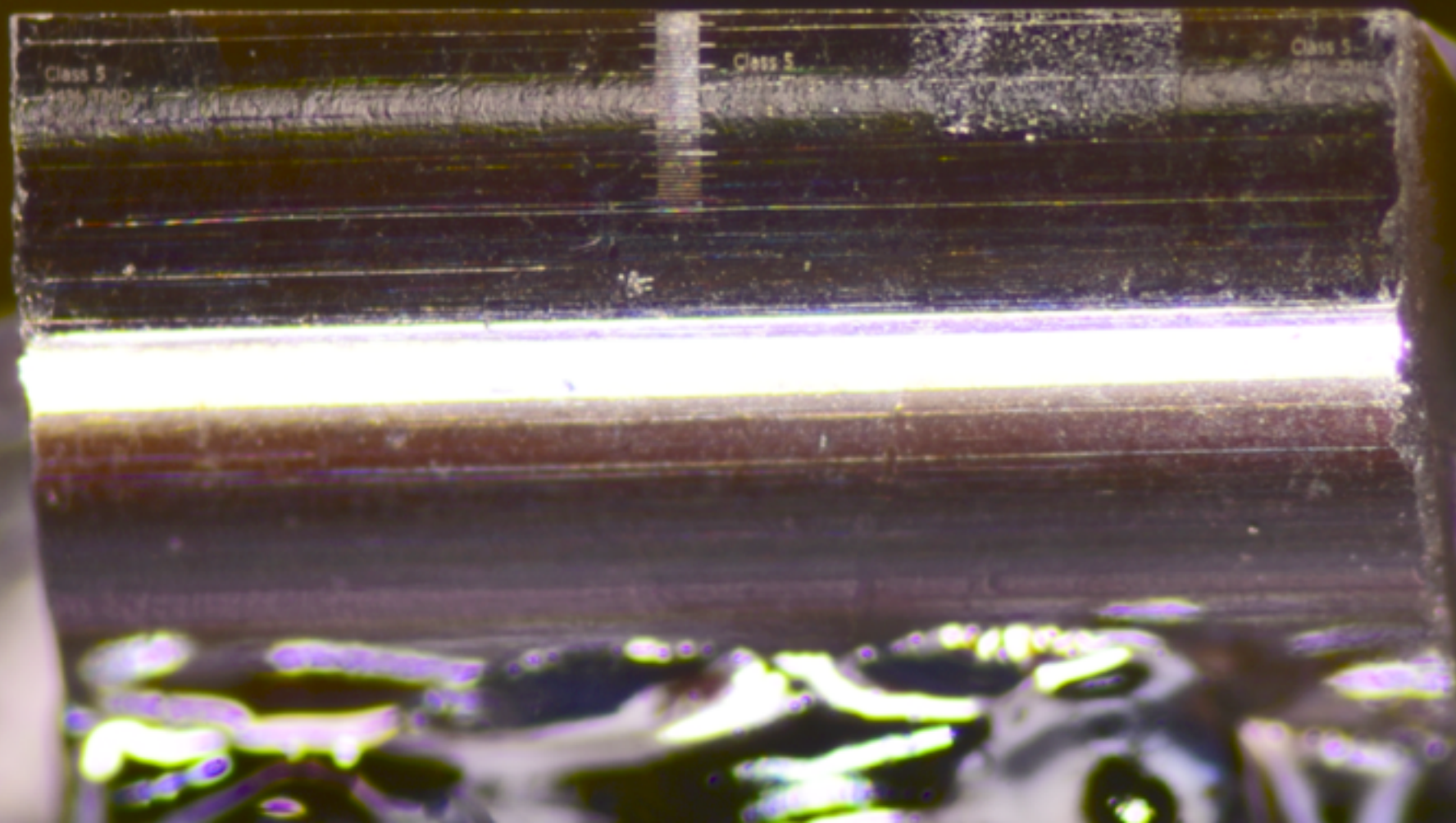
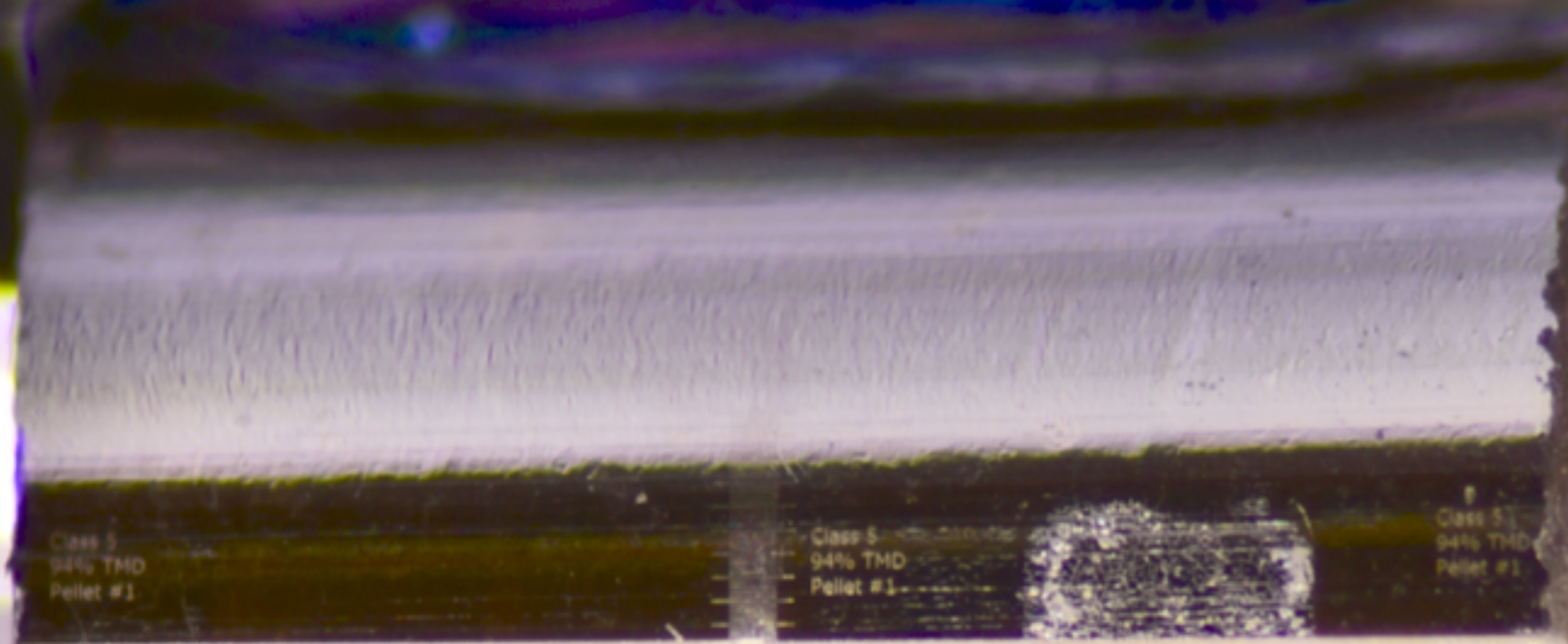


Image stitching
vs
Large area acquisition

Dynamic

Static

H 1 = 3.121 mm

V 1 = 3.164 mm

200 μm

30.00 μm

Imaging Mode: SEM

30kV:50pA ref

Width = 4.970 mm

EHT = 5.00 kV

Signal A = SE2

WD = 35.4 mm

Image Pixel Size = 4.853 μm

Mag = 23 X

InlensDuo Grid = 408 V

0.0 °

Dynamic

Static

H 1 = 3.121 mm

V 1 = 3.164 mm

200 μm

30.00 μm

Imaging Mode: SEM

30kV:50pA ref

Width = 4.970 mm

EHT = 5.00 kV

Signal A = SE2

WD = 35.4 mm

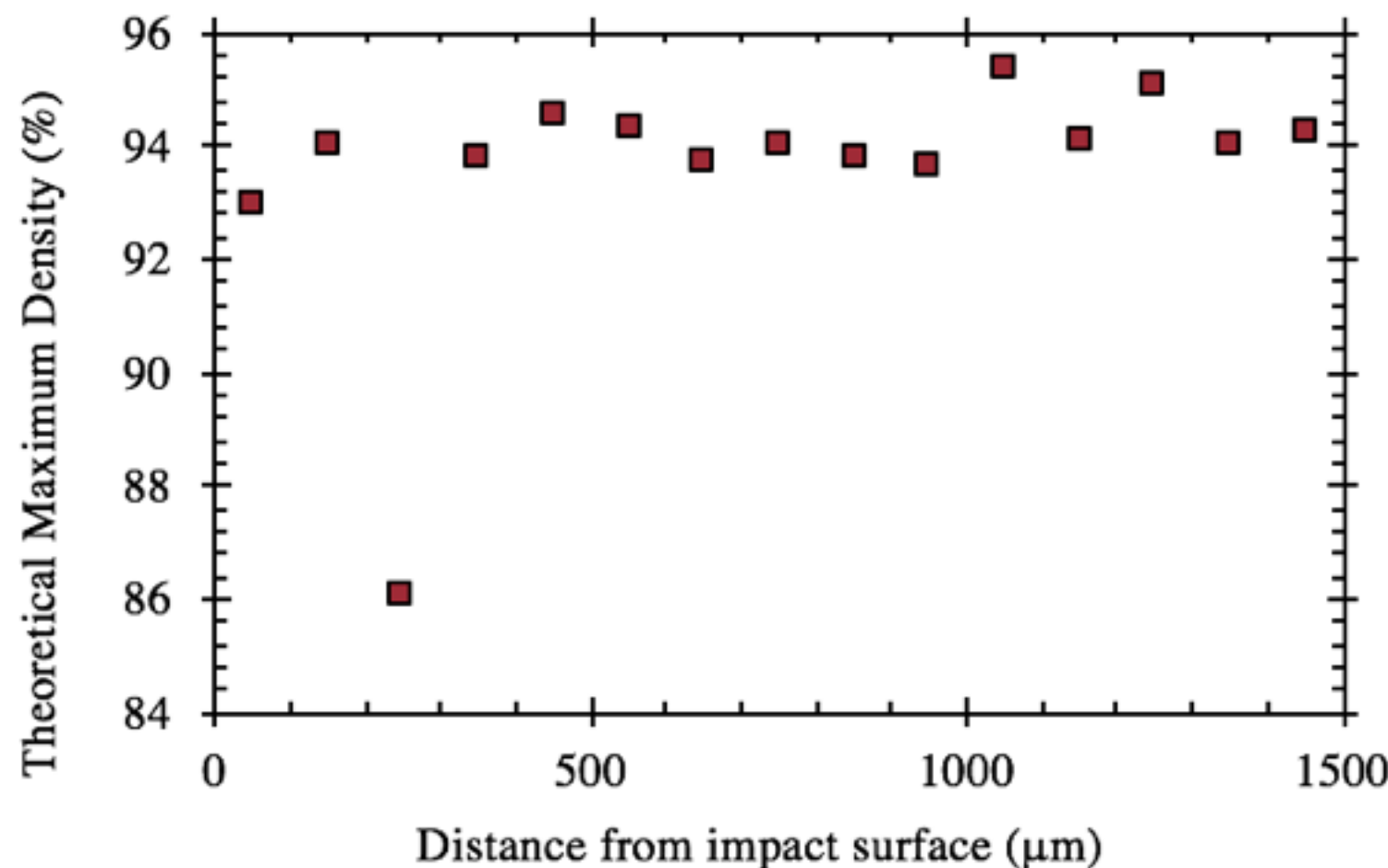
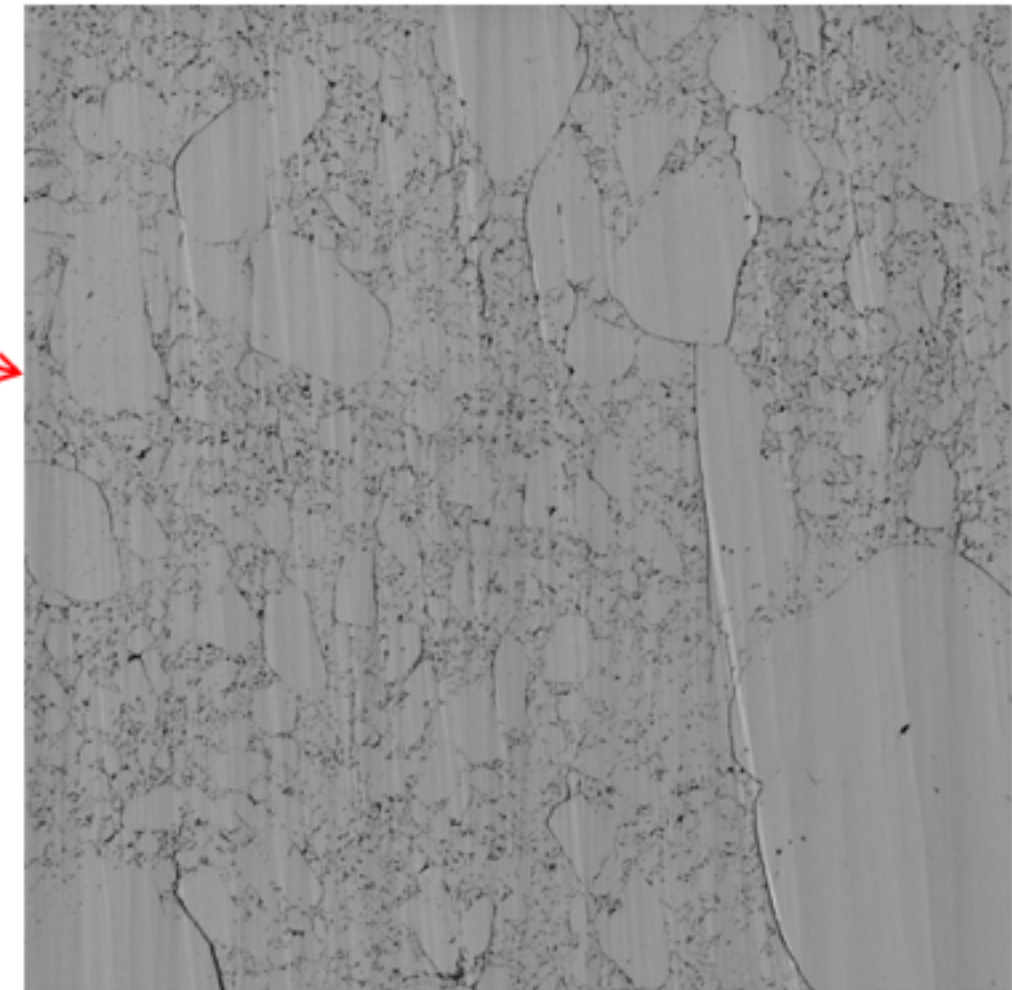
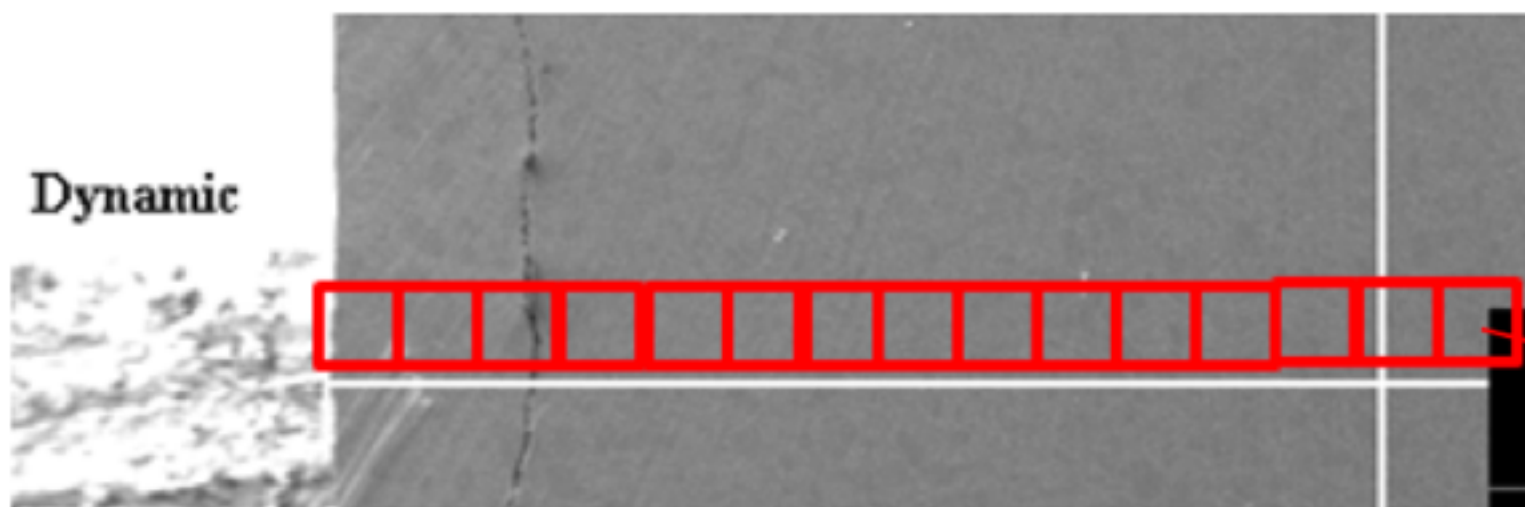
Image Pixel Size = 4.853 μm

Mag = 23 X

InlensDuo Grid = 408 V

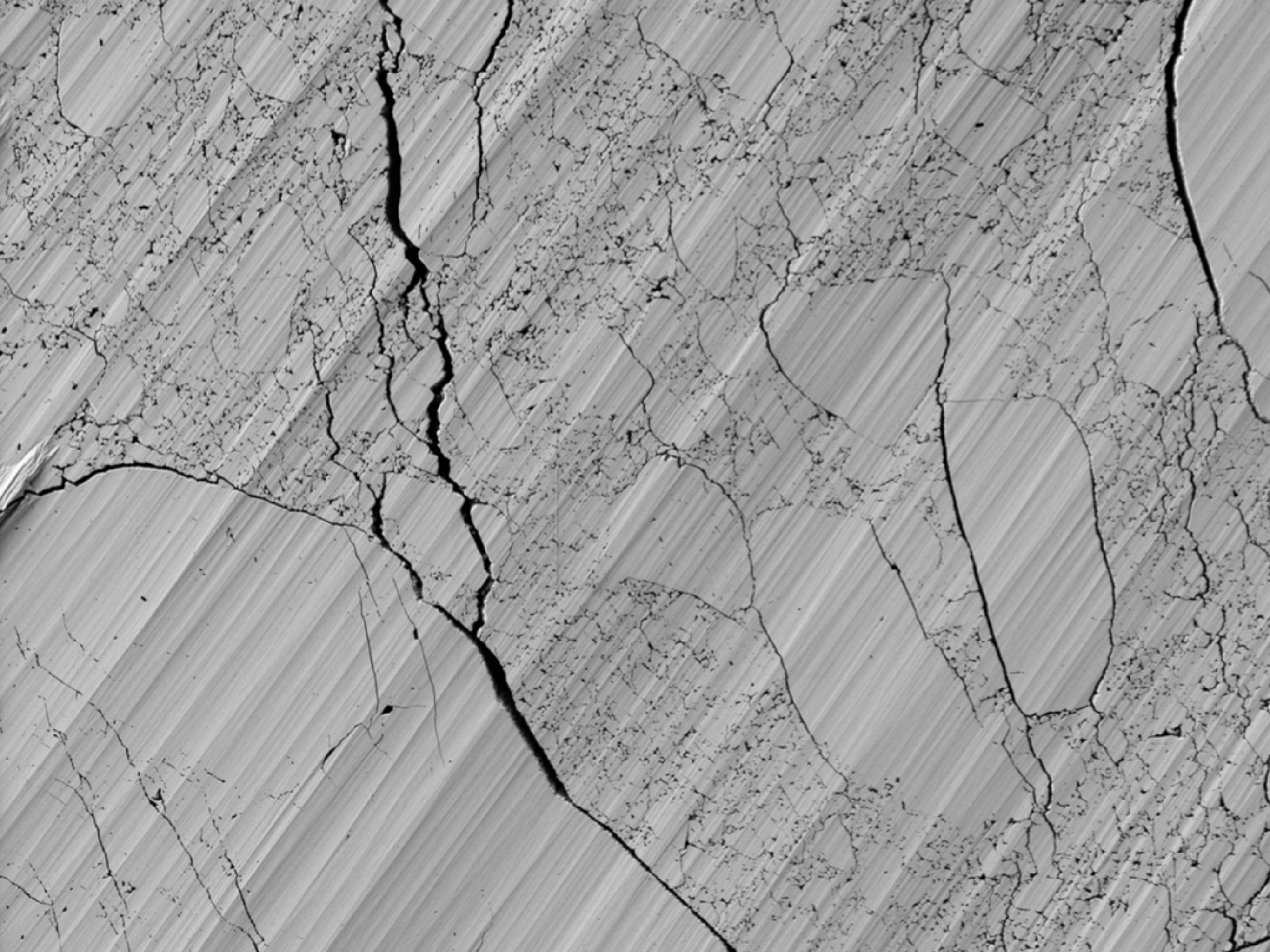
0.0 °

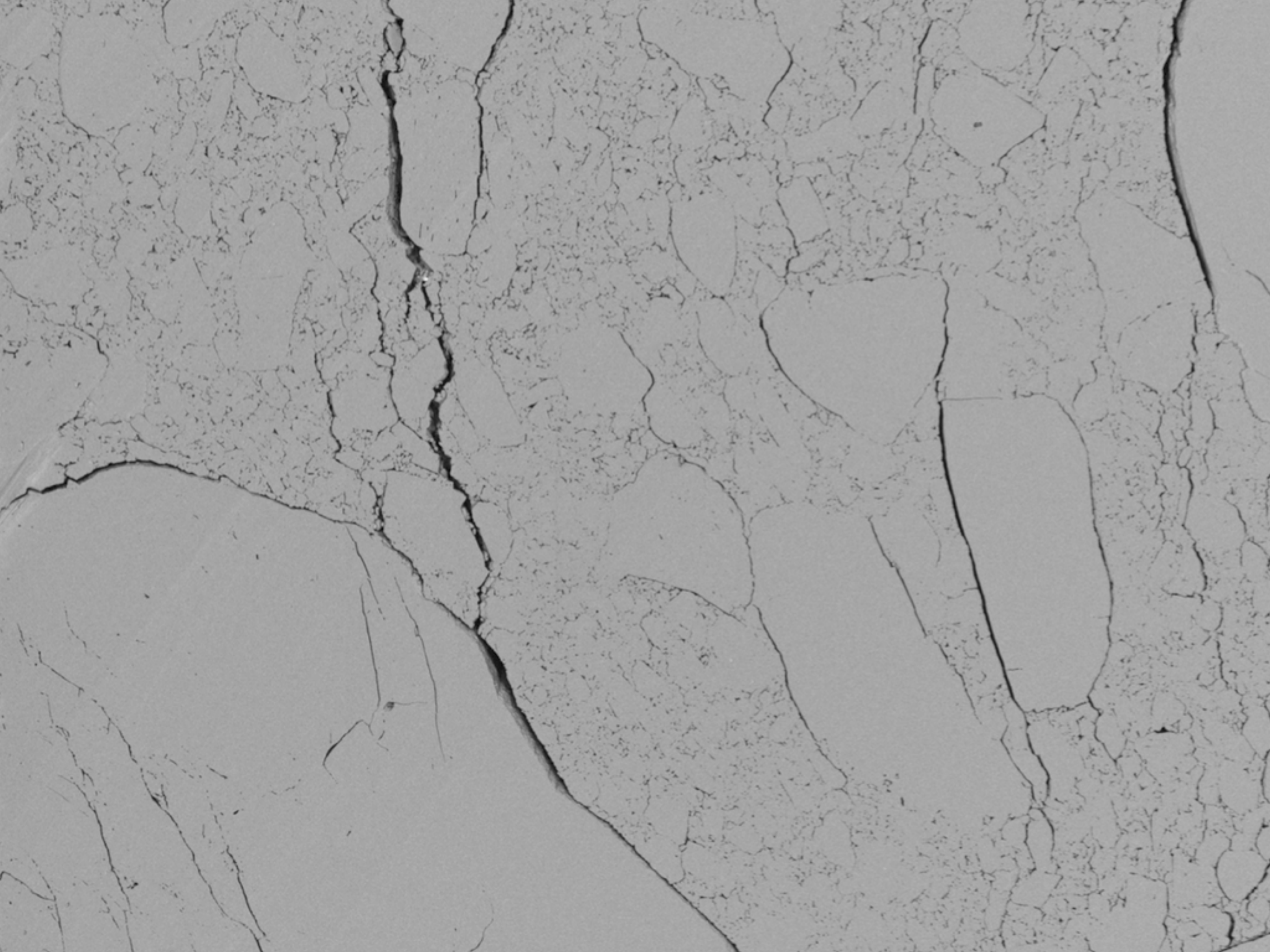
Density Variation as a Function of Depth



Class 5 at nominal 94% TMD

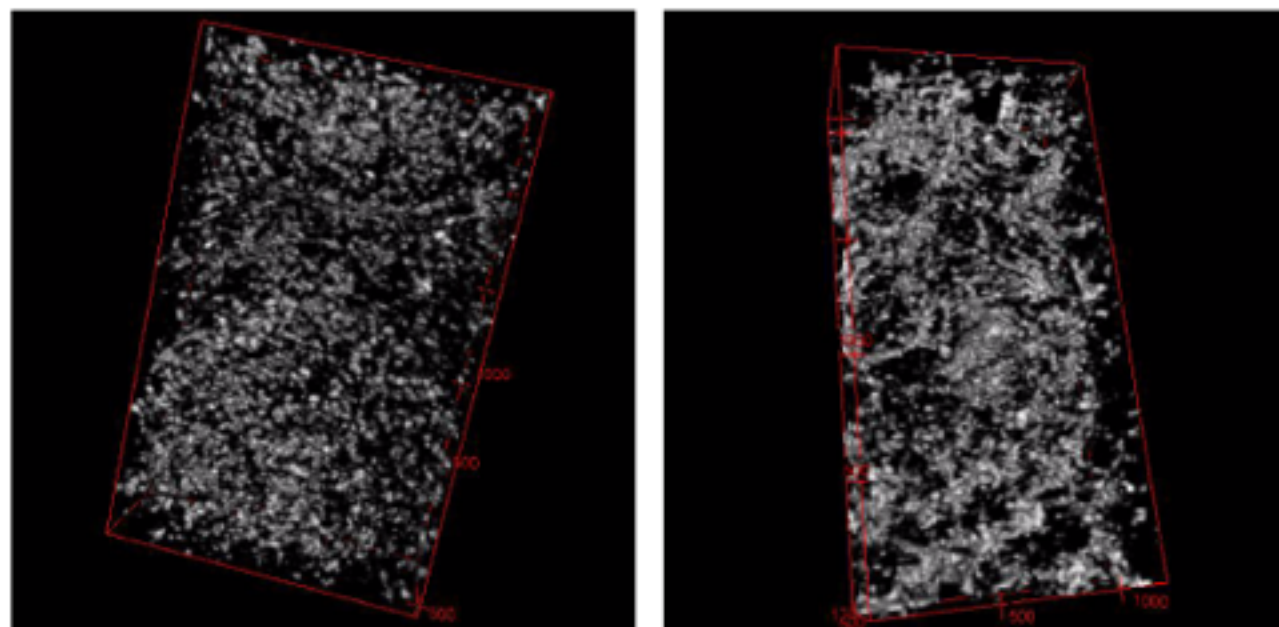
- Each image 100 μm square and 9.8 nm pixel size
- SIA is 0.0024 (0.0002) nm²/nm³



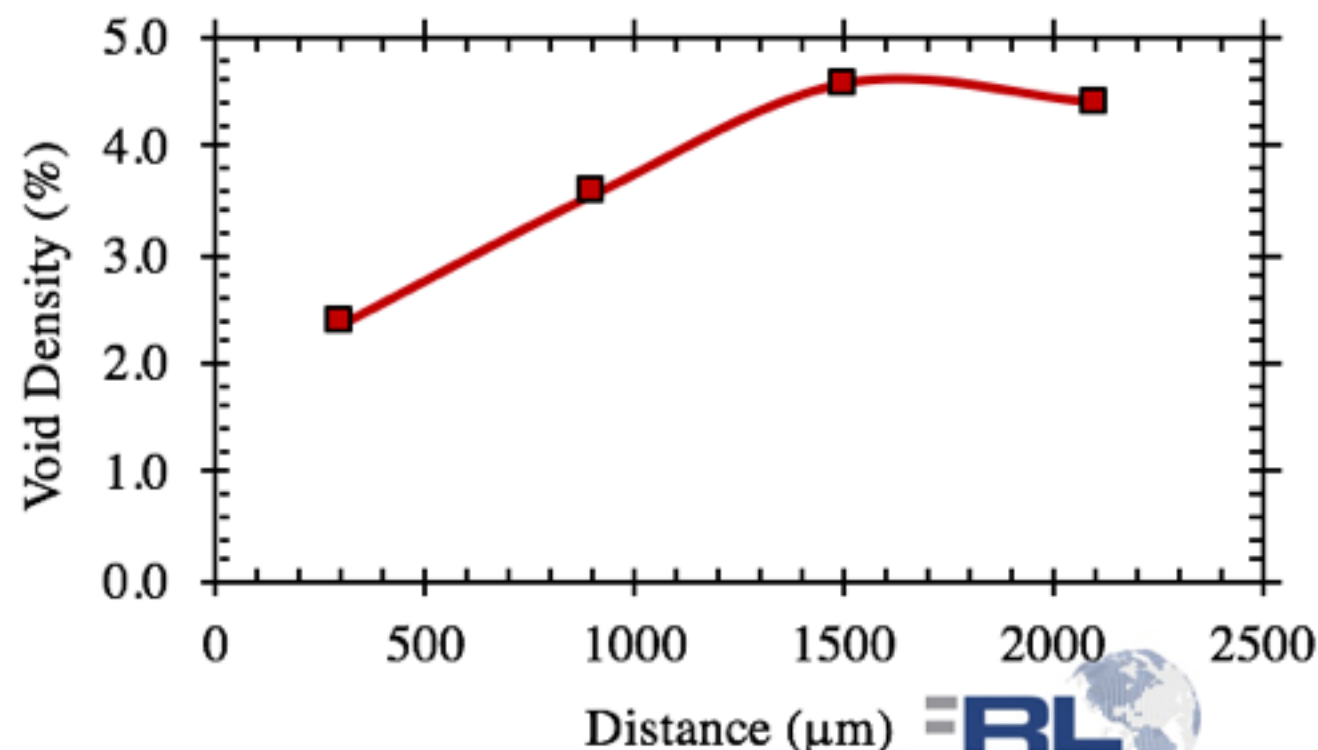
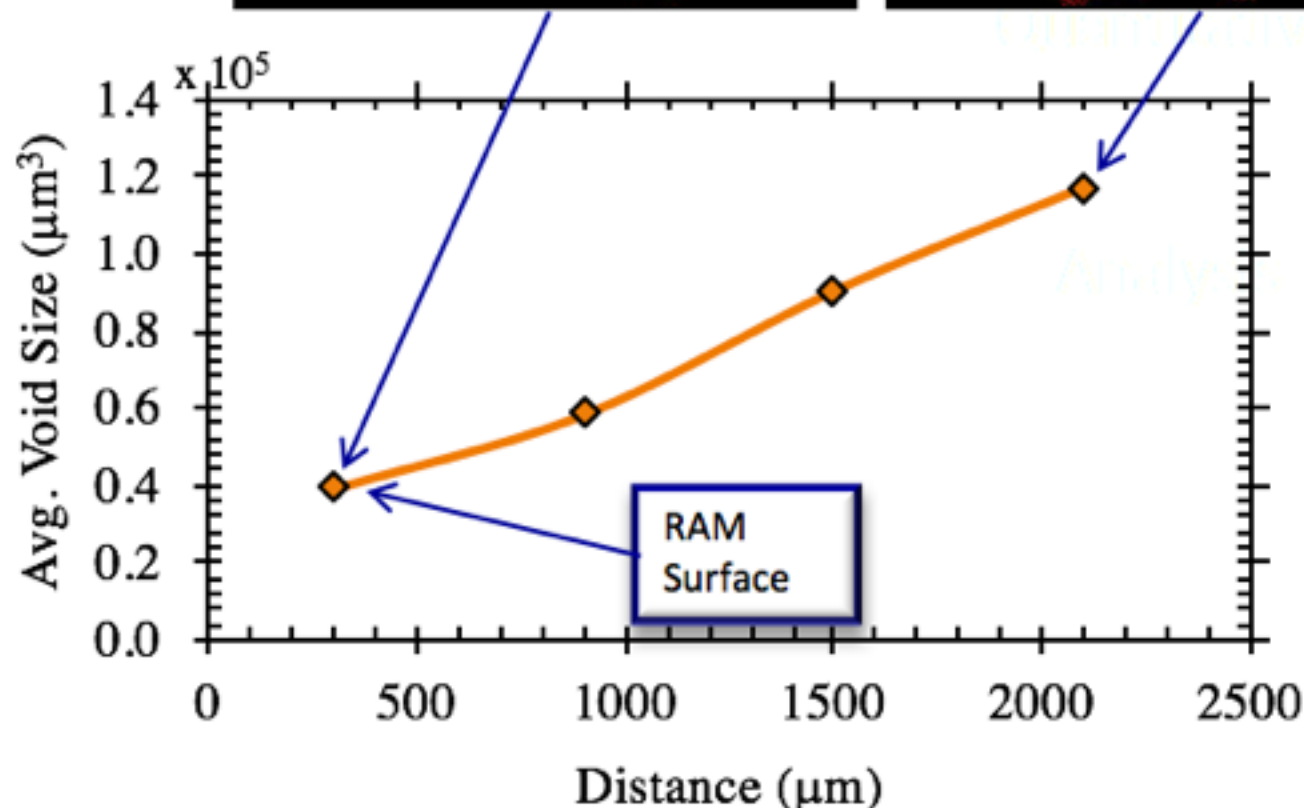


Class 1 XCMT Data

Class 1 data obtained for 3 mm pellet at 94% TMD



- Dynamic face of the press is correlating to higher cracking of crystals, i.e. higher observed calculated density
- Observed > 500 micron crystals with voids 20-60 μm in size in the center

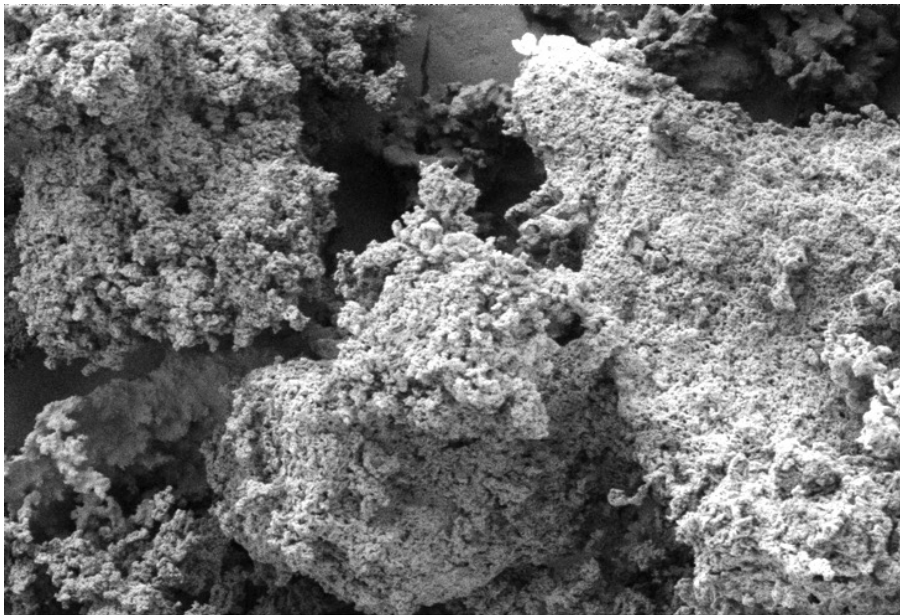


TATB STUDY: THREE ORDERS OF MAGNITUDE

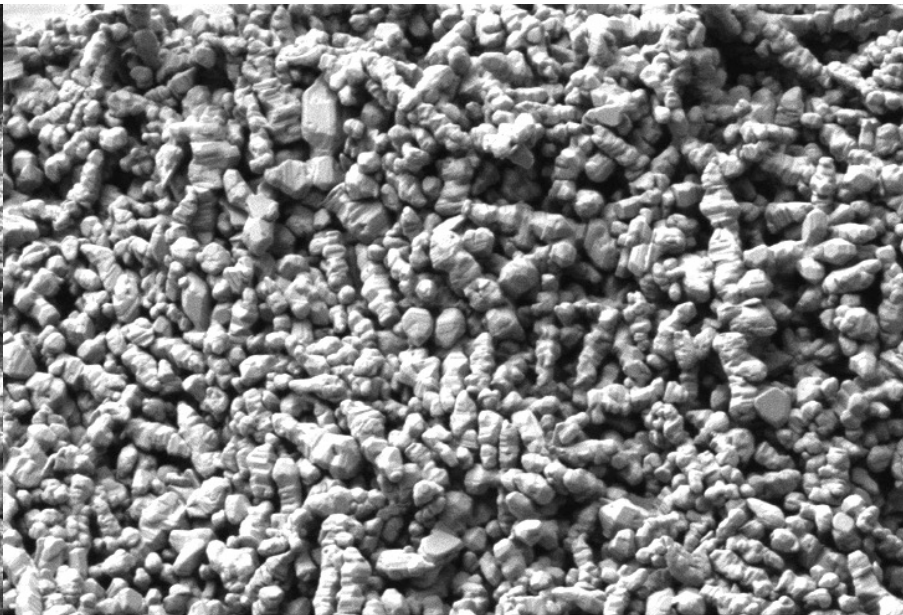
ARDEC

SNL

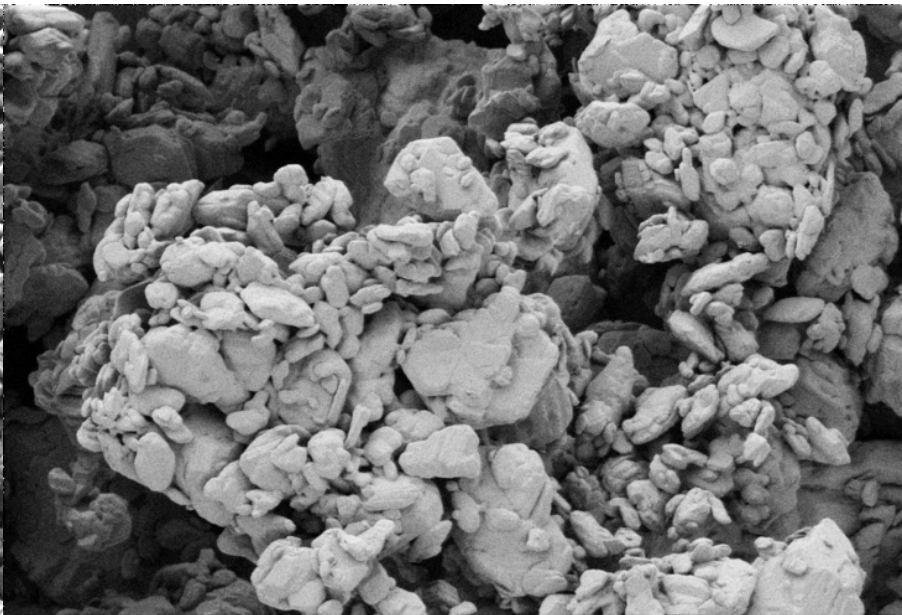
PANTEX



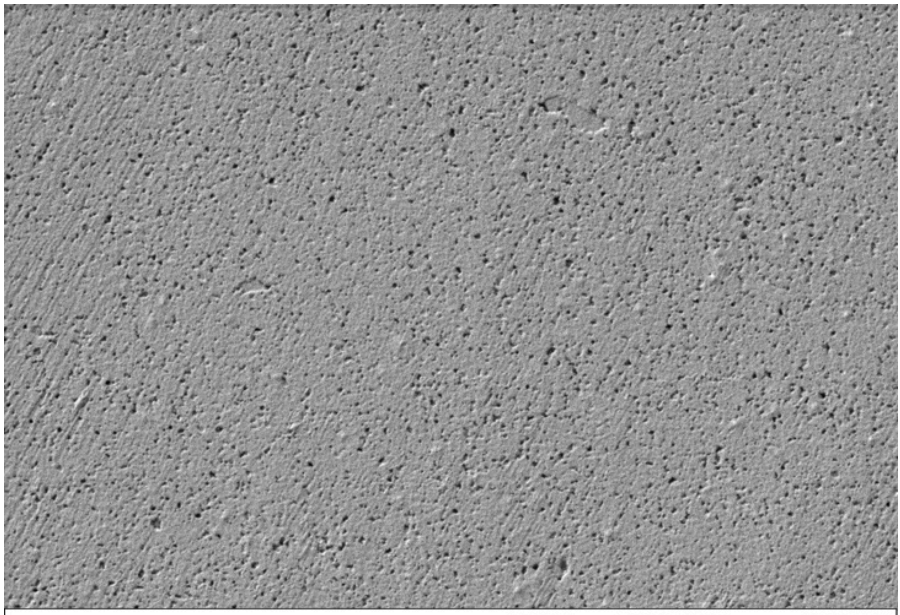
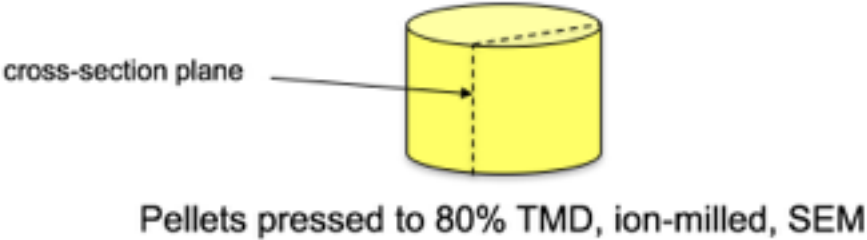
TATB - Nano
File= Nano_25um-2.tif
2 μ m
4.57 K X
1.10 kV
SE2
Width = 25.03 μ m
Stage at T = 10.0 °
WD = 4.9 mm
8 Sep 2015
Mag> Polaroid 545
1.56e-004 Pa



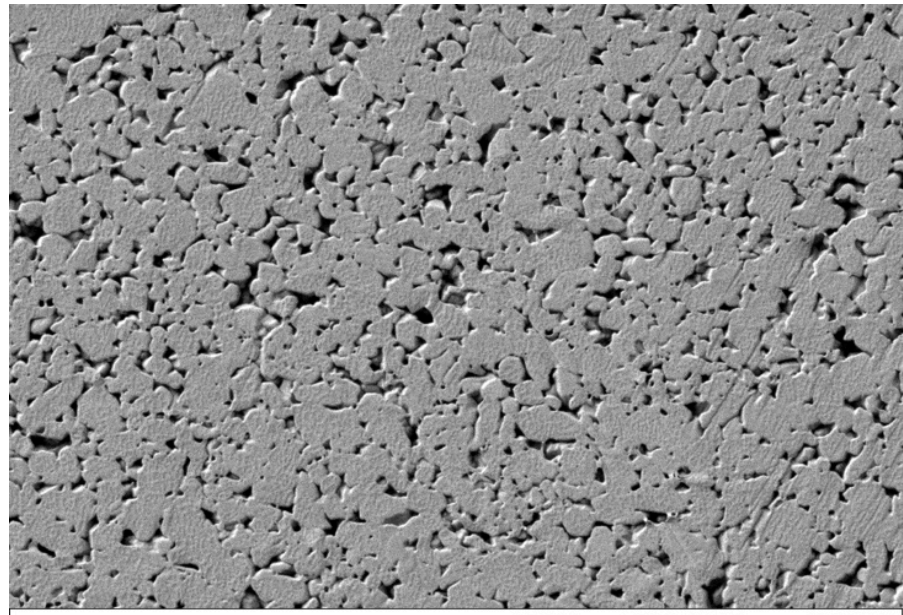
ZB
File= ZB_10um-1.tif
1 μ m
11.43 K X
1.10 kV
SE2
Width = 10.00 μ m
Stage at T = 5.6 °
WD = 4.6 mm
29 Sep 2015
Mag> Polaroid 545
1.55e-004 Pa



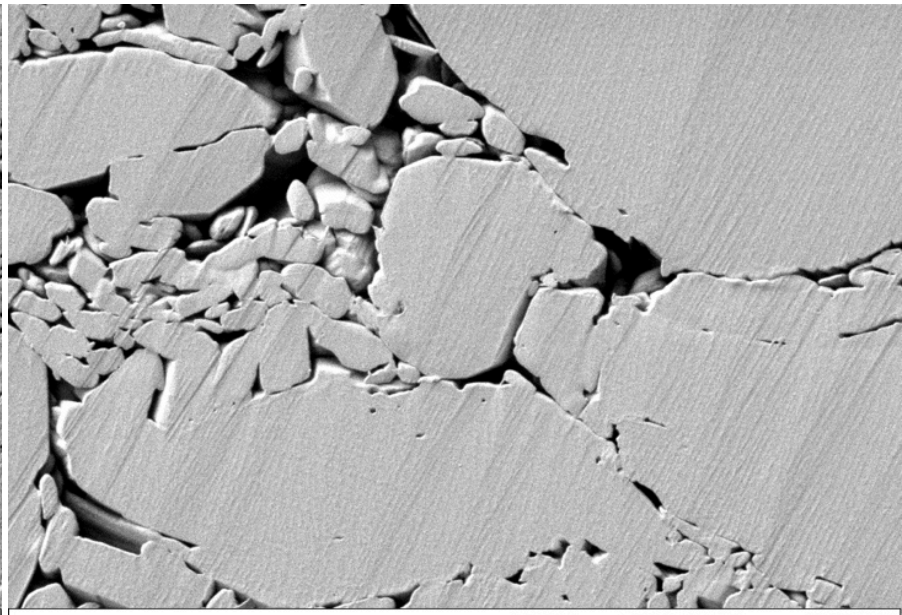
TATB - UF
File= UF_25um-2.tif
2 μ m
4.57 K X
1.10 kV
SE2
Width = 25.00 μ m
Stage at T = 10.0 °
WD = 4.8 mm
8 Sep 2015
Mag> Polaroid 545
1.77e-004 Pa



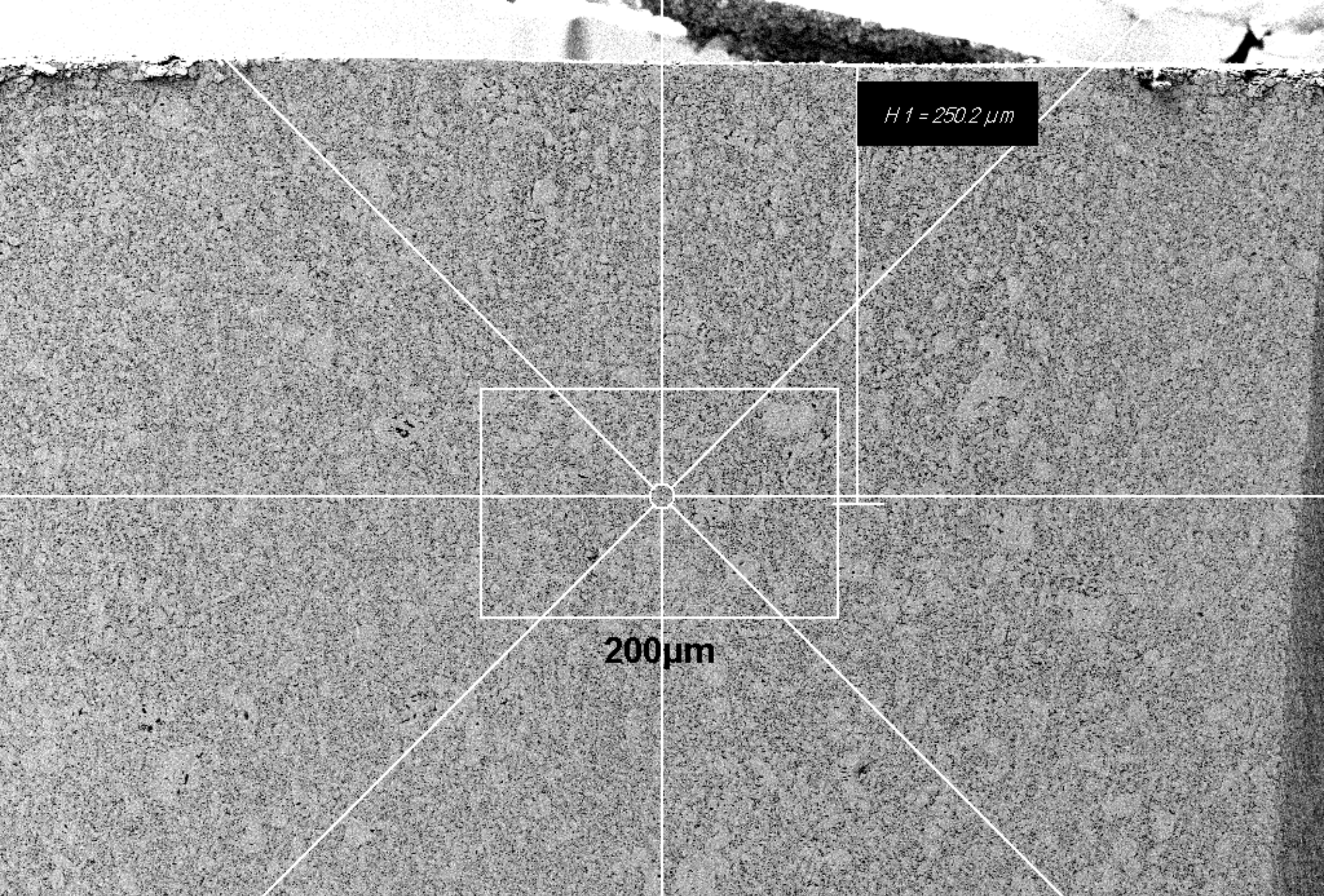
#5 Nano
File= 5-Nano_10um-2.tif
1 μ m
11.43 K X
1.10 kV
SE2
Width = 10.00 μ m
Stage at T = 0.0 °
WD = 4.4 mm
30 Sep 2015
Mag> Polaroid 545
1.29e-004 Pa



#2 ZB
File= 2-ZB_10um-2.tif
1 μ m
11.43 K X
1.10 kV
SE2
Width = 10.000 μ m
Stage at T = 0.0 °
WD = 4.4 mm
30 Sep 2015
Mag> Polaroid 545
1.28e-004 Pa



#7 UF
File= 7-UF_10um-1.tif
1 μ m
11.43 K X
1.10 kV
SE2
Width = 10.000 μ m
Stage at T = 0.0 °
WD = 4.6 mm
30 Sep 2015
Mag> Polaroid 545
1.29e-004 Pa



TATB Ultra-Fine (7)

File= Ultra-Fine_IP_16K Area.tif

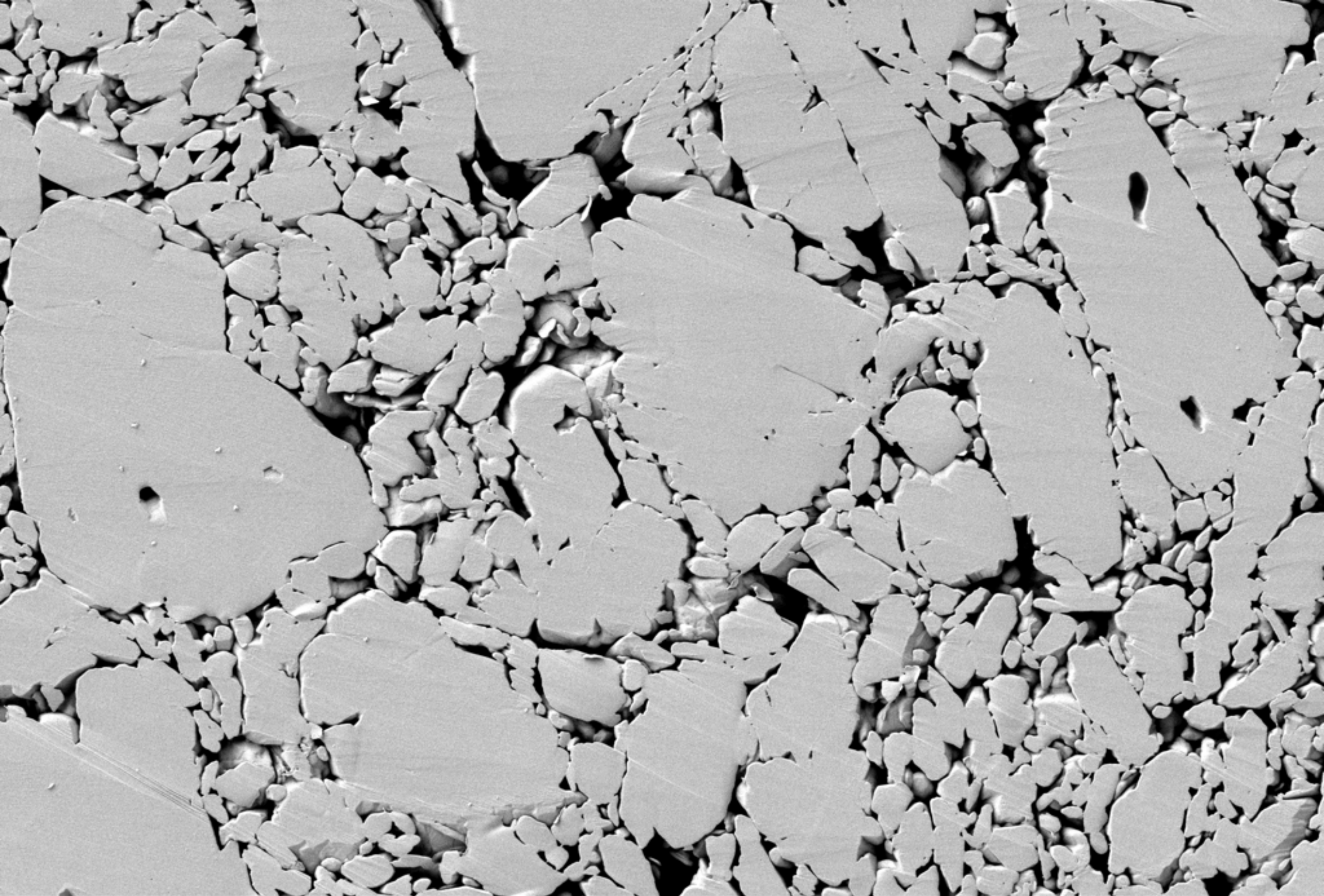
100 µm



151 X
1.10 kV
SE2

Width = 755.8 µm
Stage at T = 0.0 °
WD = 3.8 mm

14 Jul 2016
Mag> Polaroid 545
0.00e+000 Pa

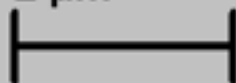


TATB Ultra-Fine (7)

File= Ultra-Fine_IP_25um-2048.tif



2 μm

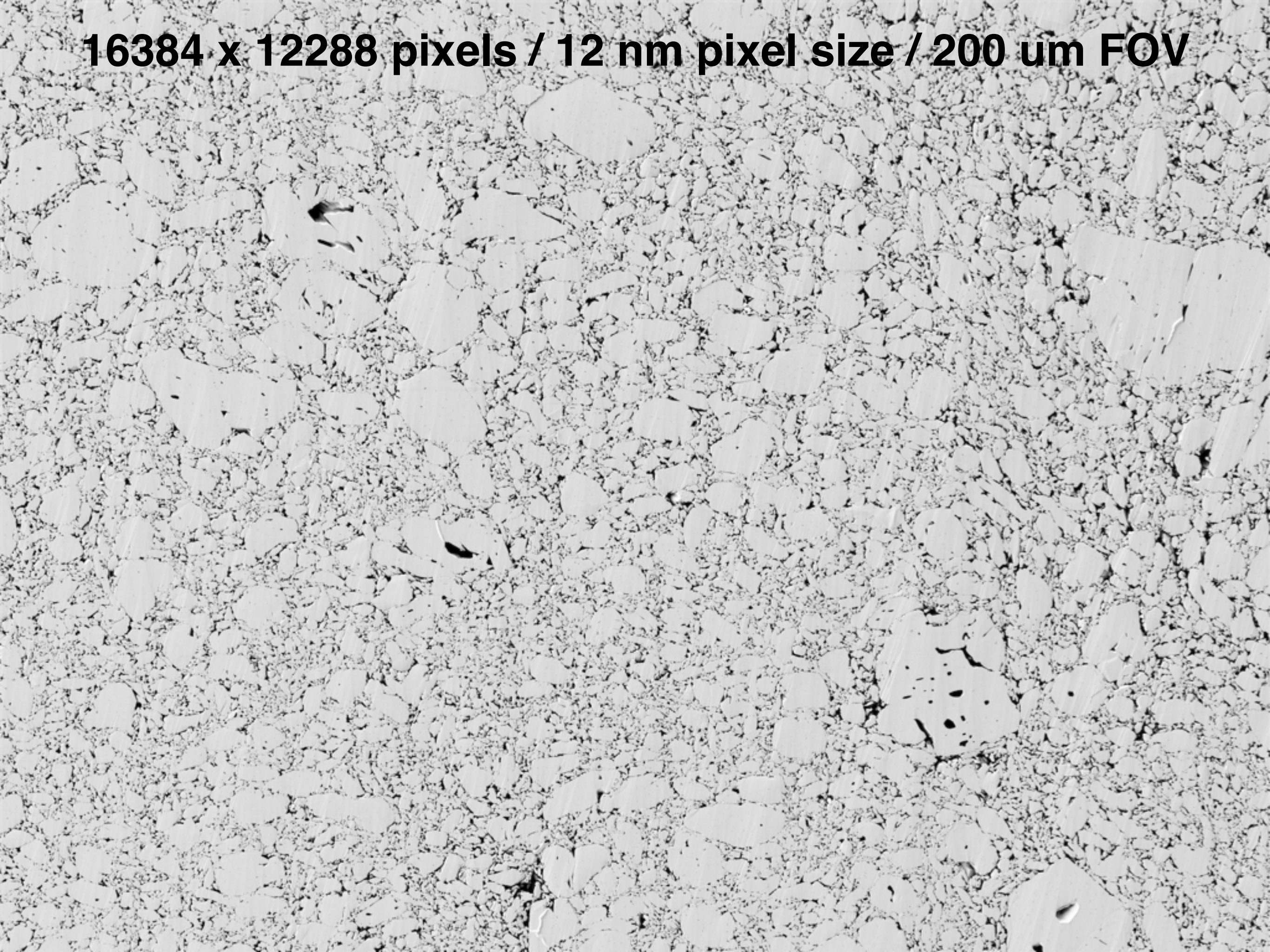


4.57 K X
1.10 kV
SE2

Width = 25.00 μm
Stage at T = 0.0 °
WD = 4.5 mm

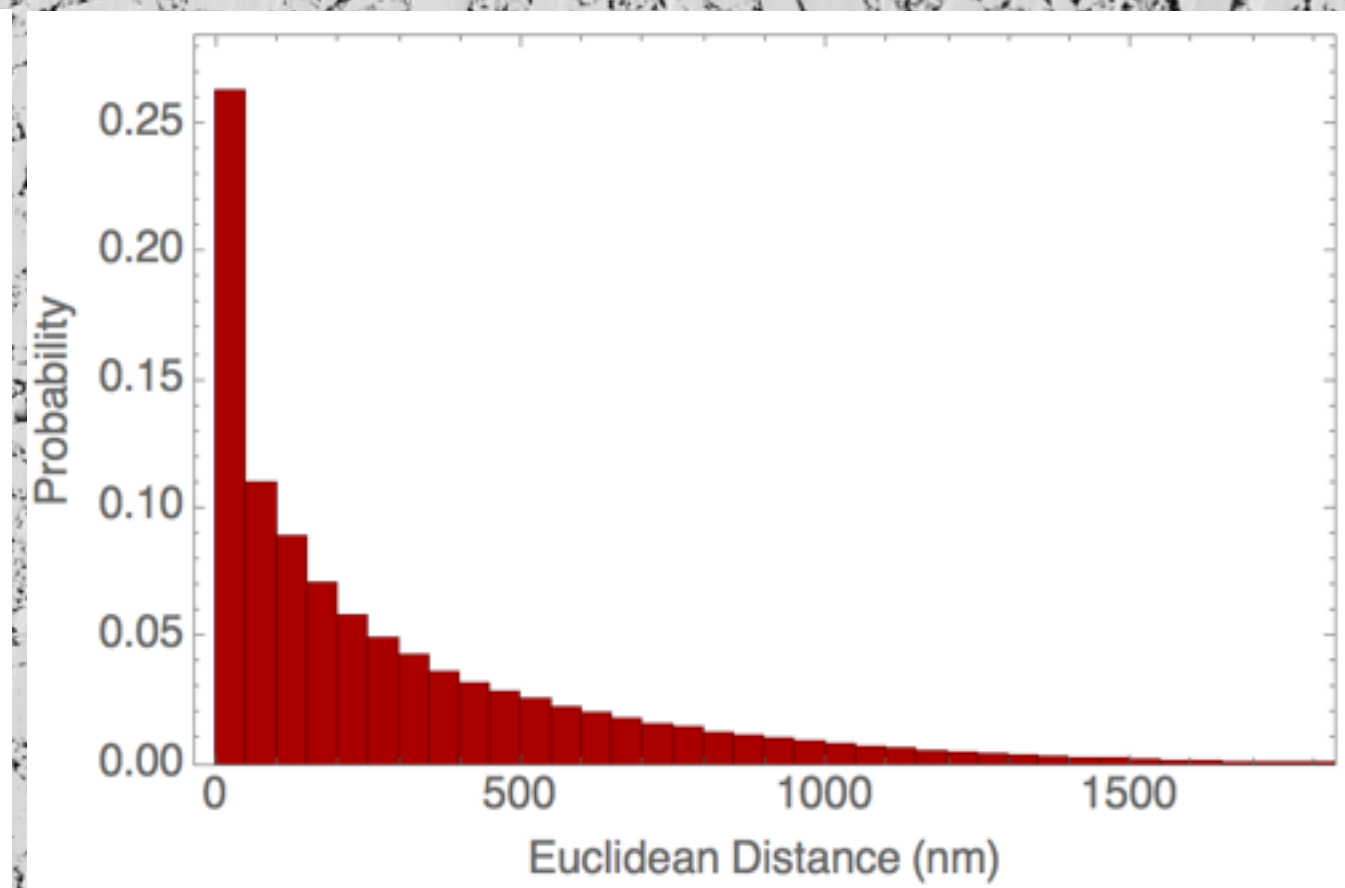
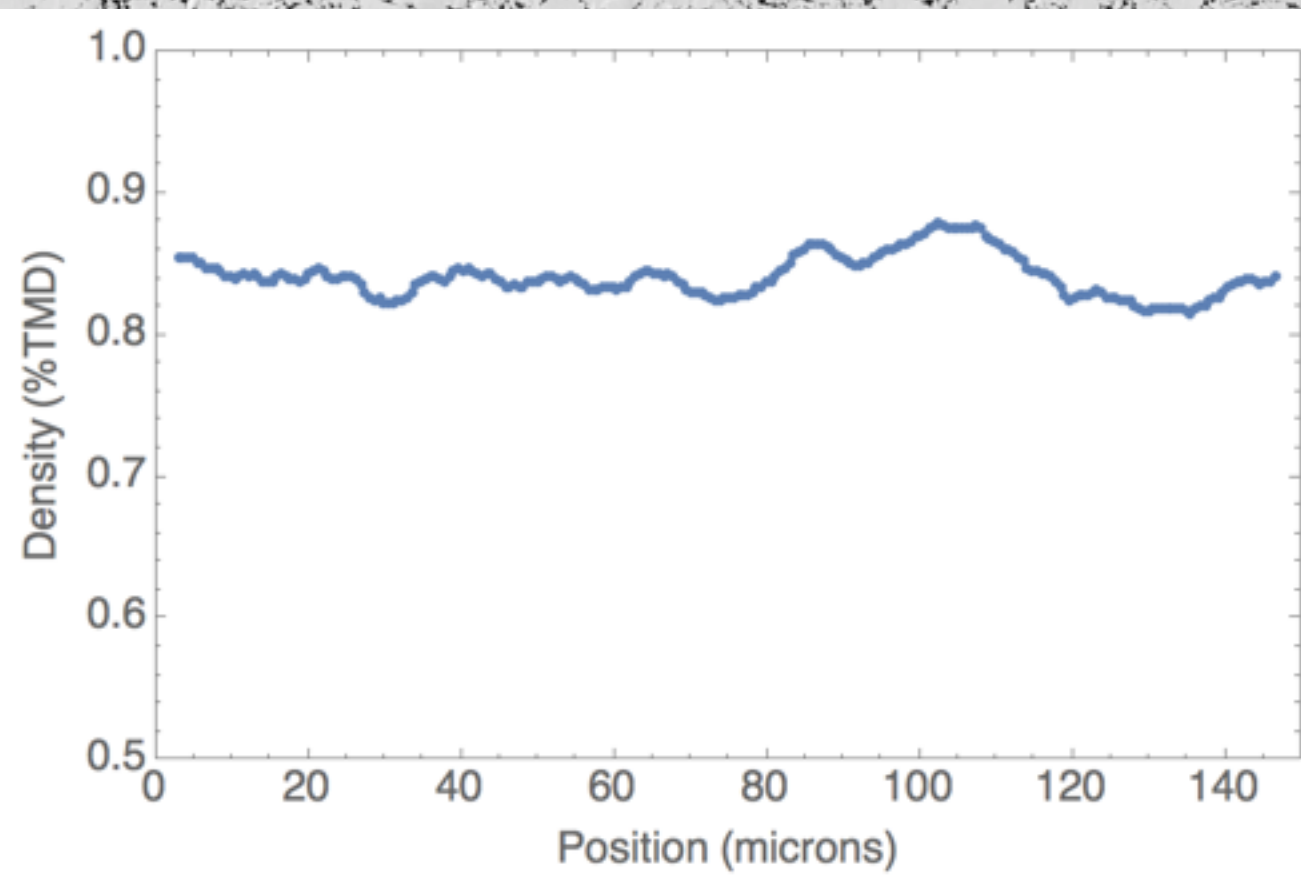
8 Jul 2016
Mag> Polaroid 545
0.00e+000 Pa

16384 x 12288 pixels / 12 nm pixel size / 200 um FOV

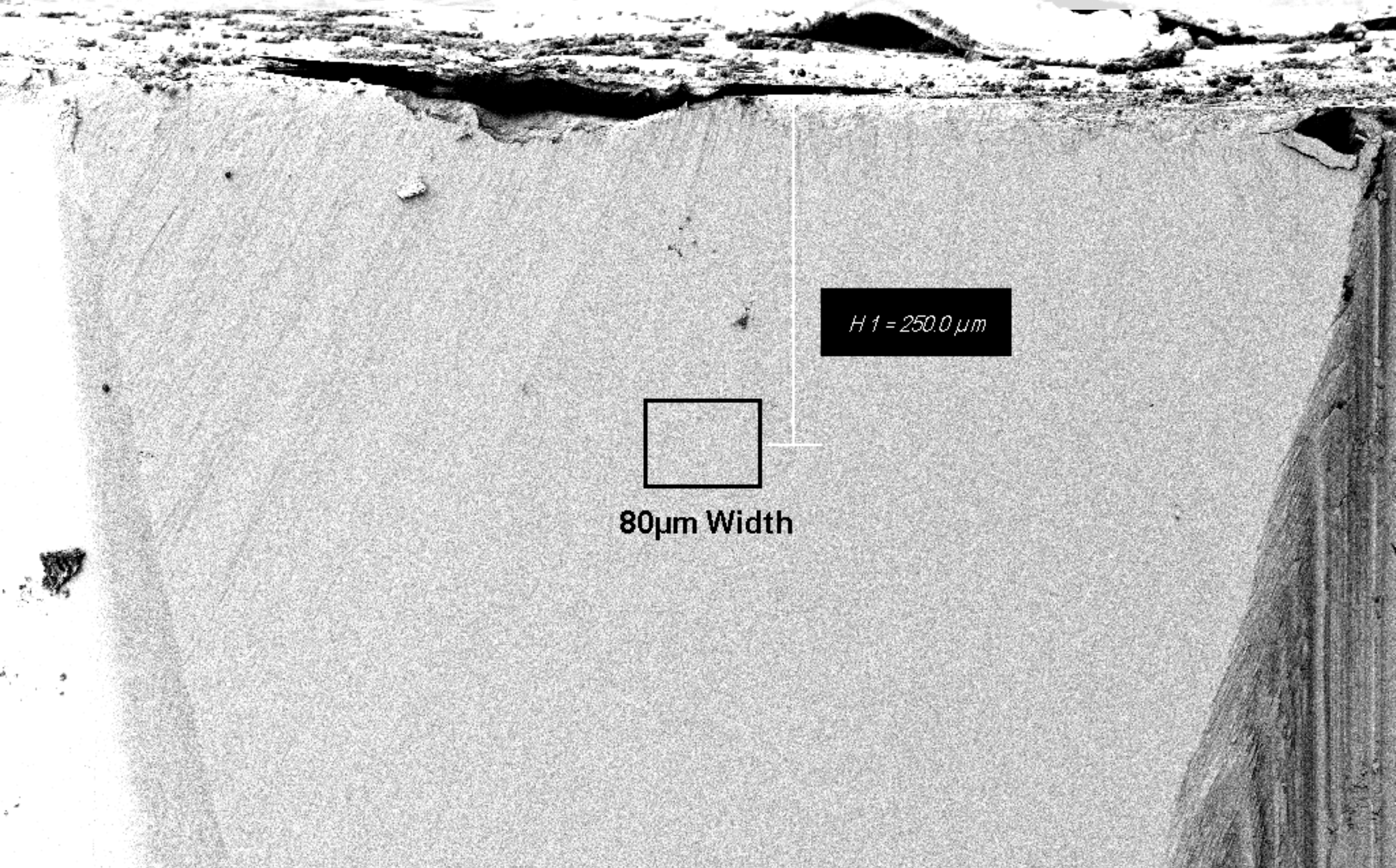


16384 x 12288 pixels / 12 nm pixel size / 200 um FOV

80% TMD
500 Bin width
50 step size



NANO-TATB (ARDEC: RAJ PATEL, VICTOR STEPANOV)



TATB Nano-Powder (5)

File= Nano16K Area.tif

100 μm
|-----|

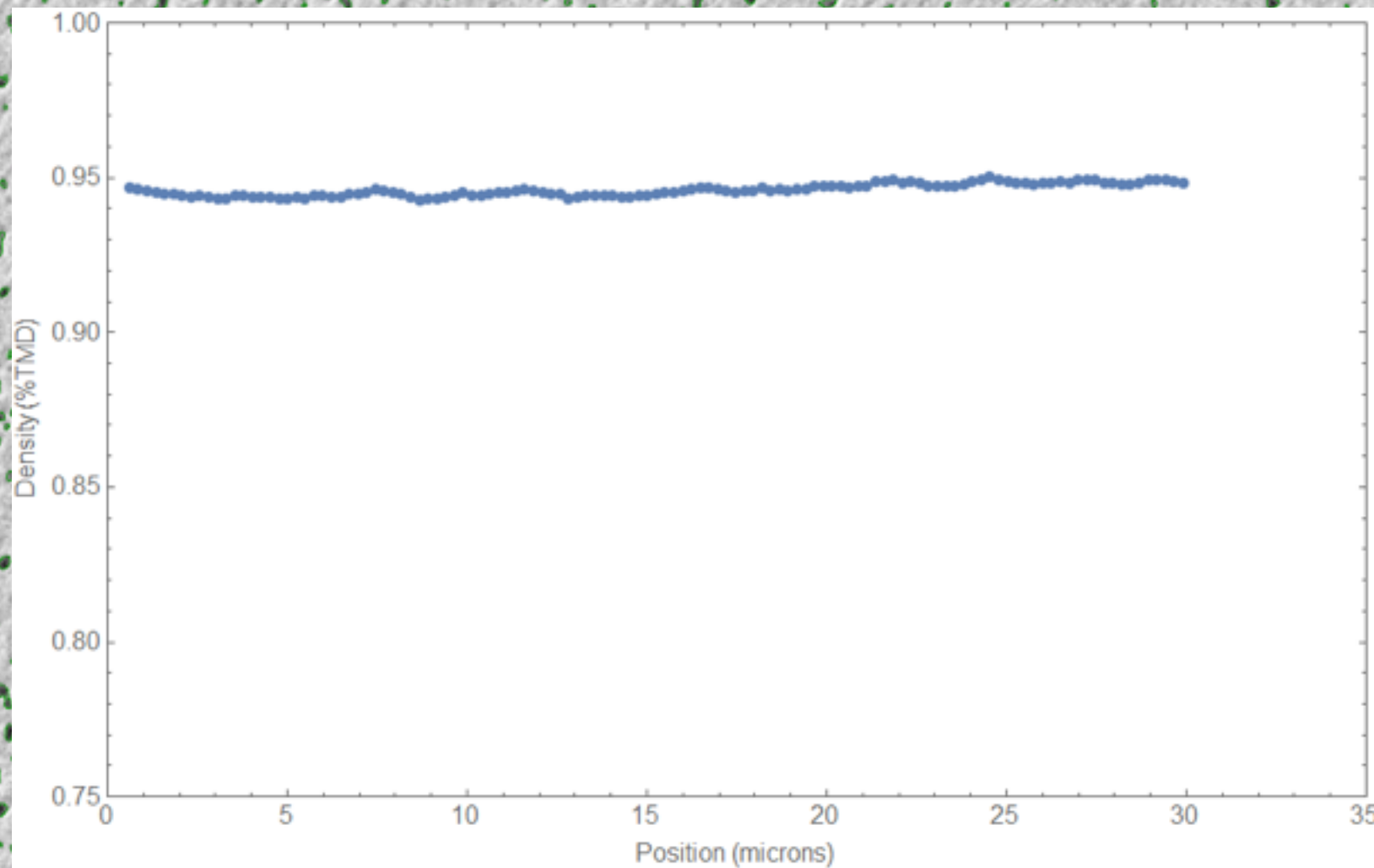
114 X
1.50 kV
SE2

Width = 1000.0 μm
Stage at T = -0.1 °
WD = 4.4 mm

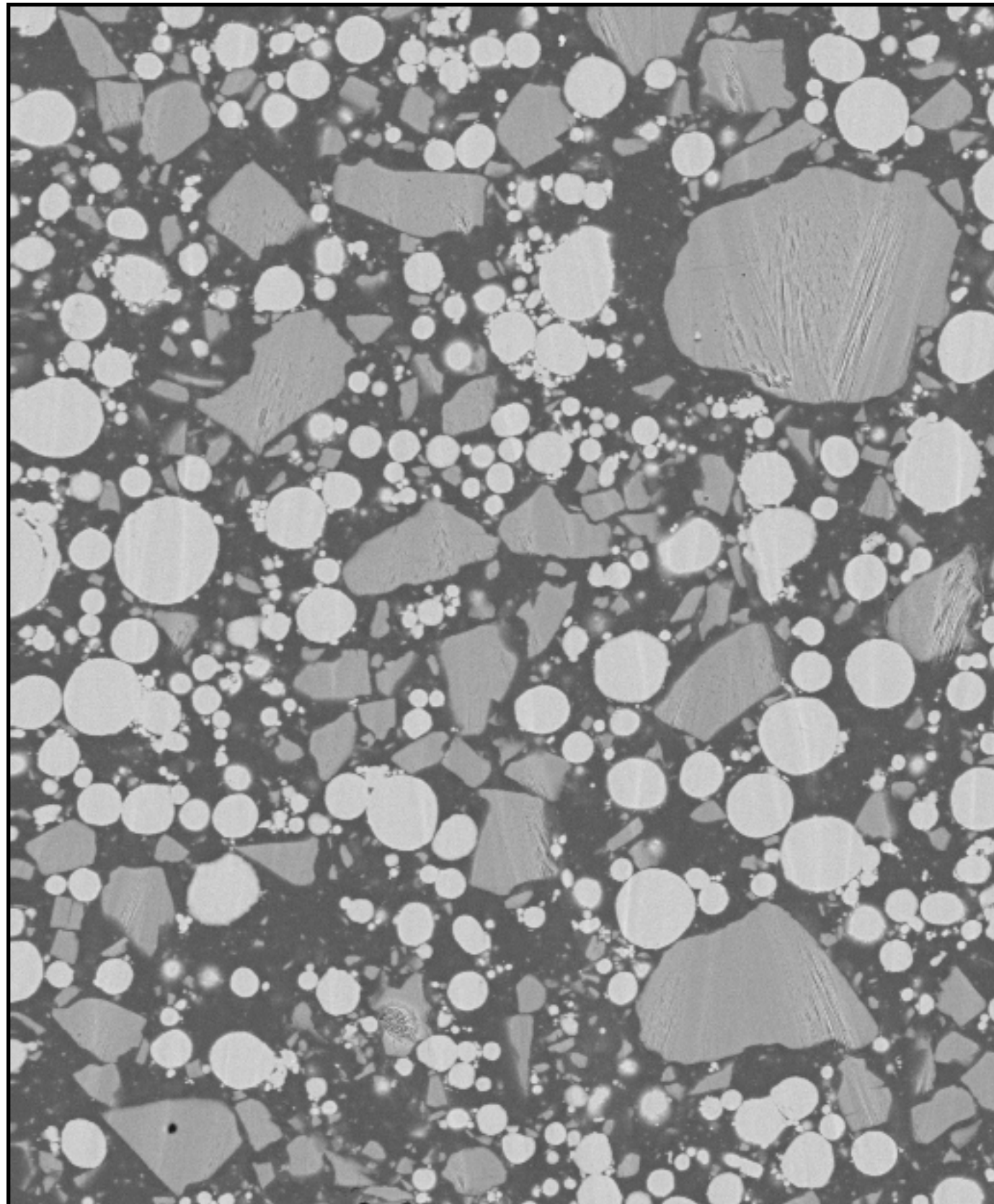
13 Jul 2016
Mag> Polaroid 545
0.00e+000 Pa



Density too high? Location in pellet?
Maybe even the SEM can't resolve the pores.
Perhaps AFM? FIB into center of pellet?

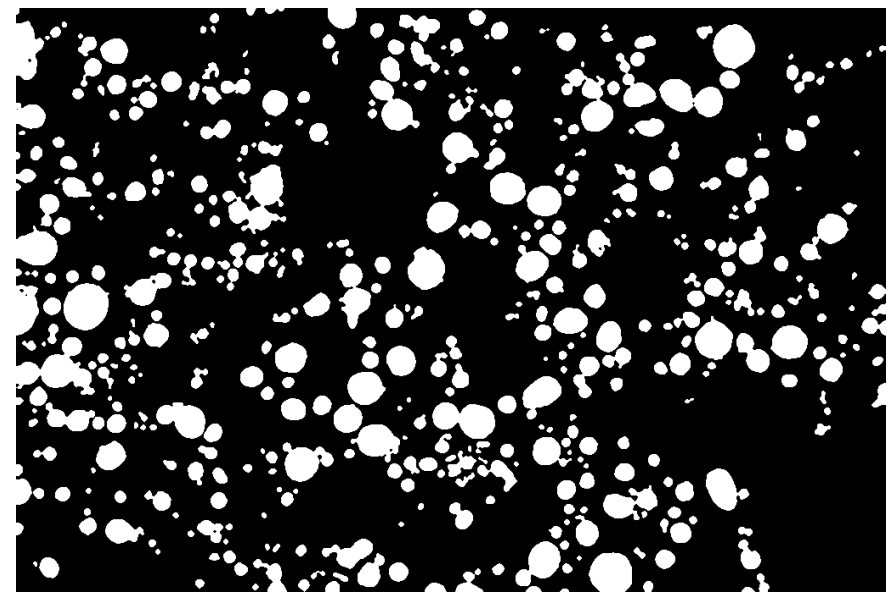


COMPOSITE PROPELLANT

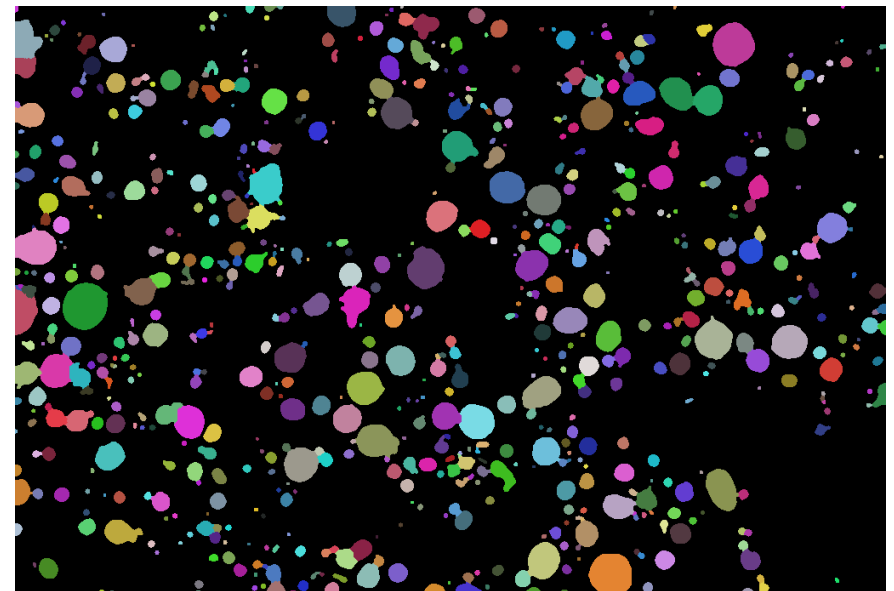


TP-H-3340 TU126280
Ion Polished Surface
File= 500um-BSE-1.tif

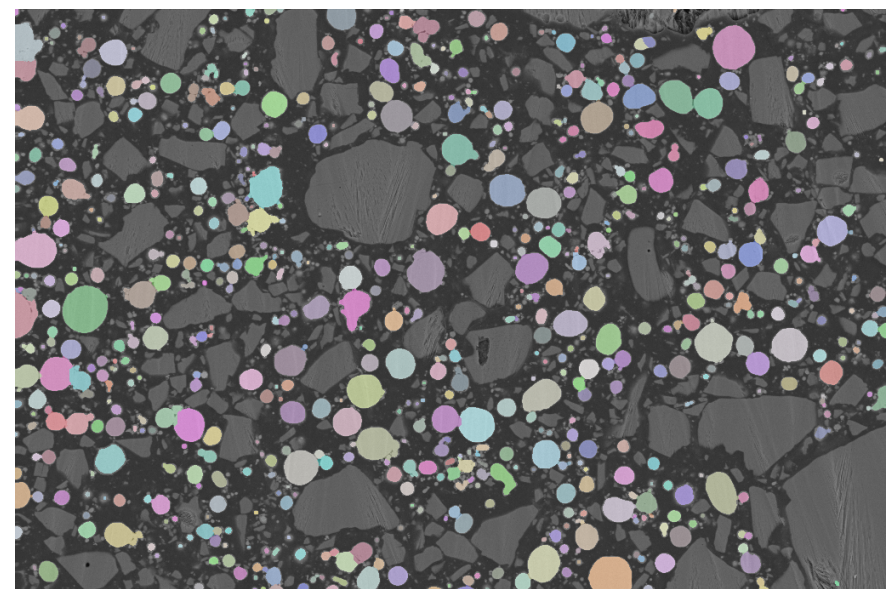
20 μm
┌───┐
└───┘



Binary image of aluminum particles



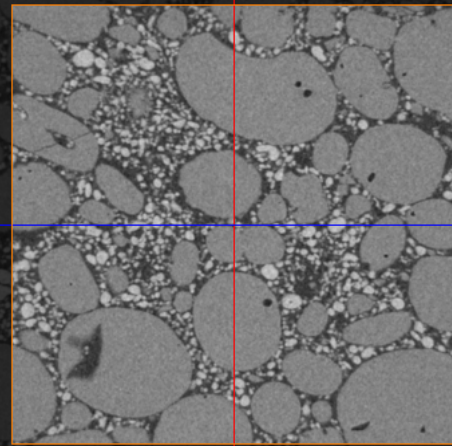
Identify and measure individual particles



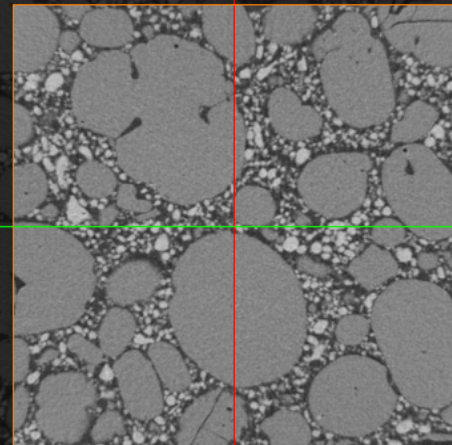
Overlay of aluminum particles onto original

APCP, 3 um pixels, 3 mm FOV

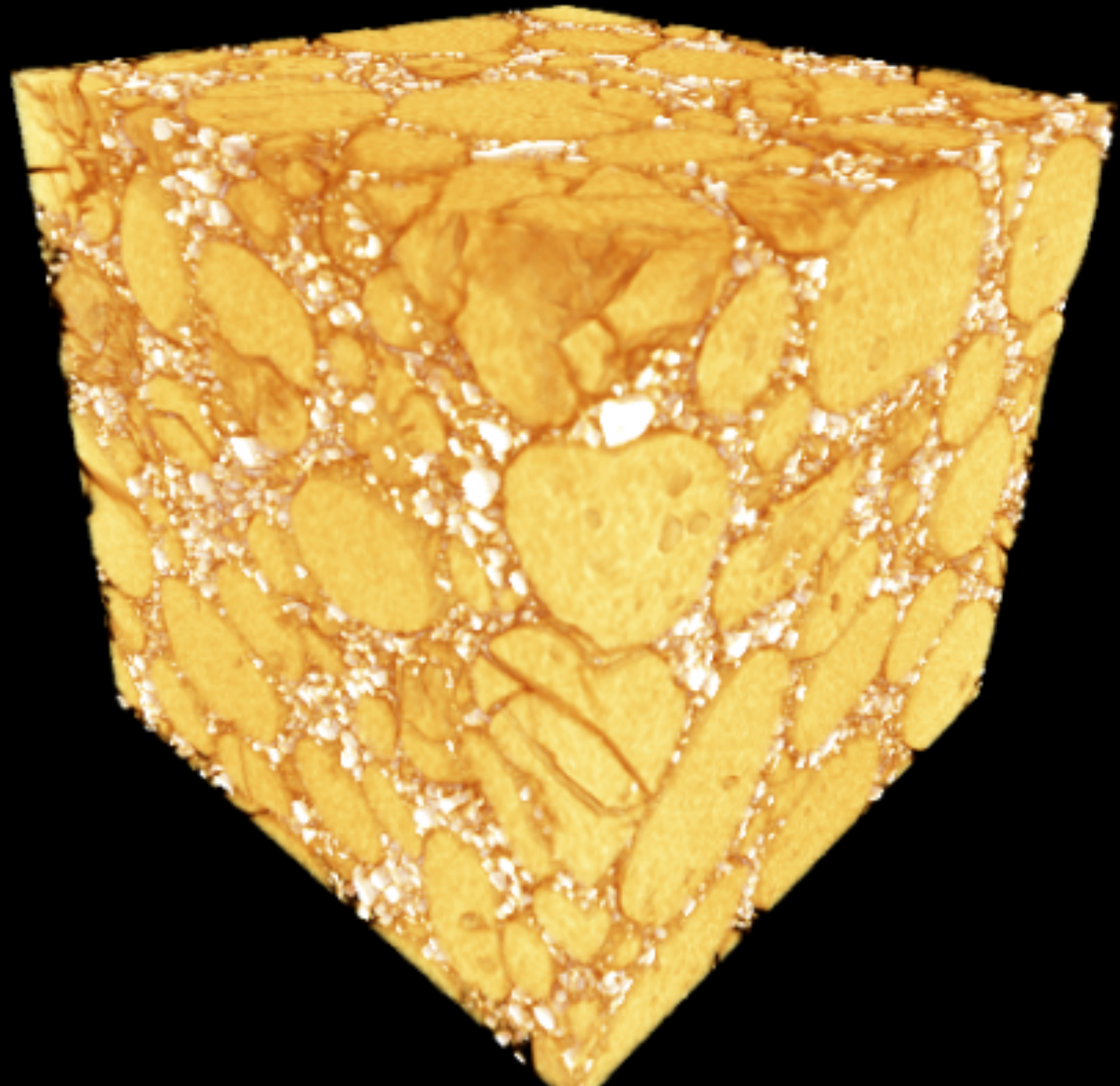
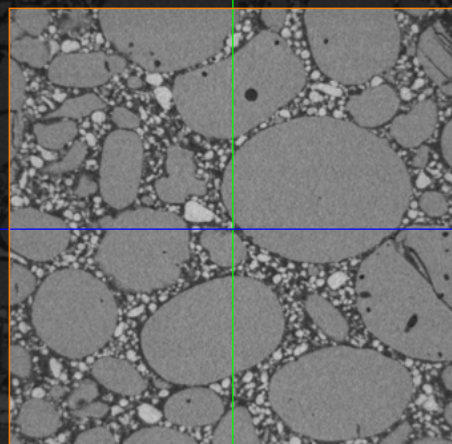
XZ
507 / 1013
C 32768 W 65535



XY
497 / 993
C 32768 W 65535

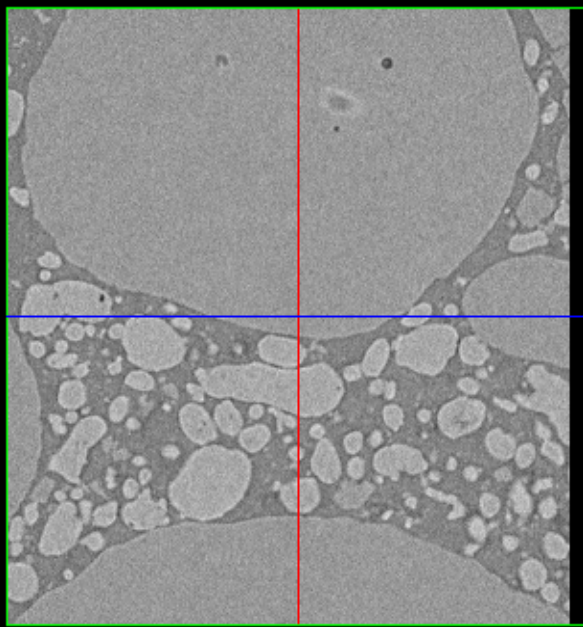


YZ
497 / 992
C 32768 W 65535

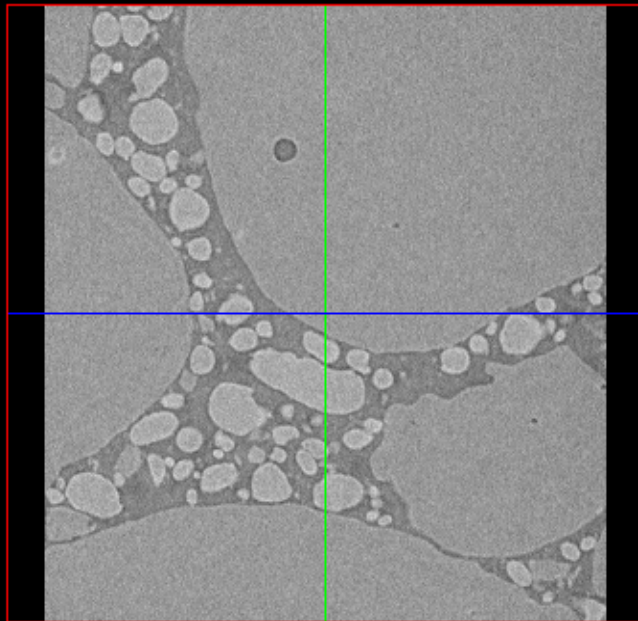


480 nm pixels, 437 μm FOV

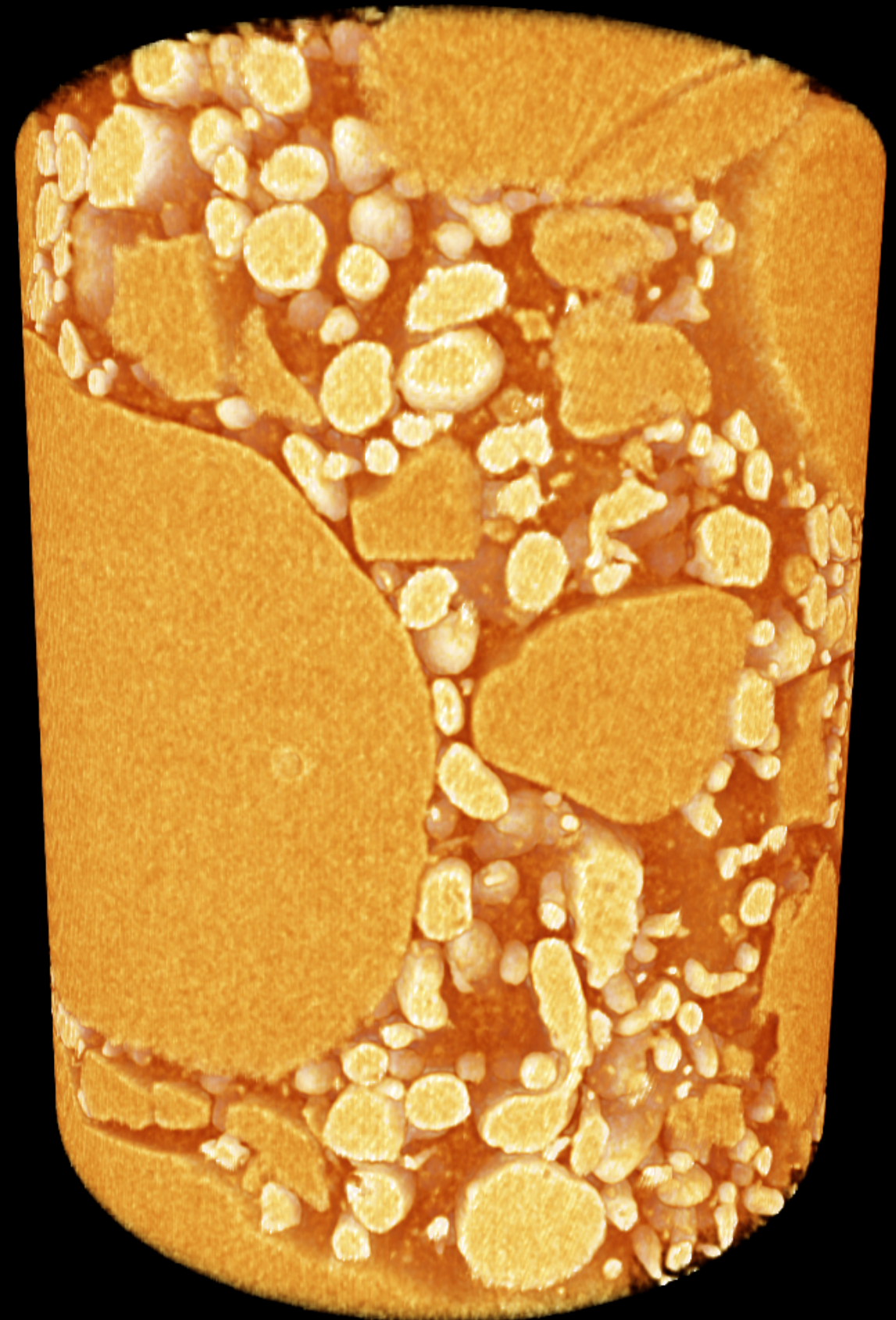
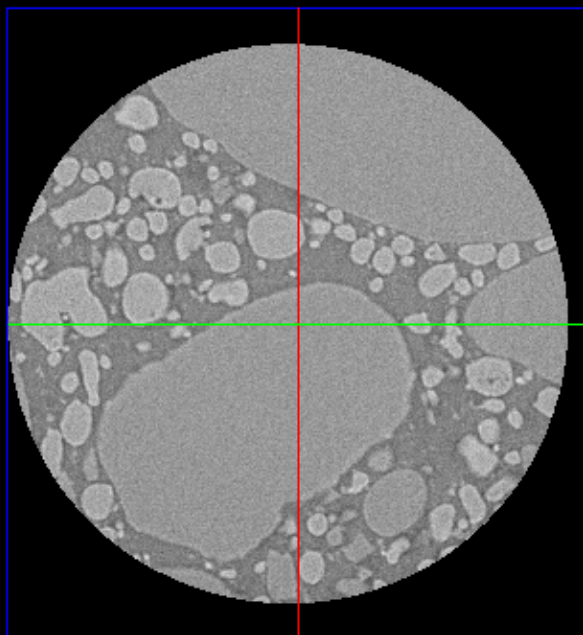
XZ
498 / 994
C 31548 W 63096



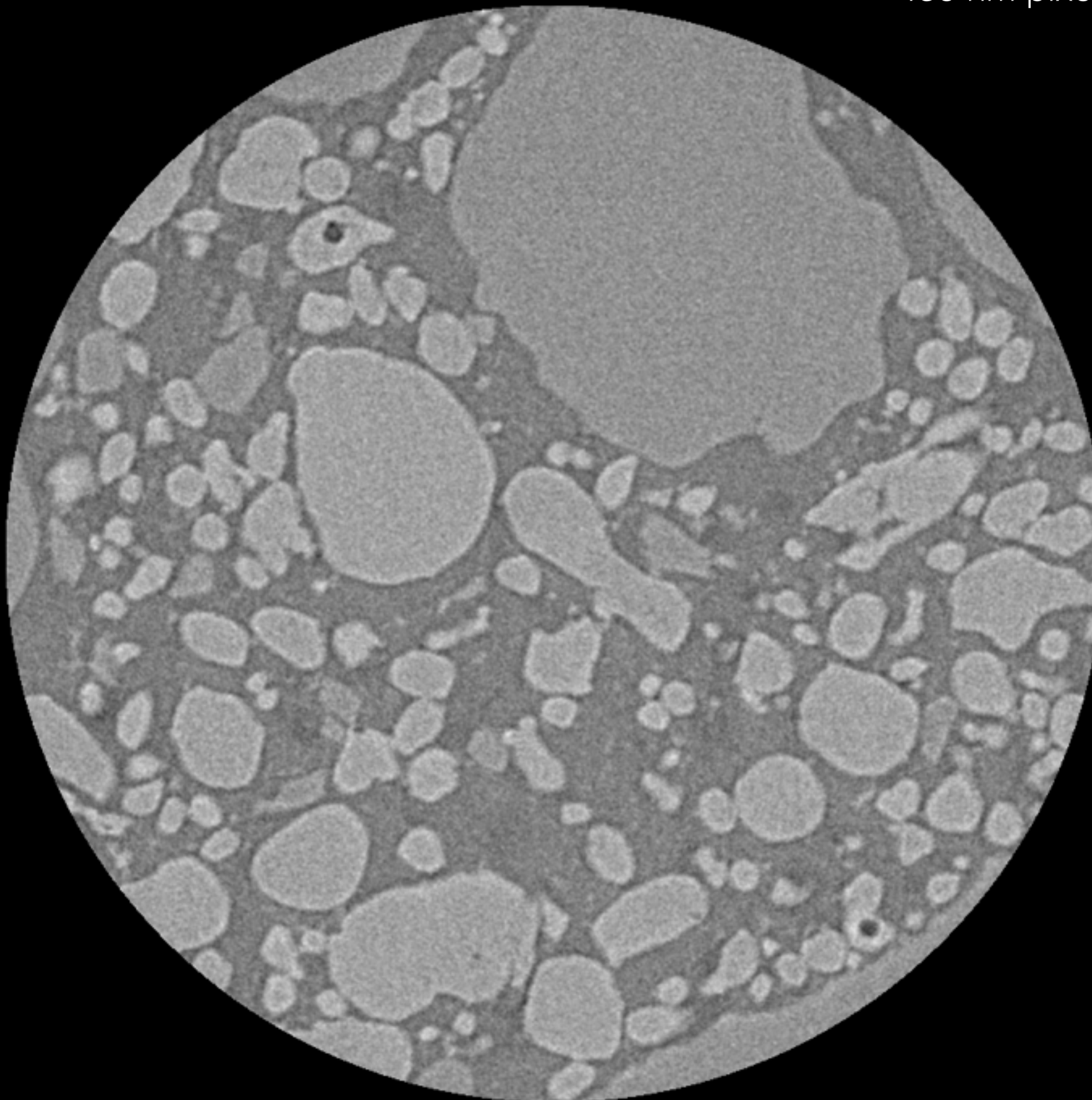
YZ
457 / 912
C 31548 W 63096



XY
481 / 960
C 31548 W 63096



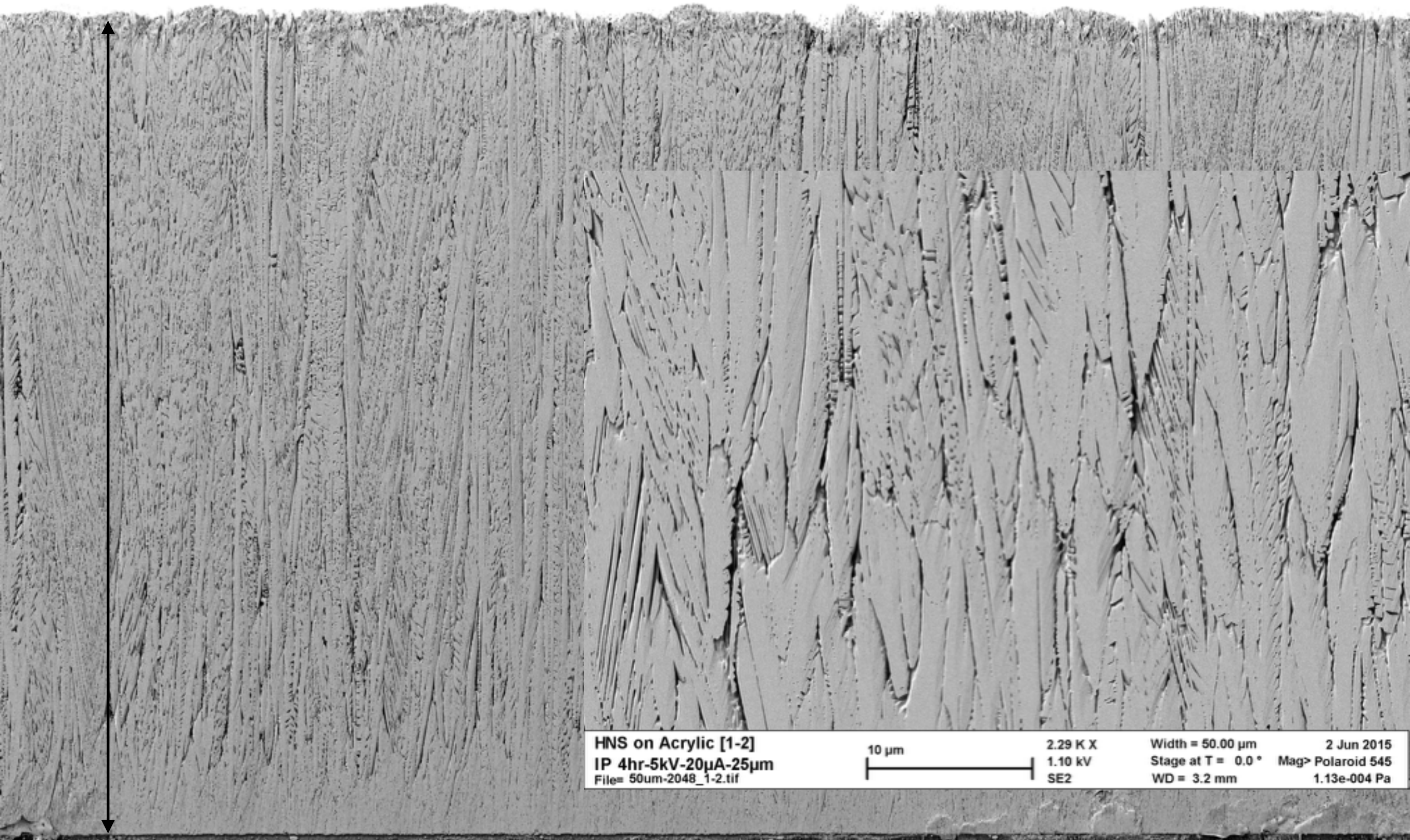
480 nm pixels, 437 μm FOV



Samples: Vapor-deposited HNS (50-200um thick)

These samples are extremely cool

~100 um



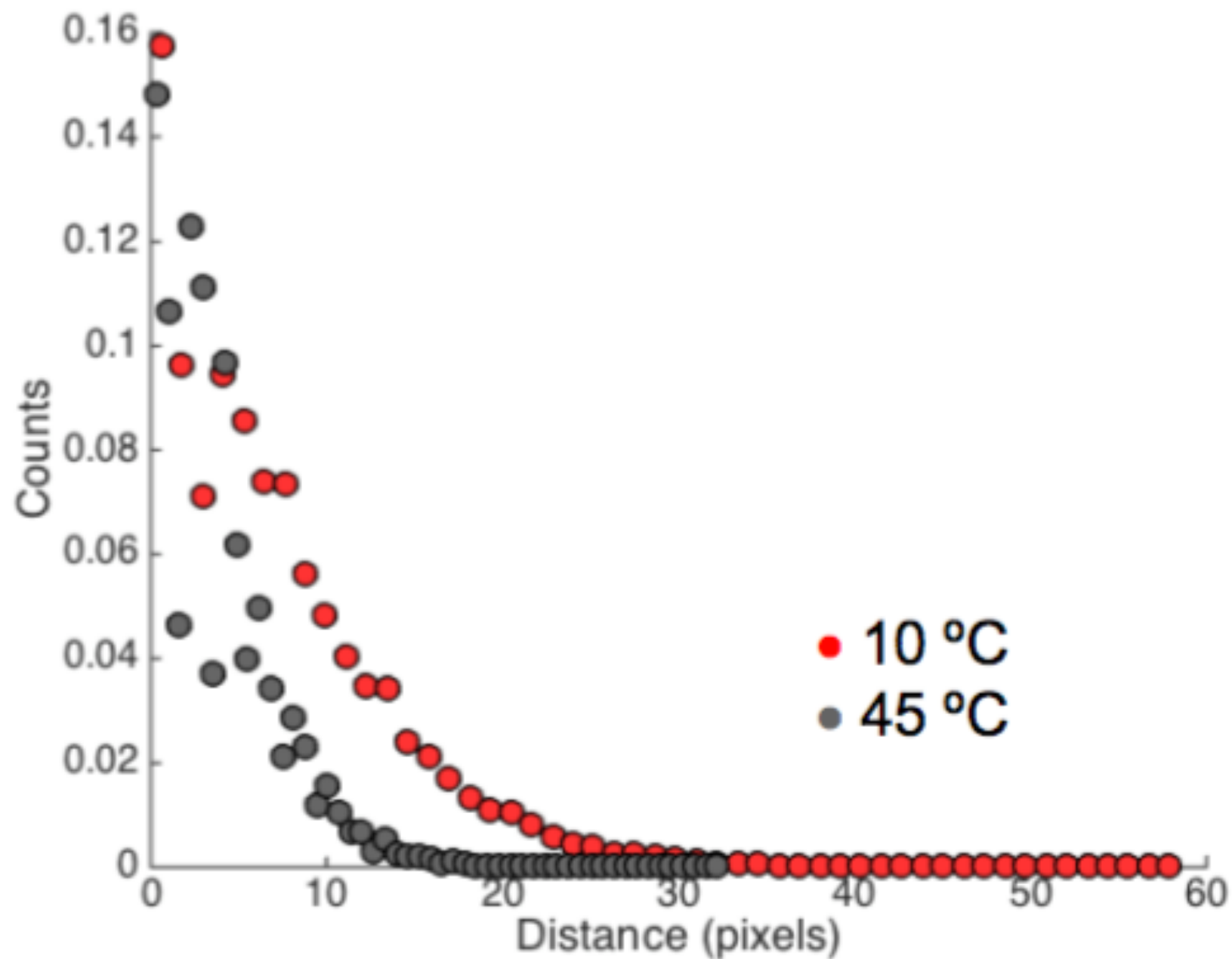
SEM of ion milled cross-section

10 C



45 C

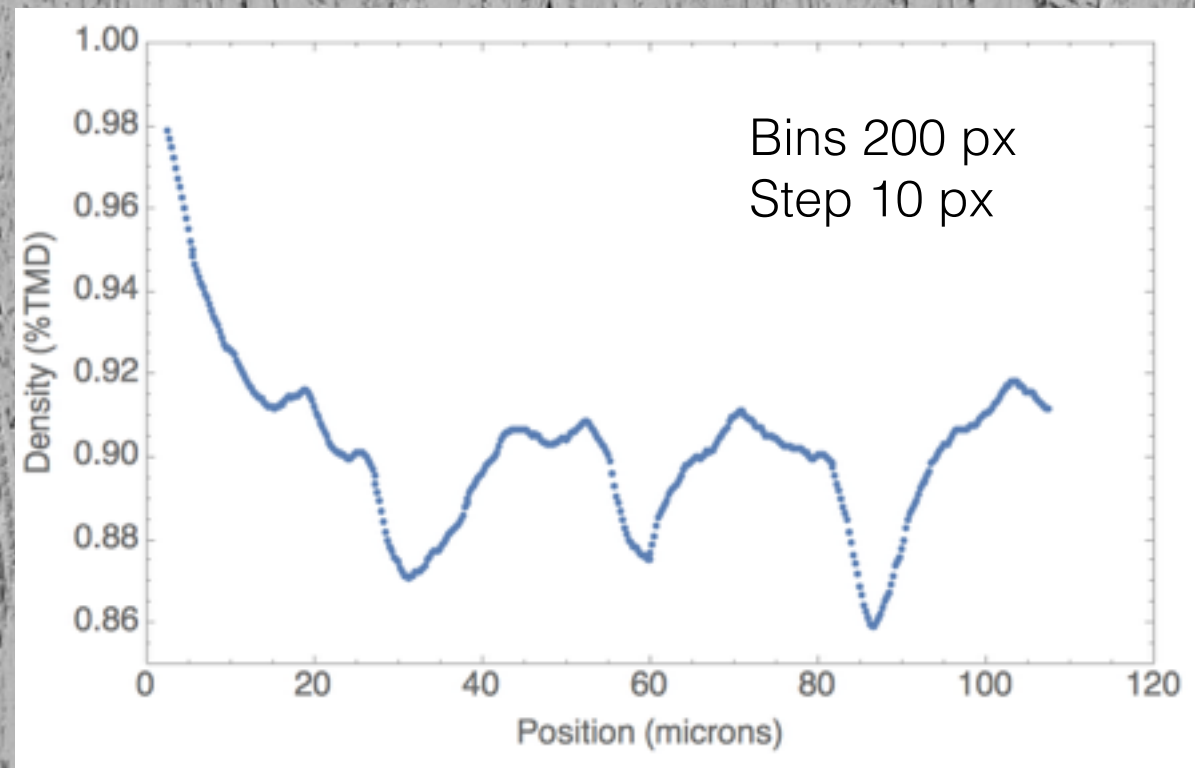




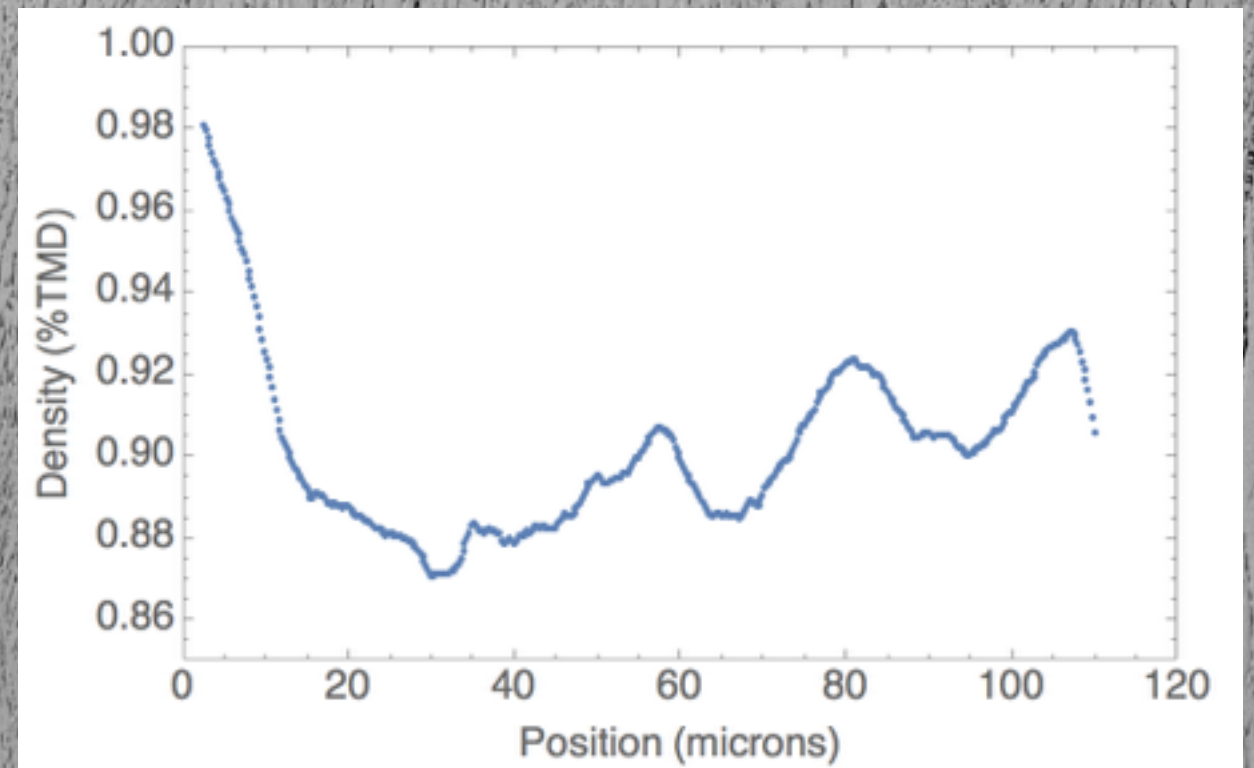
Histogram of a Euclidean distance map indicating distances from any pixel to a pore in HNS films deposited at 10 °C and 45 °C.

DENSITY VARIATION IN HNS FILMS

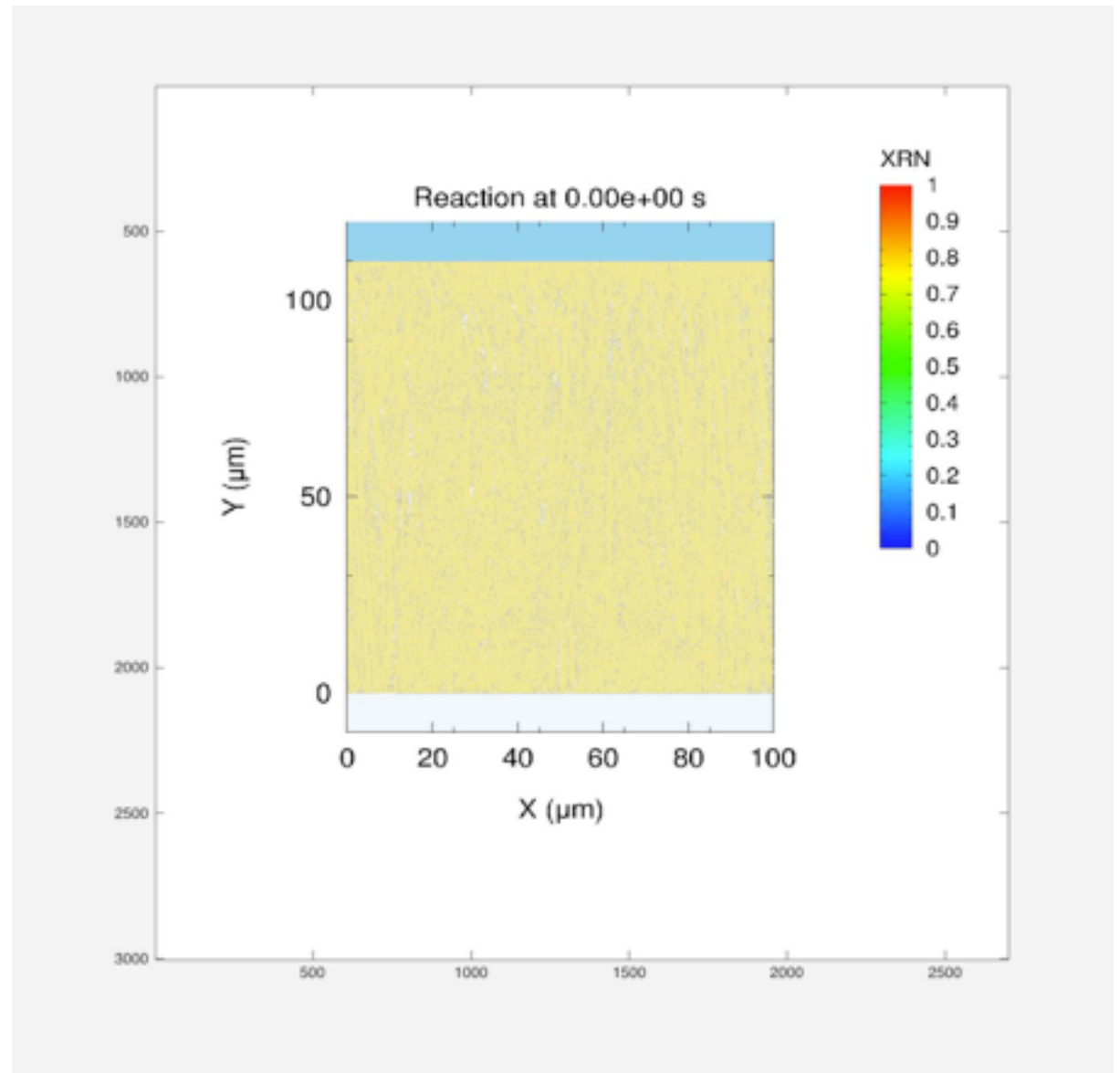
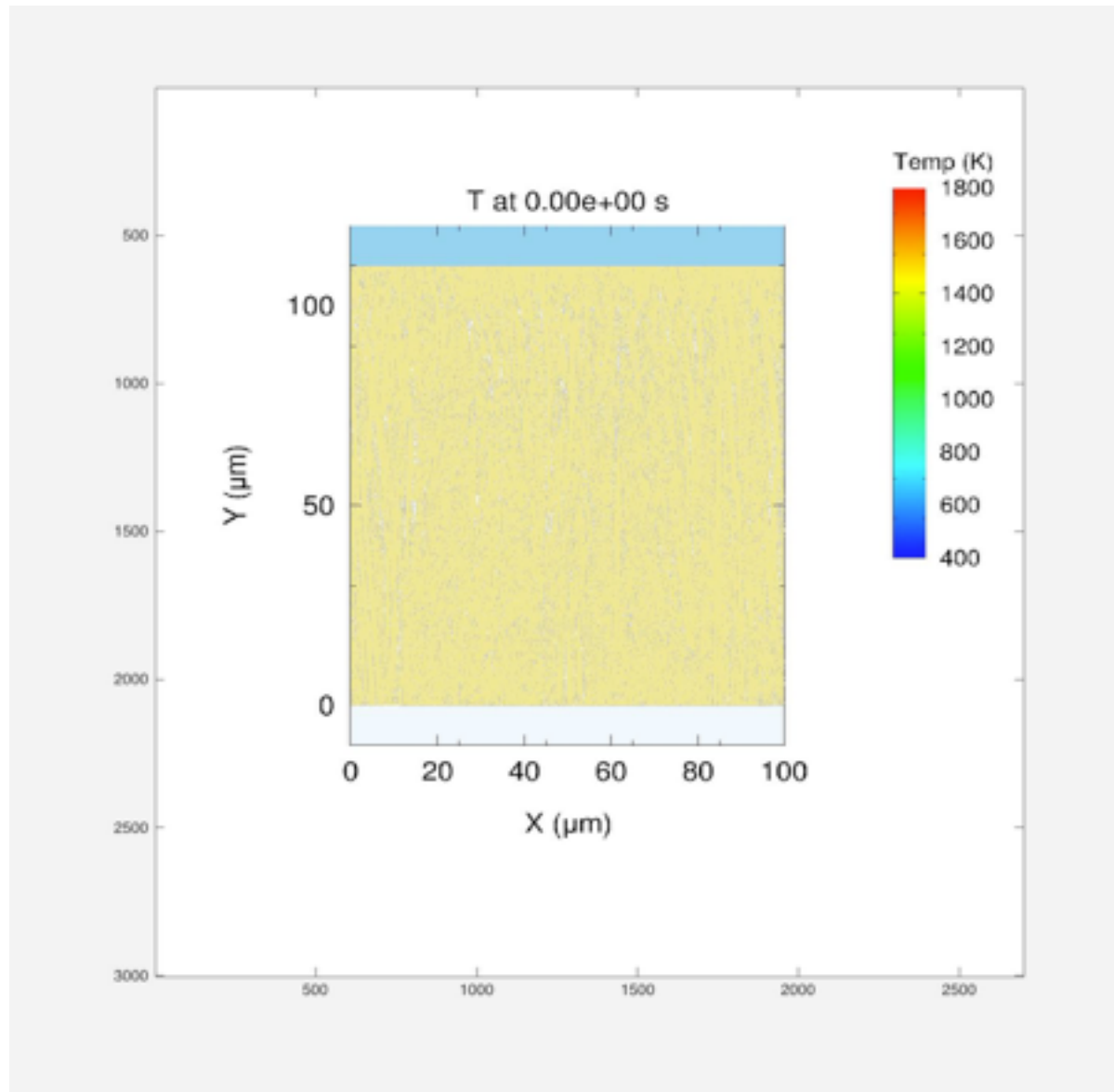
10 C



45 C

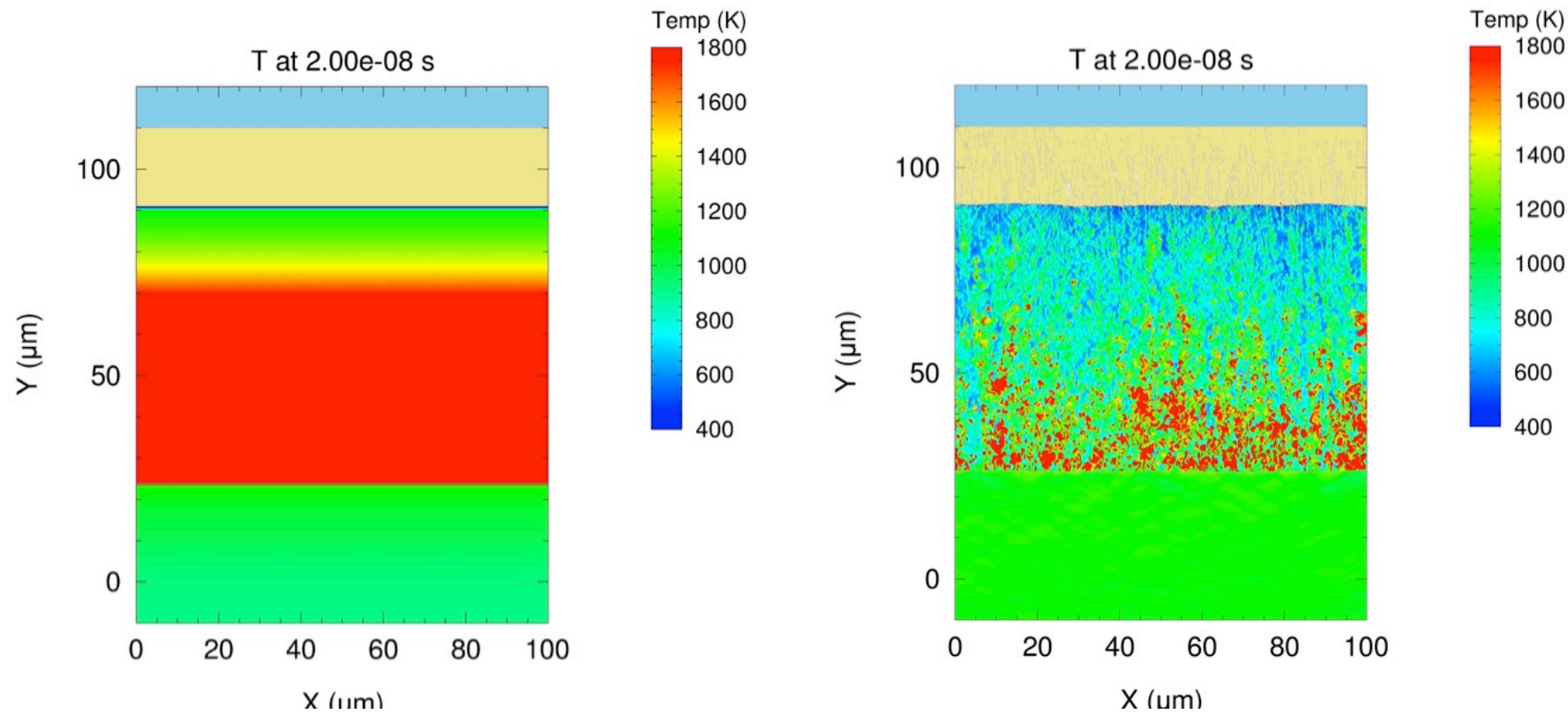


Grain-scale (mesoscale) simulation of HNS initiation

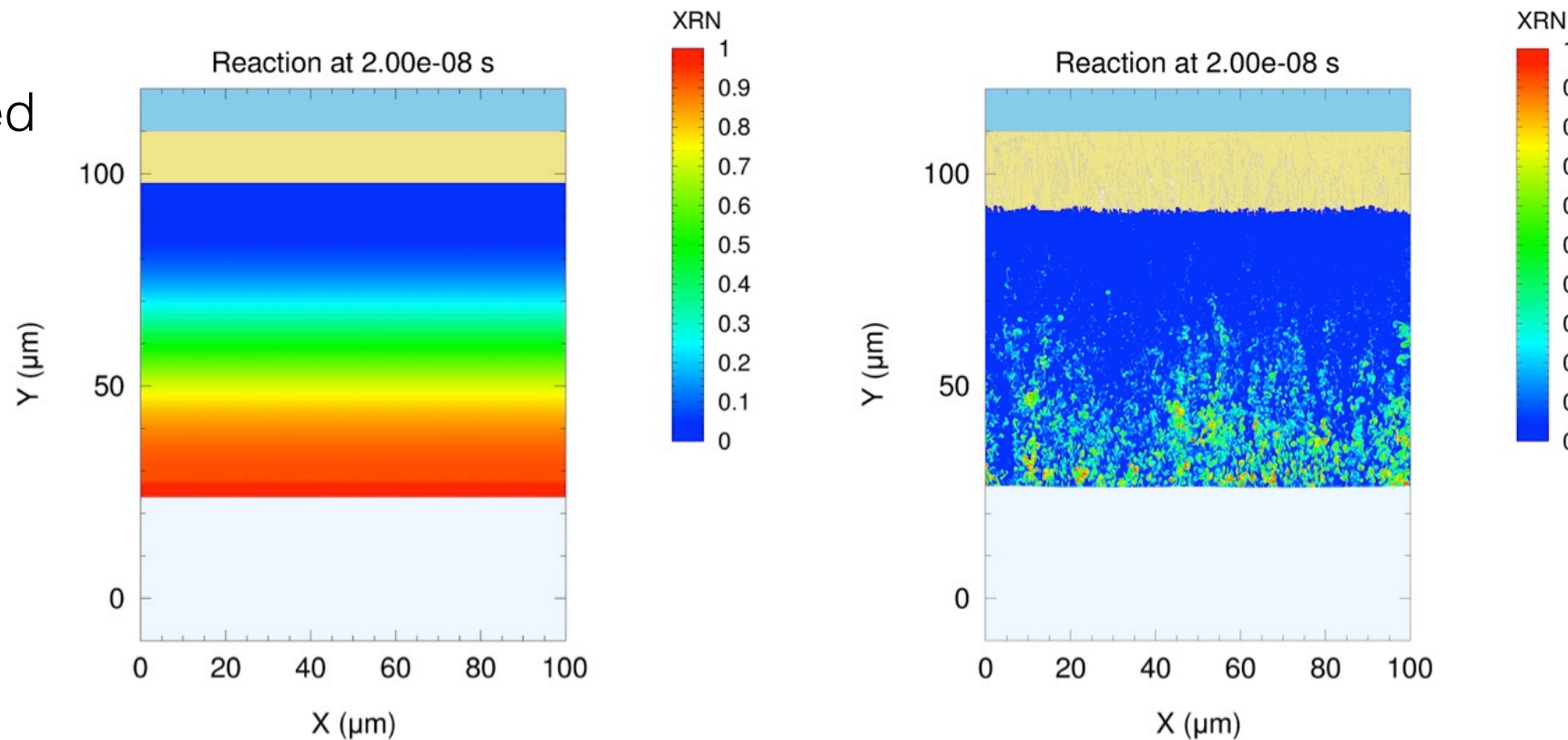


Continuum vs. mesoscale simulation, 3 km/s impact

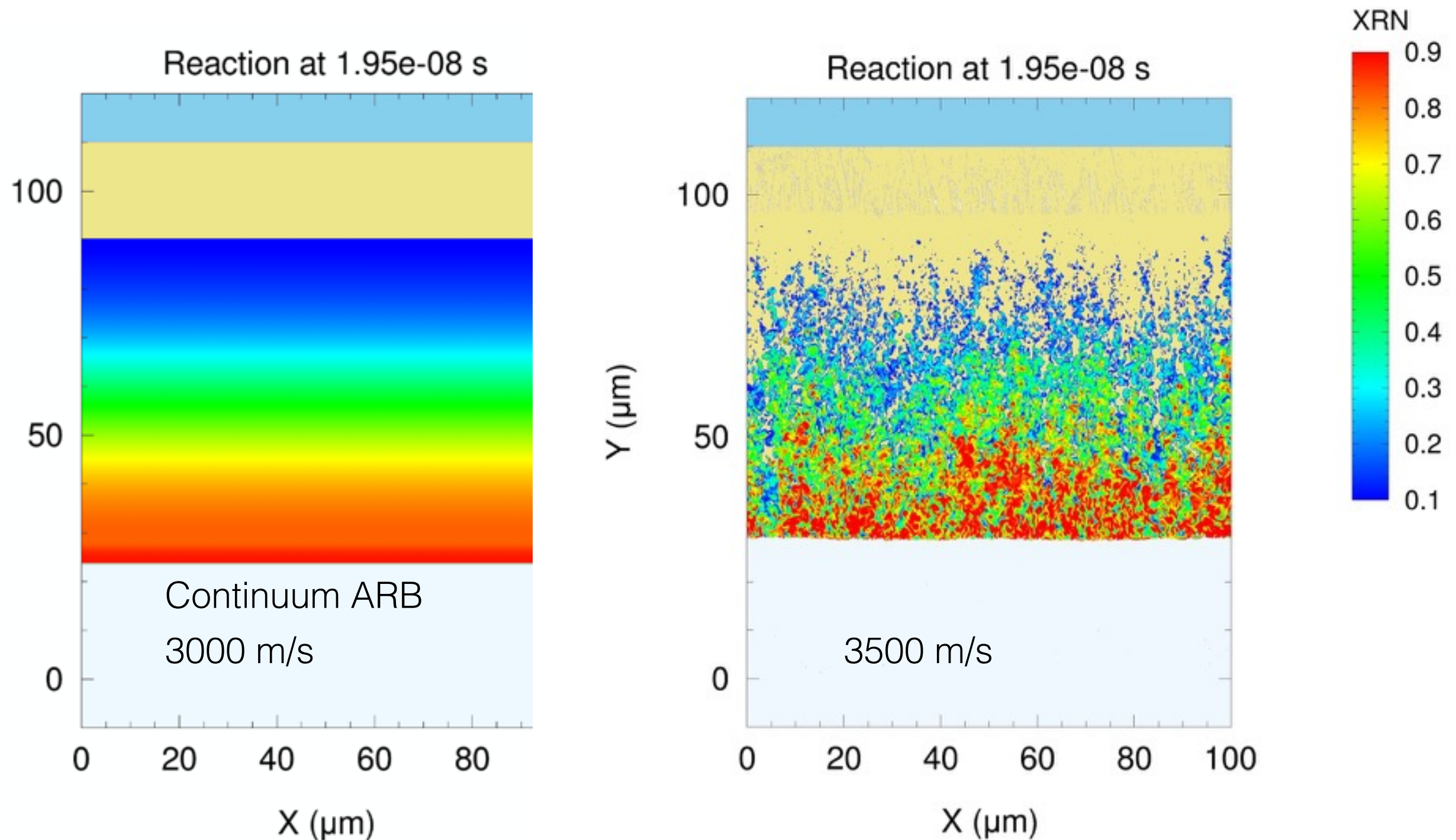
Temperature



Fraction Reacted



Continuum vs. Mesoscale



First-principles based reactants EOS (tabular)
Sesame table product EOS (historical)
Arrhenius reactive burn (ARB) with new and old parameters

Center for Integrated Nanotechnology (CINT)

www.cint.lanl.gov





Wrap-up:

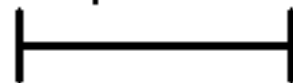
- FIB/SEM, Ar Ion, xCT
- What does the modeling community need?
- What resolution and FOV?
- Resolution -> mesh
- Sample size?
- ?

CL-20-05 ~300 μ m down

Ion Polished

File= 05_100um-300down.tif

10 μ m*



Mag = 1.14 K X

Width = 100.0 μ m

EHT = 1.20 kV

